### 1 GENERAL INTRODUCTION

This section gives a general overview of the remainder of this document.

Sections 2 and 3 contain general information about the IBIS versions and the general rules and guidelines. Several progressions of IBIS documents are referenced in Section 2 and in the discussion below. They are IBIS Version 1.1 (ratified August 1993), IBIS Version 2.1 (ratified as ANSI/EIA-656 in December 1995), IBIS Version 3.2 (ratified as ANSI/EIA-656-A in October 1999 and renewed on August 17, 2005), IBIS Version 4.2 (ratified as ANSI/EIA-656-B on March 1, 2007), and IBIS Version 5.0 (ratified on August 29, 2008)

The functionality of IBIS follows in Sections 4 through 8. Sections 4 through 6 describe the format of the core functionality of IBIS Version 1.1 and the extensions in later versions. The data in these sections are contained in .ibs files. Section 7 describes the package model format of IBIS Version 2.1 and a subsequent extension. Package models can be formatted within .ibs files or can be formatted (along with the Section file header keywords) as .pkg files. Section 8 contains the Electrical Board Description format of IBIS Version 3.2. Along with Section 4 header information, electrical board descriptions must be contained in separate .ebd files.

Sections 6C, 10, and 11 are new in IBIS Version 5.0 and contain reference and modeling information related to the algorithmic modeling interface support, and EMI parameters

Section 9 contains some notes regarding the extraction conditions and data requirements for IBIS files. This section focuses on implementation conditions based on measurement or simulation for gathering the IBIS compliant data.

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#### 2 STATEMENT OF INTENT

In order to enable an industry standard method to electronically transport IBIS modeling data between semiconductor vendors, EDA tool vendors, and end customers, this template is proposed. The intention of this template is to specify a consistent format that can be parsed by software, allowing EDA tool vendors to derive models compatible with their own products.

One goal of this template is to represent the current state of IBIS data, while allowing a growth path to more complex models/methods (when deemed appropriate). This would be accomplished by a revision of the base template, and possibly the addition of new keywords or categories.

Another goal of this template is to ensure that it is simple enough for semiconductor vendors and customers to use and modify, while ensuring that it is rigid enough for EDA tool vendors to write reliable parsers.

Finally, this template is meant to contain a complete description of the I/O elements on an entire component. Consequently, several models will need to be defined in each file, as well as a table that equates the appropriate buffer to the correct pin and signal name.

Version 5.0 of this electronic template was finalized by an industry-wide group of experts representing various companies and interests. Regular "IBIS Open Forum" meetings were held to accomplish this task.

Commitment to Backward Compatibility. Version 1.0 is the first valid IBIS ASCII file format. It represents the minimum amount of I/O buffer information required to create an accurate IBIS model of common CMOS and bipolar I/O structures. Future revisions of the ASCII file will add items considered to be "enhancements" to Version 1.0 to allow accurate modeling of new, or other I/O buffer structures. Consequently, all future revisions will be considered supersets of Version 1.0, allowing backward compatibility. In addition, as modeling platforms develop support for revisions of the IBIS ASCII template, all previous revisions of the template must also be supported.

**Version 1.1 update**. Version 1.1, (published as "ver1\_1.ibs") is conceptually the same as the 1.0 version of the IBIS ASCII format (published as "ver1\_0.ibs"). However, various comments have been added for further clarification.

**Version 2.0 update.** Version 2.0 maintains backward compatibility with Versions 1.0 and 1.1. All new keywords and elements added in Version 2.0 are optional. A complete list of changes to the specification is in the IBIS Version 2.0 Release Notes document ("ver2 0.rn.txt").

**Version 2.1 update.** Version 2.0 contains clarification text changes, corrections, and two additional waveform parameters beyond Version 2.0.

**Version 3.0 update.** Version 3.0 adds a number of new keywords and functionality. A complete list of functions can be found on eda.org under /pub/ibis/birds/birddir.txt showing the approved Buffer Issue Resolution Documents (BIRDs) that have been approved for Version 3.0.

**Version 3.1 update.** Version 3.1 contains a major reformatting of the document and a simplification of the wording. It also contains some new technical enhancements that were unresolved when Version 3.0 was approved.

**Version 3.2 update**. Version 3.2 adds more technical advances and also a number of editorial changes documented in 12 BIRDs and also in responses to public letter ballot comments.

**Version 4.0 update.** Version 4.0 adds more technical advances and a few editorial changes documented in 11 BIRDs.

**Version 4.1 update.** Version 4.1 adds more technical advances and a few editorial changes documented in 10 BIRDs.

**Version 4.2 Update**. Version 4.2 adds more technical advances and some editorial changes documented in 13 BIRDs.

**Version 5.0 Update.** Version 5.0 adds more technical advances and some editorial changes documented in 10 BIRDs.

**Version 5.1 Update**. Version 5.1 adds more technical advances and some editorial changes documented in 23 BIRDs. Additionally, Version 5.1 uses a new document format.

### 3 GENERAL SYNTAX RULES AND GUIDELINES

This section contains general syntax rules and guidelines for ASCII IBIS| files:

- 1. The content of the files is case sensitive, except for reserved words and keywords.
- The following words are reserved words and must not be used for any other purposes in the document:

POWER - reserved model name, used with power supply pins,

GND - reserved model name, used with ground pins,

NC - reserved model name, used with no-connect pins,

NA - used where data not available,

CIRCUITCALL - used for circuit call references in Section 6B.

3. To facilitate portability between operating systems, file names used in the IBIS file must only have lower case characters. File names should have a basename of no more than forty (40) characters followed by a period ('.'), followed by a file name extension of no more than three characters. The file name and extension must use characters from the set (space, '', 0x20 is not included):

```
abcdefghijklmnopqrstuvwxyz
0123456789_^$~!#%&-{})(@``
```

The file name and extension are recommended to be lower case on systems that support such names.

- 4. A line of the file may have at most 120 characters, followed by a line termination sequence. The line termination sequence must be one of the following two sequences: a linefeed character, or a carriage return followed by linefeed character.
- 5. Anything following the comment character is ignored and considered a comment on that line. The default '|' (pipe) character can be changed by the keyword [Comment Char] to any other character. The [Comment Char] keyword can be used anywhere in the file as desired.
- 6. Keywords must be enclosed in square brackets, [], and must start in column 1 of the line. No space or tab is allowed immediately after the opening bracket '[' or immediately before the closing bracket ']'. If used, only one space (' ') or underscore ('\_') character separates the parts of a multi-word keyword.
- Underscores and spaces are equivalent in keywords. Spaces are not allowed in subparameter names.
- 8. Valid scaling factors are:

T = tera k = kilo n = nano G = giga m = milli p = pico M = mega u = micro f = femto

When no scaling factors are specified, the appropriate base units are assumed. (These are volts, amperes, ohms, farads, henries, and seconds.) The parser looks at only one alphabetic character after a numerical entry, therefore it is enough to use only the prefixes to scale the parameters. However, for clarity, it is allowed to use full abbreviations for the units, (e.g., pF, nH, mA, mOhm). In addition, scientific notation IS allowed (e.g., 1.2345e-12).

The I-V data tables should use enough data points around sharply curved areas of the I-V
curves to describe the curvature accurately. In linear regions there is no need to define
unnecessary data points.

- 10. The use of tab characters is legal, but they should be avoided as much as possible. This is to eliminate possible complications that might arise in situations when tab characters are automatically converted to multiple spaces by text editing, file transferring and similar software. In cases like that, lines might become longer than 120 characters, which is illegal in IBIS files.
- 11. Currents are considered positive when their direction is into the component.
- 12. All temperatures are represented in degrees Celsius.
- 13. Important supplemental information is contained in Section 9, "NOTES ON DATA DERIVATION METHOD", concerning how data values are derived.
- 14. Only ASCII characters, as defined in ANSI Standard X3.4-1986, may be used in an IBIS file. The use of characters with codes greater than hexadecimal 07E is not allowed. Also, ASCII control characters (those numerically less than hexadecimal 20) are not allowed, except for tabs or in a line termination sequence. As mentioned in item 10 above, the use of tab characters is discouraged.

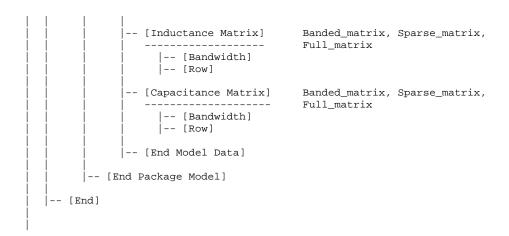
### 3.1 KEYWORD HIERARCHY

```
.ibs FILE
 |-- File Header Section
      -- [IBIS Ver]
      -- [Comment Char]
       -- [File Name]
       -- [File Rev]
       -- [Date]
       -- [Source]
       -- [Notes]
       -- [Disclaimer]
      -- [Copyright]
  -- [Component]
                                        Si_location, Timing_location
      |-- [Manufacturer]
       -- [Package]
                                        R_pkg, L_pkg, C_pkg
       -- [Pin]
                                        signal_name, model_name, R_pin,
                                        L_pin, C_pin
       -- [Package Model]
            |-- [Alternate Package Models]
                -----
                 -- [End Alternate Package Models]
       -- [Pin Mapping]
                                        pulldown_ref, pullup_ref,
                                        gnd_clamp_ref, power_clamp_ref,
                                        ext_ref
       -- [Diff Pin]
                                        inv_pin, vdiff, tdelay_typ,
                                        tdelay_min, tdelay_max
       -- [Series Pin Mapping]
                                        pin_2, model_name,
                                        function_table_group
       -- [Series Switch Groups]
                                        On, Off
       -- [Node Declarations]
            ._____
           |-- [End Node Declarations]
       -- [Circuit Call]
                                        Signal_pin, Diff_signal_pins,
                                        Series_pins, Port_map
          _____
           |-- [End Circuit Call]
```

```
Domain, Cpd, C_Heatsink_gnd,
     |-- [Begin EMI Component]
          -----
                                        C_Heatsing_float
           -- [Pin EMI]
                                        domain_name, clock_div
           |-- [Pin Domain EMI]
                                        percentage
           -- [End EMI Component]
-- [Model Selector]
-- [Model]
                                        Model_type, Polarity, Enable,
                                        Vinl, Vinh, C_comp, C_comp_pullup,
                                        C_comp_pulldown,
                                         C_comp_power_clamp,
                                        C_comp_gnd_clamp
                                        Vmeas, Cref, Rref, Vref
                                        Rref_diff, Cref_diff
      -- [Model Spec]
                                        Vinh, Vinl, Vinh+, Vinh-, Vinl+,
                                        Vinl-, S_overshoot_high,
                                        S_overshoot_low, D_overshoot_high,
                                        D_overshoot_low, D_overshoot_time,
                                        _
D_overshoot_area_h,
                                        D_overshoot_area_l,
                                        D_overshoot_ampl_h,
                                        D_overshoot_ampl_l,
                                        Pulse_high, Pulse_low, Pulse_time, Vmeas, Vref, Cref, Rref,
                                        Cref_rising,
                                        Cref_falling, Rref_rising,
                                        Rref_falling, Vref_rising,
                                         Vref_falling, Vmeas_rising,
                                        Vmeas_falling, , Weak_R,
                                        Weak_I, Weak_V
                                        Rref_diff, Cref_diff
      -- [Receiver Thresholds]
                                        Vth, Vth_min, Vth_max, Vinh_ac,
                                        Vinh_dc, Vinl_ac, Vinl_dc,
                                        Threshold_sensitivity,
                                        Reference_supply, Vcross_low,
                                        Vcross_high, Vdiff_ac, Vdiff_dc,
                                        Tslew_ac, Tdiffslew_ac
     -- [Add Submodel]
      -- [Driver Schedule]
      -- [Temperature Range]
     -- [Voltage Range]
     -- [Pullup Reference]
     -- [Pulldown Reference]
     -- [POWER Clamp Reference]
     -- [GND Clamp Reference]
      -- [External Reference]
     -- [C Comp Corner]
                                        C_comp, C_comp_pullup,
                                        C_comp_pulldown,
                                        C_comp_power_clamp,
                                        C_comp_gnd_clamp
     -- [TTgnd]
     -- [TTpower]
     -- [Pulldown]
     -- [Pullup]
     -- [GND Clamp]
```

```
-- [POWER Clamp]
-- [ISSO PU]
-- [ISSO PD]
-- [Rgnd]
-- [Rpower]
-- [Rac]
-- [Cac]
-- [On]
-- [Off]
-- [R Series]
-- [L Series]
-- [Rl Series]
-- [C Series]
-- [Lc Series]
-- [Rc Series]
-- [Series Current]
-- [Series MOSFET]
                                 Vds
-- [Ramp]
                                 dV/dt_r, dV/dt_f,
                                 R_load
-- [Rising Waveform]
                                 R_fixture, V_fixture,
                                 V_fixture_min, V_fixture_max,
                                 C_fixture, L_fixture, R_dut,
                                 L_dut, C_dut
    -- [Composite Current]
                                 R_fixture, V_fixture,
-- [Falling Waveform]
                                 V_fixture_min, V_fixture_max,
                                 C_fixture, L_fixture, R_dut,
                                 L_dut, C_dut
     -- [Composite Current]
-- [External Model]
                                 Language, Corner, Parameters,
                                 Ports, D_to_A, A_to_D
    |-- [End External Model]
-- [Algorithmic Model]
                                 Executable
   _____
    |-- [End Algorithmic Model]
-- [Begin EMI Model]
                                 Model_emi_type, Model_Domain
    |-- [End EMI Model]
```

```
Submodel_type
|-- [Submodel]
     |-- [Submodel Spec]
                                         V_trigger_r, V_trigger_f,
                                         Off_delay
      -- [POWER Pulse Table]
      -- [GND Pulse Table]
      -- [Pulldown]
      -- [Pullup]
      -- [GND Clamp]
      -- [POWER Clamp]
      -- [Ramp]
                                        dV/dt_r, dV/dt_f, R_load
      -- [Rising Waveform]
                                        R_fixture, V_fixture,
                                        V_fixture_min, V_fixture_max,
                                        C_fixture, L_fixture, R_dut, L_dut,
                                        C_dut
     -- [Falling Waveform]
                                        R_fixture, V_fixture,
                                        V_fixture_min, V_fixture_max,
                                        C_fixture, L_fixture, R_dut, L_dut,
                                        C_dut
-- [External Circuit]
                                        Language, Corner, Parameters,
       ______
                                        Ports, D_to_A, A_to_D
     -- [End External Circuit]
-- [Test Data]
                                        Test_data_type, Driver_model,
                                        Driver_model_inv, Test_load
     |-- [Rising Waveform Near]
      -- [Falling Waveform Near]
      -- [Rising Waveform Far]
      -- [Falling Waveform Far]
      -- [Diff Rising Waveform Near]
      -- [Diff Falling Waveform Near]
      -- [Diff Rising Waveform Far]
      -- [Diff Falling Waveform Far]
      -- [Test Load]
                                        Test_load_type, C1_near, Rs_near,
                                        Ls_near, C2_near, Rp1_near,
                                        Rp2_near, Td, Zo, Rp1_far,
                                        Rp2_far, C2_far, Ls_far, Rs_far,
C1_far, V_term1, V_term2,
                                        Receiver_model,
                                        Receiver_model_inv, R_diff_near,
                                        R_diff_far
-- [Define Package Model]
     |-- [Manufacturer]
      -- [OEM]
      -- [Description]
      -- [Number Of Sections]
      -- [Number Of Pins]
      -- [Pin Numbers]
                                         Len, L, R, C, Fork, Endfork
      -- [Model Data]
           |-- [Resistance Matrix]
                                         Banded_matrix, Sparse_matrix,
                                         Full_matrix
                  -- [Bandwidth]
                 -- [Row]
```



```
.pkg FILE
  |-- File Header Section
       -- [IBIS Ver]
        -- [Comment Char]
        -- [File Name]
        -- [File Rev]
        -- [Date]
        -- [Source]
        -- [Notes]
        -- [Disclaimer]
        -- [Copyright]
   -- [Define Package Model]
     -----
       |-- [Manufacturer]
        -- [OEM]
        -- [Description]
        -- [Number Of Sections]
        -- [Number Of Pins]
        -- [Pin Numbers]
                                        Len, L, R, C, Fork, Endfork
        -- [Model Data]
           _____
             |-- [Resistance Matrix]
                                        Banded_matrix, Sparse_matrix,
                                        {\tt Full\_matrix}
                _____
                  -- [Bandwidth]
                  -- [Row]
              -- [Inductance Matrix]
                                        Banded_matrix, Sparse_matrix,
                                        Full_matrix
                  -- [Bandwidth]
                  -- [Row]
              -- [Capacitance Matrix]
                                        Banded_matrix, Sparse_matrix,
                                        Full_matrix
                  -- [Bandwidth]
                   -- [Row]
             -- [End Model Data]
        -- [End Package Model]
  -- [End]
```

```
|.ebd FILE
   |-- File Header Section
         -- [IBIS Ver]
         -- [Comment Char]
-- [File Name]
-- [File Rev]
-- [Date]
          -- [Source]
          -- [Notes]
          -- [Disclaimer]
          -- [Copyright]
    -- [Begin Board Description]
          |-- [Manufacturer]
          -- [Number of Pins]
                                                    signal_name
          -- [Path Description]
                                                    Len, L, R, C, Fork, Endfork, Pin,
                                                    Node
          -- [Reference Designator Map]
-- [End Board Description]
   -- [End]
```

### 4 FILE HEADER INFORMATION

Keyword: [IBIS Ver]

Required: Yes

*Description:* Specifies the IBIS template version. This keyword informs electronic parsers of the kinds of data types that are present in the file.

*Usage Rules:* [IBIS Ver] must be the first keyword in any IBIS file. It is normally on the first line of the file, but can be preceded by comment lines that must begin with a ".

Example:

```
[IBIS Ver] 5.1 | Used for template variations
```

Keyword: [Comment Char]

Required: No

Description: Defines a new comment character to replace the default " (pipe) character, if desired.

Usage Rules: The new comment character to be defined must be followed by the underscore character and the letters 'char'. For example: '|\_char' redundantly redefines the comment character to be the pipe character. The new comment character is in effect only following the [Comment Char] keyword. The following characters MAY be used:

```
! " # $ % & ' ( ) * , : ; < > ? @ \ ^ ` { | } ~
```

Other Notes: The [Comment Char] keyword can be used anywhere in the file, as desired.

Example:

```
[Comment Char] |_char
```

Keyword: [File Name]

Required: Yes

Description: Specifies the name of the IBIS file.

*Usage Rules:* The file name must conform to the rules in paragraph 3 of Section 3, "GENERAL SYNTAX RULES AND GUIDELINES". In addition, the file name must use the extension '.ibs', '.pkg', or '.ebd'. The file name must be the actual name of the file.

Example:

```
[File Name] ver5_1.ibs
```

Keyword: [File Rev]

Required: Yes

Description: Tracks the revision level of a particular .ibs file.

*Usage Rules:* Revision level is set at the discretion of the engineer defining the file. The following guidelines are recommended:

0.x silicon and file in development

1.x pre-silicon file data from silicon model only

2.x file correlated to actual silicon measurements

3.x mature product, no more changes likely

### Example:

[File Rev] 1.0 | Used for .ibs file variations

Keywords: [Date], [Source], [Notes], [Disclaimer], [Copyright]

Required: No

Description: Optionally clarifies the file.

*Usage Rules:* The keyword arguments can contain blanks, and be of any format. The [Date] keyword argument is limited to a maximum of 40 characters, and the month should be spelled out for clarity.

Because IBIS model writers may consider the information in these keywords essential to users, and sometimes legally required, design automation tools should make this information available. Derivative models should include this text verbatim. Any text following the [Copyright] keyword must be included, verbatim, in any derivative models.

### Examples:

[Date]	August 29, 2008	The latest file revis:	ion date
[Source]	Put originator and the example:	source of information here	e. For
	From silicon level SPIC		
	From lab measurement at		
1	Compiled from manufactu	rer's data book at Quad De	esign, etc.
 [Notes] 	Use this section for any	y special notes related to	o the file.
[Disclaimer]	This information is for guaranteed.	modeling purposes only, a	
 [Copyright]	Copyright 2012, XYZ Corp	o., All Rights Reserved	

### 5 COMPONENT DESCRIPTION

*Keyword:* [Component]

Required: Yes

Description: Marks the beginning of the IBIS description of the integrated circuit named after the

keyword.

Sub-Params: Si\_location, Timing\_location

*Usage Rules:* If the .ibs file contains data for more than one component, each section must begin with a new [Component] keyword. The length of the component name must not exceed 40 characters, and blank characters are allowed.

NOTE: Blank characters are not recommended due to usability issues.

Si\_location and Timing\_location are optional and specify where the Signal Integrity and Timing measurements are made for the component. Allowed values for either subparameter are 'Die' or 'Pin'. The default location is at the 'Pin'.

#### Example:

[Component] 7403398 MC452
|
Si\_location Pin | Optional subparameters to give measurement
Timing\_location Die | location positions

*Keyword:* [Manufacturer]

Required: Yes

Description: Specifies the name of the component's manufacturer.

*Usage Rules:* The length of the manufacturer's name must not exceed 40 characters (blank characters are allowed, e.g., Texas Instruments). In addition, each manufacturer must use a consistent name in all .ibs files.

Example:

[Manufacturer] Intel Corp.

Keyword: [Package]
Required: Yes

Description: Defines a range of values for the default packaging resistance, inductance, and capacitance of the component pins.

Sub-Params: R\_pkg, L\_pkg, C\_pkg

*Usage Rules:* The typical (typ) column must be specified. If data for the other columns are not available, they must be noted with 'NA'.

Other Notes: If RLC parameters are available for individual pins, they can be listed in columns 4-6 under keyword [Pin]. The values listed in the [Pin] description section override the default values defined here. Use the [Package Model] keyword for more complex package descriptions.

If defined, the [Package Model] data overrides the values in the [Package] keyword. Regardless, the data listed under the [Package] keyword must still contain valid data.

### Example:

[Package]			
variable	typ	min	max
R_pkg	250.0m	225.0m	275.0m
L_pkg	15.0nH	12.0nH	18.0nH
C_pkg	18.0pF	15.0pF	20.0pF

Keyword: [Pin] Required: Yes

Description: Associates the component's I/O models to its various external pin names and signal

names.

Sub-Params: signal\_name, model\_name, R\_pin, L\_pin, C\_pin

*Usage Rules:* All pins on a component must be specified. The first column must contain the pin name. The second column, signal\_name, gives the data book name for the signal on that pin. The third column, model\_name, maps a pin to a specific I/O buffer model or model selector name. Each model\_name must have a corresponding model or model selector name listed in a [Model] or [Model Selector] keyword below, unless it is a reserved model name (POWER, GND, or NC).

The model\_name column cannot be used for model or model selector names that reference Series and Series\_switch models.

Each line must contain either three or six columns. A pin line with three columns only associates the pin's signal and model. Six columns can be used to override the default package values (specified under [Package]) FOR THAT PIN ONLY. When using six columns, the headers R\_pin, L\_pin, and C\_pin must be listed. If 'NA' is in columns 4 through 6, the default packaging values must be used. The headers R\_pin, L\_pin, and C\_pin may be listed in any order.

#### Column length limits are:

[Pin]	5 characters max
model_name	40 characters max
signal_name	40 characters max
R_pin	9 characters max
L_pin	9 characters max
C_pin	9 characters max

#### Example:

[Pin]	signal_name	model_name	R_pin	L_pin	C_pin
1	RAS0#	Buffer1	200.0m	5.0nH	2.0pF
2	RAS1#	Buffer2	209.0m	NA	2.5pF
3	EN1#	Input1	NA	6.3nH	NA
4	A0	3-state			
5	D0	I/01			
6	RD#	Input2	310.0m	3.0nH	2.0pF

7	WR#	Input2			
8	A1	I/O2			
9	D1	I/O2			
10	GND	GND	297.0m	6.7nH	3.4pF
11	RDY#	Input2			-
12	GND	GND	270.0m	5.3nH	4.0pF
.					_
į .					
1 .					
18	Vcc3	POWER			
19	NC	NC			
20	Vcc5	POWER	226.0m	NA	1.0pF
21	BAD1	Series_switch1		Illegal	assignment
22	BAD2	Series selector	1 İ	Illegal	assignment

Keyword: [Package Model]

Required: No

Description: Indicates the name of the package model to be used for the component.

Usage Rules: The package model name is limited to 40 characters. Spaces are allowed in the name. The name should include the company name or initials to help ensure uniqueness. The EDA tool will search for a matching package model name as an argument to a [Define Package Model] keyword in the current IBIS file first. If a match is not found, the EDA tool will next look for a match in an external .pkg file. If the matching package model is in an external .pkg file, it must be located in the same directory as the .ibs file. The file names of .pkg files must follow the rules for file names given in Section 3, "GENERAL SYNTAX RULES AND GUIDELINES".

Other Notes: Use the [Package Model] keyword within a [Component] to indicate which package model should be used for that component. The specification permits .ibs files to contain [Define Package Model] keywords as well. These are described under "Package Modeling" in Section 7. When package model definitions occur within a .ibs file, their scope is "local", i.e., they are known only within that .ibs file and no other. In addition, within that .ibs file, they override any globally defined package models that have the same name.

#### Example:

[Package Model] QS-SMT-cer-8-pin-pkgs

Keywords: [Alternate Package Models], [End Alternate Package Models]

Required: No

Description: Used to select a package model from a list of package models.

Usage Rules: The [Alternate Package Models] keyword can be used in addition to the [Package Model] keyword. [Alternate Package Models] shall be used only for components that use the [Package Model] keyword.

Each [Alternate Package Models] keyword specifies a set of alternate package model names for only one component, which is given by the previous [Component] keyword. The [Alternate Package Models] keyword shall not appear before the first [Component] keyword in an IBIS file.

The [Alternate Package Models] keyword applies only to the [Component] section in which it appears, and must be followed by an [End Alternate Package Models] keyword.

All alternate package model names must appear below the [Alternate Package Models] keyword, and above the following [End Alternate Package Models] keyword. The package model names listed under the [Alternate Package Models] must follow the rules of the package model names associated with the [Package Model] keyword. The package model names correspond to the names of package models defined by [Define Package Model] keywords. EDA tools may offer users a facility for choosing between the default package model and any of the alternate package models, when analyzing occurrences of the [Component].

The package model named by [Package Model] can be optionally repeated in the [Alternate Package Models] list of names.

#### Example:

```
[Alternate Package Models]
| 208-pin_plastic_PQFP_package-even_mode | Descriptive names are shown 208-pin_plastic_PQFP_package-odd_mode 208-pin_ceramic_PQFP_package-even_mode 208-pin_ceramic_PQFP_package-odd_mode | [End Alternate Package Models]
```

Keyword: [Pin Mapping]

Required: No

Description: Used to indicate the power and/or ground buses to which a given driver, receiver or terminator is connected.

Sub-Params: pulldown\_ref, pullup\_ref, gnd\_clamp\_ref, power\_clamp\_ref, ext\_ref

Usage Rules: The [Pin Mapping] keyword names the connections between POWER and/or GND pins and buffer and/or terminator voltage supply references using unique bus labels. All buses with identical labels are assumed to be connected with an ideal short. Each label must be associated with at least one pin whose model\_name is POWER or GND. Bus labels must not exceed 15 characters.

Each line must contain either three, five or six entries. Use the reserved word NC where an entry is required but a bus connection is not made.

The first column contains a pin name. Each pin name must match one of the pin names declared in the [Pin] section of the [Component].

For buffers and terminators, the remaining columns correspond to the voltage supply references for the named pin. Each [Model] supply reference is connected to a particular bus through a bus label in the corresponding column.

The second column, pulldown\_ref, designates the ground bus connections for the buffer or termination associated with that pin. The bus named under pulldown\_ref is associated with the [Pulldown] I-V table for non-ECL [Model]s. This is also the bus associated with the [GND Clamp] I-V table and the [Rgnd] model unless overridden by a label in the gnd\_clamp\_ref column.

The third column, pullup\_ref, designates the power bus connection for the buffer or termination. The bus named under pullup\_ref is associated with the [Pullup] table for non-ECL [Model]s (for ECL models, this bus is associated with the [Pulldown] table). This is also the bus label associated with the [POWER Clamp] I-V table and the [Rpower] model unless overridden by a label in the power\_clamp\_ref column.

The fourth and fifth columns, gnd\_clamp\_ref and power\_clamp\_ref, contain entries, if needed, to specify additional ground bus and power bus connections for clamps. Finally, the sixth column, ext\_ref, contains entries to specify external reference supply bus connections.

The usage of the columns changes for GND and POWER pins. For GND pins, the pulldown\_ref column contains the name of the bus to which the pin connects; the pullup\_ref column in this case must contain the reserved word NC. Similarly, for POWER (including external reference) pins, the pullup\_ref column contains the name of the bus to which the pin connects; the pulldown\_ref column in this case must contain the reserved word NC.

If the [Pin Mapping] keyword is present, then the bus connections for EVERY pin listed under the [Pin] keyword must be given.

If a pin has no connection, then both the pulldown\_ref and pullup\_ref subparameters for it will be NC.

The column length limits are:

[Pin Mapping]	5 characters max
pulldown_ref	15 characters max
pullup_ref	15 characters max
gnd_clamp_ref	15 characters max
power_clamp_ref	15 characters max
ext ref	15 characters max

For compatibility with models developed under previous IBIS versions, [Pin Mapping] lines which contain ext\_ref column entries must also explicitly include entries for the pulldown\_ref, pullup\_ref, gnd\_clamp\_ref and power\_clamp\_ref columns. These entries can be NC.

When six columns of data are specified, the headings <code>gnd\_clamp\_ref</code>, power\_clamp\_ref and ext\_ref must be used on the line containing the [Pin Mapping] keyword. Otherwise, these headings can be omitted.

#### Example:

```
[Pin Mapping] pulldown_ref pullup_ref gnd_clamp_ref power_clamp_ref ext_ref
                GNDBUS1
                            PWRBUS1
                                        Signal pins and their associated
                GNDBUS2
                           PWRBUS2
                                        ground, power and external
                                        reference connections
                GNDBUS1
                           PWRBUS1
                                         GNDCLMP
                                                        PWRCLAMP
                GNDBUS2
                           PWRBUS2
                                         GNDCLMP
                                                        PWRCLAMP
                GNDBUS2
                           PWRBUS2
                                         NC
                                                        PWRCLAMP REFBUS1
                                         GNDCT MP
                GNDBUS 2
                           PWRBUS2
                                                        NC
                GNDBUS2
                           PWRBUS2
                                         GNDCLMP
                                                                  REFBUS2
                                                        NC
                                        Some possible clamping
                                        connections are shown above
                                        for illustration purposes
```

```
11
                GNDBUS1
                            NC
                                        One set of ground connections.
12
                GNDBUS1
                                        NC indicates no connection to
                            NC
13
                GNDBUS1
                            NC
                                        power bus.
                            NC
                                       | Second set of ground connections
21
                GNDBUS2
22
                GNDBUS2
                            NC
                GNDBUS2
23
                            NC
31
                NC
                            PWRBUS1
                                        One set of power connections.
                                        NC indicates no connection to
                            PWRBUS1
                NC
32
33
                NC
                            PWRBUS1
                                        ground bus.
                NC
                            PWRBUS2
                                       | Second set of power connections
41
42
                NC
                            PWRBUS2
                NC.
                            PWRBUS2
43
                GNDCLMP
                            NC
                                         Additional power connections
51
52
                NC
                            PWRCLMP
                                        for clamps
71
                NC
                            REFBUS1
                                       | External reference connections
72
                NC
                            REFBUS2
 The following [Pin] list corresponds to the [Pin Mapping] shown above.
[Pin] signal_name model_name R_pin L_pin C_pin
      OUT1
                   output_buffer1
                                          Output buffers
      OUT2
                   output_buffer2
3
      I03
                   io_buffer1
                                           Input/output buffers
4
      IO4
                   io_buffer2
5
      SPECIAL1
                   ref_buffer1
                                           Buffers with POWER CLAMP but no
6
                                           GND CLAMP I-V tables; two use
      SPECIAL2
                   io_buffer_term1
7
      SPECIAL3
                   ref_buffer2
                                           external reference voltages
11
                    GND
      VSS1
12
      VSS1
                    GND
13
      VSS1
                    GND
                    GND
21
      VSS2
22
      VSS2
                    GND
23
      VSS2
                    GND
31
      VCC1
                    POWER
32
      VCC1
                    POWER
33
      VCC1
                    POWER
41
      VCC2
                    POWER
      VCC2
42
                    POWER
43
      VCC2
                    POWER
51
      VSSCLAMP
                    GND
                                           Power connections for clamps
52
      VCCCLAMP
                    POWER
71
      V_EXTREF1
                    POWER
                                           External reference voltage pins
72
      V_EXTREF2
                    POWER
```

Keyword: [Diff Pin]
Required: No

Description: Associates differential pins and defines their differential receiver threshold voltage and differential driver timing delays.

Sub-Params: inv\_pin, vdiff, tdelay\_typ, tdelay\_min, tdelay\_max

Usage Rules: Enter only differential pin pairs. The first column, [Diff Pin], contains a non-inverting pin name. The second column, inv\_pin, contains the corresponding inverting pin name for I/O output. Each pin name must match the pin names declared previously in the [Pin] section of the IBIS file. The third column, vdiff, contains the specified differential receiver threshold voltage between the inverting and non-inverting pins for Input or I/O model types. The fourth, fifth, and sixth columns, tdelay\_typ, tdelay\_min, and tdelay\_max, contain launch delays of the non-inverting pins relative to the inverting pins. All of the numerical entries may be a positive, zero, or negative number.

For differential Input or I/O model types, the differential input threshold (vdiff) overrides and supersedes the need for Vinh and Vinl.

Other Notes: The output pin polarity specification in the table overrides the [Model] Polarity specification such that the pin in the [Diff Pin] column is Non-Inverting and the pin in the inv\_pin column is Inverting. This convention enables one [Model] to be used for both pins.

The column length limits are:

[Diff Pin] 5 characters max inv\_pin 5 characters max vdiff 9 characters max tdelay\_typ 9 characters max tdelay\_min 9 characters max tdelay\_max 9 characters max

Each line must contain either four or six columns. Using four columns is an equivalent of entering 'NA's in the fifth and sixth columns. An 'NA' in the vdiff column will be interpreted as a 200 mV default differential receiver threshold. 'NA's in the tdelay\_typ, or tdelay\_min columns are interpreted as 0 ns. If 'NA' appears in the tdelay\_max column, its value is interpreted as the tdelay\_typ value. When using six columns, the headers tdelay\_min and tdelay\_max must be listed. Entries for the tdelay\_min column are based on minimum magnitudes; and tdelay\_max column, maximum magnitudes. One entry of vdiff, regardless of its polarity, is used for difference magnitudes.

When a [Model] that is associated with any of the pins listed under the [Diff Pin] keyword contains the [Algorithmic Model] keyword, the tdelay\_\*\*\* parameters in the fourth, fifth and sixth columns of the [Diff Pin] keyword are ignored in AMI channel characterization simulations, i.e. they are treated as if their value would be zero.

The positioning of numerical entries and/or 'NA' must not be used as an indication for the model type. The model type is determined by the model type parameter inside the [Model]s referenced by the [Diff Pin] keyword, regardless of what the [Diff Pin]'s entries are. The simulator may ignore the vdiff or the tdelay\_\*\*\* parameters if not needed by the model type of the [Model], or use the default values defined above if they are needed but not provided in the [Diff Pin] keyword. For

example, an 'NA' in the third column (vdiff) does not imply that the model type is Output, or three 'NA's in the tdelay columns does not mean that the model type is Input.

Note that the starting point of the flight time measurements will occur when the differential driver's output waveforms are crossing, i.e., when the differential output voltage is zero, and consequently Vmeas, if defined, will be ignored.

### Example:

```
[Diff Pin] inv_pin vdiff tdelay_typ tdelay_min tdelay_max
3
                     150mV
                              -1ns
                                         0ns
                                                   -2ns
 For Input, tdelay_typ/min/max ignored
 For Output, vdiff ignored
                       07/
                               1ns
                                          NΑ
                                                     NΑ
16
           15
                     200mV
                               1ns
 For Input, tdelay_typ ignored
 For Output, vdiff ignored and tdelay_min = 0ns and tdelay_max = 1ns
              tdelay_min = 0ns and tdelay_max = 1ns
            10
                       NA
                                NA
                                                     NA
22
            21
                       NA
                                NA
 For Input, vdiff = 200 mV
 For Output, tdelay_typ/min/max = Ons
 For I/O,
              vdiff = 200 mV and tdelay_typ/min/max = 0ns
20
                                NA
 For Output, vdiff ignored and tdelay_typ/min/max = Ons
 For I/O,
              tdelay_typ/min/max = 0ns
```

**Keyword:** [Series Pin Mapping]

Required: No

Description: Used to associate two pins joined by a series model.

Sub-Params: pin\_2, model\_name, function\_table\_group

Usage Rules: Enter only series pin pairs. The first column, [Series Pin Mapping], contains the series pin for which input impedances are measured. The second column, pin\_2, contains the other connection of the series model. Each pin must match the pin names declared previously in the [Pin] section of the IBIS file. The third column, model\_name, associates models of type Series or Series\_switch, or model selectors containing references to models of type Series or Series\_switch for the pair of pins in the first two columns. Each model\_name must have a corresponding model or model selector name listed in a [Model] or [Model Selector] keyword below. The usage of reserved model names (POWER, GND, or NC) within the [Series Pin Mapping] keyword is not allowed. The fourth column, function\_table\_group, contains an alphanumeric designator string to associate those sets of Series\_switch pins that are switched together.

Each line must contain either three or four columns. When using four columns, the header function\_table\_group must be listed.

One possible application is to model crossbar switches where the straight through On paths are indicated by one designator and the cross over On paths are indicated by another designator. If the model referenced is a Series model, then the function\_table\_group entry is omitted.

The column length limits are:

[Series Pin Mapping] 5 characters max pin\_2 5 characters max model\_name 40 characters max function\_table\_group 20 characters max

Other Notes: If the model\_name is for a non-symmetrical series model, then the order of the pins is important. The [Series Pin Mapping] and pin\_2 entries must be in the columns that correspond with Pin 1 and Pin 2 of the referenced model.

This mapping covers only the series paths between pins. The package parasitics and any other elements such as additional capacitance or clamping circuitry are defined by the model\_name that is referenced in the [Pin] keyword. The model\_names under the [Pin] keyword that are also referenced by the [Series Pin Mapping] keyword may include any legal model or reserved model except for Series and Series\_switch models. Normally the pins will reference a [Model] whose Model\_type is 'Terminator'. For example, a Series\_switch model may contain Terminator models on EACH of the pins to describe both the capacitance on each pin and some clamping circuitry that may exist on each pin. In a similar manner, Input, I/O or Output models may exist on each pin of a Series model that is serving as a differential termination.

Also, a pin name may appear on more than one entry under the [Series Pin Mapping] keyword. This allows for multiple and perhaps different models or model selectors to be placed between the same, or any arbitrary pin pair combinations.

### Example:

[Series Pin Mapping]	pin_2	model_name	function_table_group
2	3	CBTSeries	1 Four independent groups
5	6	CBTSeries	2
9	8	CBTSeries	3
12	11	CBTSeries	4
22	23	CBTSeries	5   Straight through path
25	26	CBTSeries	5
22	26	CBTSeries	6   Cross over path
25	23	CBTSeries	6
32	33	Fixed_series	No group needed

#### Keyword: [Series Switch Groups]

Required: Yes, if function\_table\_group column data is present under [Series Pin Mapping]

Description: Used to define allowable switching combinations of series switches described using the names of the groups in the [Series Pin Mapping] keyword function\_table\_group column.

Sub-Params: On, Off

Usage Rules: Each state line contains an allowable configuration. A typical state line will start with 'On' followed by all of the on-state group names or an 'Off' followed by all of the off-state group names. Only one of 'On' or 'Off' is required since the undefined states are presumed to be

opposite of the explicitly defined states. The state line is terminated with the slash '/', even if it extends over several lines to fit within the 120 character column width restriction.

The group names in the function\_table\_group are used to associate switches whose switching action is synchronized by a common control function. The first line defines the assumed (default) state of the set of series switches. Other sets of states are listed and can be selected through a user interface or through automatic control.

#### Example:

```
[Series Switch Groups]
 Function Group States
On 1 2 3 4 /
                         Default setting is all switched On
Off 1 2 3 4 /
                         All Off setting
                         Other possible combinations below
On 1 /
On 2 /
On 3 /
On 4 /
On 1 2 /
On 1 3 /
On 1 4 /
On 2 3 /
On 2 4 /
On 3 4 /
On 1 2 3 /
On 1 2 4 /
On 1 3 4 /
On 2 3 4 /
 Off 4 /
                         The last four lines above could have been replaced
 Off 3 /
                         with these four lines with the same meaning.
 Off 2 /
 Off 1 /
On 5 /
                         Crossbar switch straight through connection
On 6 /
                         Crossbar cross over connection
Off 5 6 /
                         Crossbar open switches
```

Keyword: [Model Selector]

Required: No

Description: Used to pick a [Model] from a list of [Model]s for a pin which uses a programmable buffer.

*Usage Rules:* A programmable buffer must have an individual [Model] section for each one of its modes used in the .ibs file. The names of these [Model]s must be unique and can be listed under the [Model Selector] keyword and/or pin list. The name of the [Model Selector] keyword must match the corresponding model name listed under the [Pin] or [Series Pin Mapping] keyword and must not contain more than 40 characters. A .ibs file must contain enough [Model Selector] keywords to cover all of the model selector names specified under the [Pin] and [Series Pin Mapping] keywords.

The section under the [Model Selector] keyword must have two fields. The two fields must be separated by at least one white space. The first field lists the [Model] name (up to 40 characters

long). The second field contains a short description of the [Model] shown in the first field. The contents and format of this description is not standardized, however it shall be limited in length so that none of the descriptions exceed the 120-character length of the line that it started on. The purpose of the descriptions is to aid the user of the EDA tool in making intelligent buffer mode selections and it can be used by the EDA tool in a user interface dialog box as the basis of an interactive buffer selection mechanism.

The first entry under the [Model Selector] keyword shall be considered the default by the EDA tool for all those pins which call this [Model Selector].

The operation of this selection mechanism implies that a group of pins which use the same programmable buffer (i.e., model selector name) will be switched together from one [Model] to another. Therefore, if two groups of pins, for example an address bus and a data bus, use the same programmable buffer, and the user must have the capability to configure them independently, one can use two [Model Selector] keywords with unique names and the same list of [Model] keywords; however, the usage of the [Model Selector] is not limited to these examples. Many other combinations are possible.

### Example:

```
[Pin]
        signal_name
                        model_name
                                         R_pin
                                                 L_pin
                                                          C_pin
 1
                                         200.0m
                                                 5.0nH
        RAS0#
                         Progbuffer1
                                                          2.0pF
  2
        EN1#
                         Input1
                                         NA
                                                  6.3nH
                                                          NA
  3
        A0
                         3-state
  4
                         Progbuffer2
        D0
  5
        D1
                         Progbuffer2
                                         320.0m 3.1nH
                                                          2.2pF
  6
        D2
                         Progbuffer2
        RD#
                         Input2
                                         310.0m 3.0nH
                                                          2.0pF
                          POWER
  18
         Vcc3
[Model Selector]
                         Progbuffer1
OUT_2
            2 mA buffer without slew rate control
OUT_4
            4 mA buffer without slew rate control
OUT_6
            6 mA buffer without slew rate control
OUT_4S
            4 mA buffer with slew rate control
OUT_6S
            6 mA buffer with slew rate control
[Model Selector]
                         Progbuffer2
OUT 2
            2 mA buffer without slew rate control
            6 mA buffer without slew rate control \,
OUT_6
OUT_6S
            6 mA buffer with slew rate control
OUT_8S
            8 mA buffer with slew rate control
OUT_10S
           10 mA buffer with slew rate control
```

### **6 MODEL STATEMENT**

Keyword: [Model] Required: Yes

Description: Used to define a model, and its attributes.

*Sub-Params:* Model\_type, Polarity, Enable, Vinl, Vinh, C\_comp, C\_comp\_pullup, C\_comp\_pulldown, C\_comp\_power\_clamp, C\_comp\_gnd\_clamp, Vmeas, Cref, Rref, Vref

*Usage Rules:* Each model type must begin with the keyword [Model]. The model name must match the one that is listed under a [Pin], [Model Selector] or [Series Pin Mapping] keyword and must not contain more than 40 characters. A .ibs file must contain enough [Model] keywords to cover all of the model names specified under the [Pin], [Model Selector] and [Series Pin Mapping] keywords, except for those model names that use reserved words (POWER, GND and NC).

Model\_type must be one of the following:

Input, Output, I/O, 3-state, Open\_drain, I/O\_open\_drain, Open\_sink, I/O\_open\_sink, Open\_source, I/O\_open\_source, Input\_ECL, Output\_ECL, I/O\_ECL, 3-state\_ECL, Terminator, Series, and Series\_switch.

For true differential models documented under Section 6B, Model\_type must be one of the following:

Input\_diff, Output\_diff, I/O\_diff, and 3-state\_diff

Special usage rules for particular model types are provided in Table 1. Some definitions are included for clarification.

Table 1 Special Rules for Keyword [Model]

Model Type	Definition
Input I/O I/O_open_drain I/O_open_sink I/O_open_source	These model types must have Vinl and Vinh defined. If they are not defined, the parser issues a warning and the default values of Vinl = 0.8 V and Vinh = 2.0 V are assumed.
Input_ECL I/O_ECL	These model types must have Vinl and Vinh defined. If they are not defined, the parser issues a warning and the default values of Vinl = 0.8 V and Vinh = 2.0 V are assumed.
Terminator	This model type is an input-only model that can have analog loading effects on the circuit being simulated but has no digital logic thresholds. Examples of terminators are: capacitors, termination diodes, and pullup resistors.
Output	This model type indicates that an output always sources and/or sinks current and cannot be disabled.
3-state	This model type indicates that an output can be disabled, i.e., put into a high impedance state.

Table 1 Special Rules for Keyword [Model]

Model Type Definition		
Model Type	Definition	
Open_sink Open_drain	These model types indicate that the output has an OPEN side (do not use the [Pullup] keyword, or if it must be used, set $I=0$ mA for all voltages specified) and the output SINKS current. Open_drain model type is retained for backward compatibility.	
Open_source	This model type indicates that the output has an OPEN side (do not use the [Pulldown] keyword, or if it must be used, set $I=0$ mA for all voltages specified) and the output SOURCES current.	
Input_ECL Output_ECL I/O_ECL 3-state_ECL	These model types specify that the model represents an ECL type logic that follows different conventions for the [Pulldown] keyword.	
Series	This model type is for series models that can be described by [R Series], [L Series], [RI Series], [C Series], [Lc Series], [Rc Series], [Series Current] and [Series MOSFET] keywords.	
Series_switch	This model type is for series switch models that can be described by [On], [Off], [R Series], [L Series], [Rl Series], [C Series], [Lc Series], [Rc Series], [Series Current] and [Series MOSFET] keywords.	
Input_diff Output_diff I/O_diff 3-state_diff	These model types specify that the model defines a true differential model available directly through the [External Model] keyword documented in Section 6B.	

The Model\_type subparameter is required.

The C\_comp subparameter is required only when C\_comp\_pullup, C\_comp\_pulldown, C\_comp\_power\_clamp, and C\_comp\_gnd\_clamp are not present. If the C\_comp subparameter is not present, at least one of the C\_comp\_pullup, C\_comp\_pulldown, C\_comp\_power\_clamp, or C\_comp\_gnd\_clamp subparameters is required. It is not illegal to include the C\_comp subparameter together with one or more of the remaining C\_comp\_\* subparameters, but in that case the simulator will have to make a decision whether to use C\_comp or the C\_comp\_pullup, C\_comp\_pulldown, C\_comp\_power\_clamp, and C\_comp\_gnd\_clamp subparameters. Under no circumstances should the simulator use the value of C\_comp simultaneously with the values of the other C\_comp\_\* subparameters.

C\_comp\_pullup, C\_comp\_pulldown, C\_comp\_power\_clamp, and C\_comp\_gnd\_clamp are intended to represent the parasitic capacitances of those structures whose I-V characteristics are described by the [Pullup], [Pulldown], [POWER Clamp] and [GND Clamp] I-V tables. For this reason, the simulator should generate a circuit netlist so that, if defined, each of the C\_comp\_\*

capacitors are connected in parallel with their corresponding I-V tables, whether or not the I-V table exists. That is, the C\_comp\_\* capacitors are positioned between the signal pad and the nodes defined by the [Pullup Reference], [Pulldown Reference], [POWER Clamp Reference] and [GND Clamp Reference] keywords, or the [Voltage Range] keyword and GND.

The C\_comp and C\_comp\_\* subparameters define die capacitance. These values should not include the capacitance of the package. C\_comp and C\_comp\_\* are allowed to use 'NA' for the min and max values only.

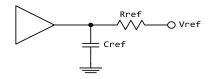
The Polarity, Enable, Vinl, Vinh, Vmeas, Cref, Rref, and Vref subparameters are optional.

Also, optional Rref\_diff and Cref\_diff subparameters discussed further in Section 6B support the true differential buffer timing test loads. They are used only when the [Diff Pin] keyword connects two models, and each buffer references the same model. The Rref\_diff and Cref\_diff subparameters can be used with the Rref, Cref, and Vref subparameters for a combined differential and signal-ended timing test load. Single-ended test loads are permitted for differential applications.

The Rref\_diff and Cref\_diff are recognized only when the [Diff Pin] keyword connects the models. This applies for the true differential buffers in Section 6B and also for differential buffers using identical single-ended models.

The Polarity subparameter can be defined as either Non-Inverting or Inverting, and the Enable subparameter can be defined as either Active-High or Active-Low.

The Cref and Rref subparameters correspond to the test load that the semiconductor vendor uses when specifying the propagation delay and/or output switching time of the model. The Vmeas subparameter is the timing reference voltage level that the semiconductor vendor uses for the model. Include Cref, Rref, Vref, and Vmeas information to facilitate board-level timing simulation. The assumed connections for Cref, Rref, and Vref are shown in Figure 1.



**Figure 1 - Reference Load Connections** 

A single-ended or true differential buffer can have Rref\_diff and Cref\_diff (Figure 2).

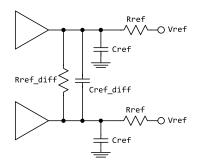


Figure 2 - Single-Ended or True Differential Buffer

Other Notes: A complete [Model] description normally contains the following keywords: [Voltage Range], [Pullup], [Pulldown], [GND Clamp], [POWER Clamp], and [Ramp]. A Terminator model may use the [Rgnd], [Rpower], [Rac], and [Cac] keywords. However, some models may have only a subset of these keywords. For example, an input structure normally only needs the [Voltage Range], [GND Clamp], and possibly the [POWER Clamp] keywords. If any of [Rgnd], [Rpower], [Rac], and [Cac] keywords is used, then the Model\_type must be Terminator.

## Examples:

```
Polarity
                Non-Inverting
Enable
                Active-High
                                         Input logic "low" DC voltage, if any
Vinl = 0.8V
Vinh = 2.0V
                                         | Input logic "high" DC voltage, if any
Vmeas = 1.5V
                            Reference voltage for timing measurements
Cref = 50pF
                            Timing specification test load capacitance value
Rref = 500
                            Timing specification test load resistance value
Vref = 0
                            Timing specification test load voltage
 variable
                   typ
                                    min
                                                    max
C_comp
                   7.0pF
                                    5.0pF
                                                    9.0pF
                                                    3.5pF
                   3.0pF
                                    2.5pF
                                                             These four can be
C_comp_pullup
C_comp_pulldown
                   2.0pF
                                    1.5pF
                                                     2.5pF
                                                             used instead of
C_comp_power_clamp 1.0pF
                                    0.5pF
                                                    1.5pF
                                                             C comp
C_comp_gnd_clamp
                   1.0pF
                                    0.5pF
                                                    1.5pF
```

#### For a single-ended or true differential buffer (Section 6B):

```
[Model]
                External_Model_Diff
Model_type
                I/O_diff
                                       | Requires [External Model]
               Non-Inverting
Polarity
Enable
                Active-High
The [Diff Pin] vdiff value overrides the thresholds below
Vinl = 0.8V
                                         Input logic "low" DC voltage, if any
Vinh = 2.0V
                                         Input logic "high" DC voltage, if any
                           The true differential measurement point is at
                           the crossover voltage
                           The Vmeas value is overridden
Vmeas = 1.5V
                           Reference voltage for timing measurements
                           Single-ended timing test load is still permitted
Cref = 5pF
                           Timing specification test load capacitance value
Rref = 500
                           Timing specification test load resistance value
Vref = 0
                           Timing specification test load voltage
                           These new subparameters are permitted for
                           single-ended differential operation based on the
                           [Diff Pin] keyword
Rref_diff = 100
                           Timing specification differential resistance value
Cref_diff = 5pF
                           Timing specification differential capacitance value
```

Keyword: [Model Spec]

Required: No

Sub-Params: Vinh, Vinl, Vinh+, Vinh-, Vinl+, Vinl-, S\_overshoot\_high, S\_overshoot\_low, D\_overshoot\_high, D\_overshoot\_low, D\_overshoot\_time, D\_overshoot\_area\_h, D\_overshoot\_area\_l, D\_overshoot\_ampl\_h, D\_overshoot\_ampl\_l, Pulse\_high, Pulse\_low, Pulse\_time, Vmeas, Vref, Cref, Rref, Cref\_rising, C\_ref\_falling, Rref\_rising, Rref\_falling, Vref\_rising, Vref\_falling, Vmeas\_rising, Vmeas\_falling, Rref\_diff, Cref\_diff, Weak\_R, Weak\_I, Weak\_V

Description: The [Model Spec] keyword defines four columns under which specification subparameters are defined.

The following subparameters are defined:

Vinh Input voltage threshold high

Vinl Input voltage threshold low

Vinh+ Hysteresis threshold high max Vt+ Vinh-Hysteresis threshold high min Vt+ Vinl+ Hysteresis threshold low max Vt-Vinl-Hysteresis threshold low min Vt-S\_overshoot\_high Static overshoot high voltage S\_overshoot\_low Static overshoot low voltage D overshoot high Dynamic overshoot high voltage D overshoot low Dynamic overshoot low voltage

D\_overshoot\_area\_h
D\_overshoot\_area\_l
D\_overshoot\_ampl\_h
D\_overshoot\_ampl\_l
D\_overshoot\_ampl\_l
D\_overshoot\_ampl\_l
D\_overshoot\_ampl\_l

Pulse\_high Pulse immunity high voltage
Pulse\_low Pulse immunity low voltage

Pulse\_time Pulse immunity time

Vmeas Measurement voltage for timing measurements

Vref Timing specification test load voltage
Cref Timing specification capacitive load
Rref Timing specification resistance load

Timing specification capacitive load for rising edges Cref\_rising Cref\_falling Timing specification capacitive load for falling edges Rref\_rising Timing specification resistance load for rising edges Rref\_falling Timing specification resistance load for falling edges Vref\_rising Timing specification test load voltage for rising edges Timing specification test load voltage for falling edges Vref\_falling Measurement voltage for rising edge timing measurements Vmeas\_rising Vmeas\_falling Measurement voltage for falling edge timing measurements

Rref\_diff Timing specification differential resistance load
Cref\_diff Timing specification differential capacitive load

Weak\_R Weak tie-up or tie-down resistance
Weak\_I Weak tie-up or tie-down current

### Weak\_V Weak tie-up or tie-down voltage

Usage Rules: [Model Spec] must follow all other subparameters under the [Model] keyword. For each subparameter contained in the first column, the remaining three columns hold its typical, minimum and maximum values The entries of typical, minimum, and maximum must be placed on a single line and must be separated by at least one white space. All four columns are required under the [Model Spec] keyword. However, data is required only in the typical column. If minimum and/or maximum values are not available, the reserved word 'NA' must be used indicating the typical value by default.

The minimum and maximum values are used for specifications subparameter values that may track the min and max operation conditions of the [Model]. Usually it is related to the Voltage Range settings.

Unless noted below, no subparameter requires having present any other subparameter.

#### Vinh, Vinl rules:

The threshold subparameter lines provide additional min and max column values, if needed. The typ column values are still required and would be expected to override the Vinh and Vinl subparameter values specified elsewhere. Note that the syntax rule that requires inserting Vinh and Vinl under models remains unchanged even if the values are defined under the [Model Spec] keyword.

#### Vinh+, Vinh-, Vinl+, Vinl- rules:

The four hysteresis subparameters (used for Schmitt trigger inputs for defining two thresholds for the rising edges and two thresholds for falling edges) must all be defined before independent input thresholds for rising and falling edges of the hysteresis threshold rules become effective. Otherwise the standard threshold subparameters remain in effect. The hysteresis thresholds shall be at the Vinh+ and Vinh- values for a low-to-high transition, and at the Vinl+ and Vinl- values for a high-to-low transition. See Figure 3.

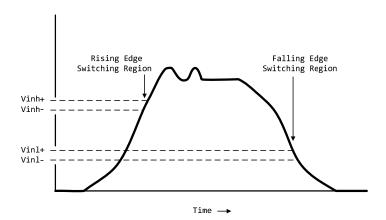


Figure 3 - Receiver Voltage with Hysteresis Thresholds

# S\_overshoot\_high, S\_overshoot\_low rules:

The static overshoot subparameters provide the DC voltage values for which the model is no longer guaranteed to function correctly. Often these voltages are given as absolute maximum ratings. However, if any lower \*\_overshoot\_high or higher \*\_overshoot\_low limit for functional specification compliance exists, that limit should be used.

# D\_overshoot\_high, D\_overshoot\_low, D\_overshoot\_time rules:

The dynamic overshoot values provide a time window during which the overshoot may exceed the static overshoot limits but be below the dynamic overshoot limits and still guarantee functional specification compliance. D\_overshoot\_time is required for dynamic overshoot testing. In addition, if D\_overshoot\_high is specified, then S\_overshoot\_high is necessary for testing beyond the static limit. Similarly, if D\_overshoot\_low is specified, then S\_overshoot\_low is necessary for testing beyond the static limit. See Figure 4.

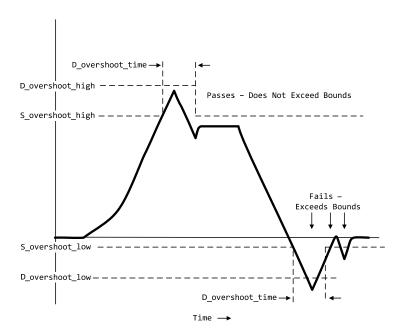


Figure 4 - Receiver Voltage with Static and Dynamic Overshoot Limits

D\_overshoot\_area\_h, D\_overshoot\_area\_l, D\_overshoot\_ampl\_h, D\_overshoot\_ampl\_l rules:

The dynamic overshoot area values define a maximum V-s area that an overshooting signal must not exceed. The high area is calculated from the point that a signal overshoots above the voltage defined by the [Power Clamp Reference] keyword until the point that the signal crosses back through this same voltage. Note that the area is defined as the complete area-under-thecurve as bounded by the limits defined above and not a "triangular" area, as shown in Figure 5. If [Power Clamp Reference] is not defined, then this crossing voltage is assumed to be defined by the [Voltage Range] keyword. The low area is calculated from the point that a signal overshoots below the voltage defined by the [GND Clamp Reference] keyword until the point that the signal crosses back through this same voltage. If [GND Clamp Reference] is not defined, then this crossing voltage is assumed to be 0.0 V. If D\_overshoot\_area\_h is specified, then D\_overshoot\_ampl\_h must also be specified. D\_overshoot\_ampl\_h provides a maximum amplitude allowed for the overshoot area and is measured as voltage above the [Power Clamp Reference] voltage. Similarly, if D overshoot area 1 is specified, then D overshoot ampl 1 must also be specified. Dovershoot ampl 1 is measured as voltage below the [GND Clamp Reference] voltage. Both amplitude parameters should be listed as absolute (non-negative) values. Also, if D\_overshoot\_area\_h, D\_overshoot\_area\_l, D\_overshoot\_ampl\_h, and D\_overshoot\_ampl\_l are specified, then other static and dynamic overshoot parameters are optional.

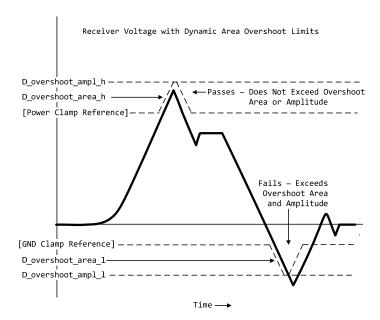


Figure 5 - Receiver Voltage with Dynamic Area Overshoot Limits

Pulse\_high, Pulse\_low, Pulse\_time rules:

The pulse immunity values provide a time window during which a rising pulse may exceed the nearest threshold value but be below the pulse voltage value and still not cause the input to switch. Pulse\_time is required for pulse immunity testing. A rising response is tested only if Pulse\_high is specified. Similarly, a falling response is tested only if Pulse\_low is specified. The rising response may exceed the Vinl value, but remain below the Pulse\_high value.

Similarly, the falling response may drop below the Vinh value, but remain above the Pulse\_low value. In either case the input is regarded as immune to switching if the responses are within these extended windows. If the hysteresis thresholds are defined, then the rising response shall use Vinh- as the reference voltage, and the falling response shall use Vinl+ as the reference voltage. See Figure 6.

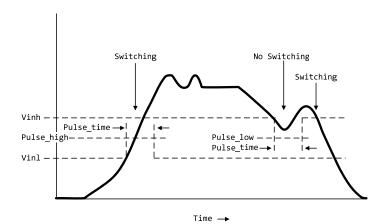


Figure 6 - Receiver Voltage with Pulse Immunity Thresholds

## Vmeas, Vref, Cref, Rref rules:

The Vmeas, Vref, Cref and Rref values under the [Model Spec] keyword override their respective values entered elsewhere. Note that a Vmeas, Vref, Cref or Rref subparameters may not be used if its edge specific version (\*\_rising or \*\_falling) is used.

Cref\_rising, Cref\_falling, Rref\_rising, Rref\_falling, Vref\_rising, Vref\_falling, Vmeas\_rising, Vmeas\_falling rules:

Use these subparameters when specifying separate timing test loads and voltages for rising and falling edges. If one 'rising' or 'falling' subparameter is used, then the corresponding 'rising' or 'falling' subparameter must be present. The values listed in these subparameters override any corresponding Cref, Vref, Rref or Vmeas values entered elsewhere.

# Rref\_diff, Cref\_diff rules:

The Rref\_diff and Creff\_diff values under the [Model Spec] keyword override their respective values entered elsewhere. These subparameters are used only when the model is referenced by the [Diff Pin] keyword. These follow the same rules as the corresponding subparameters documented under the [Model] keyword. See Section 6B for more discussion on true and single-ended differential operation.

# Weak\_R, Weak\_I, and Weak\_V rules:

If an IO circuit uses a simple weak tie-up or tie-down device (resistor or transistor) between the chip IO pad and a power supply, Weak\_R stores the resistance of this device and Weak\_V stores the voltage of the power supply to which the device is connected. A Weak\_I stores the approximate current into the device and Weak\_V stores the voltage of the power supply. They apply to both static and configurable tie-up and tie-down devices.

The Weak\_R, Weak\_I, and Weak\_V subparameters are optional and separate from the current-voltage table keywords, e.g., [Pullup], [GND Clamp], etc. They do not affect how the current-voltage tables are extracted.

(Weak\_R and Weak\_V) or (Weak\_I and Weak\_V) must always be used as a pair. Weak\_R and Weak\_I must not be used together.

The current flow convention for Weak\_I is similar to that of [GND Clamp] and {POWER Clamp] tables. A positive sign documents a weak tie-down current. A negative sign documents a weak tie-up current.

# Examples:

[Model Creat				
[Model Spec]   Subparameter	typ	min	max	
	СУР	11111	IIICX	
Thresholds				
 Vinh	3.5	2 1 5	3.85	70% of Vcc
Vinl	1.5	3.15 1.35	1.65	70% OI VCC 30% of Vcc
V I I I I	1.5	1.35	1.05	30% OI VCC
   Vinh	3.835	3.335	4.335 l	Offset from Vcc
Vinl	3.525	3.025	4.025	for PECL
j			'	
Hysteresis				
 Vinh+	2.0	NA	NA I	Overrides the
Vinh-	1.6	NA NA	NA I	thresholds
Vinl+	1.1	NA	NA I	ciii esiio i as
Vinl-	0.6	NA	NA I	All 4 are required
1				
Overshoot				
 S_overshoot_high	5.5	5.0	6.0 l	Static overshoot
	-0.5	NA	NA	Static Overshoot
D_overshoot_high	6.0	5.5	6.5 I	Dynamic overshoot
			-1.0	requires
	1.0	1.0	1.0	D overshoot time
D overshoot time	20n	20n	20n	& static overshoot
			'	
Overshoot defined by ar	ea in V-s (	Values from	DDR2 spec	cification)
D_overshoot_ampl_h	0.9	NA	NA	Dynamic overshoot
D_overshoot_ampl_l	0.9	NA	NA	requires area
D_overshoot_area_h	0.38n	NA	NA	and amplitude
D_overshoot_area_l	0.38n	NA	NA	parameters
Pulse Immunity				
1				
Pulse_high	3V	NA	NA	Pulse immunity
Pulse_low	0	NA	NA	requires

Pulse_time	3n	NA	NA	Pulse_time
   Timing Thresholds				
Vmeas	3.68	3.18	4.68	A 5 volt PECL   example
Timing test load voltage	ge reference	e example		
Vref	1.25	1.15	1.35	An SSTL-2 example
Rising and falling tim:   specification)	ing test loa	ad example	(values f	From PCI-X
 Cref_falling	10p	10p	10p	
Cref_rising	10p	10p	10p	
Rref_rising	25	500	25	typ value not specified
Rref_falling	25	500	25	typ value not specified
Vref_rising	0	1.5	0	
Vref_falling	3.3	1.5	3.6	
Vmeas_rising	0.941	0.885	1.026	vmeas = 0.285(vcc)
Vmeas_falling	2.0295	1.845	2.214	vmeas = 0.615(vcc)
   Differential timing tes	st load for	true or si	ngle-ende	ed differential model
Rref diff	100	90	110	
Cref diff	5pF	NA	NA	
   Weak tie-up examples:	-			
Weak R	10k	NA	NA	
Weak_V	1.5V	NA	NA	
 Weak_I	-10u	NA	NA   r	negative sign for
Weak_V	1.5V	NA	NA   t	tie-up current

*Keyword:* [Receiver Thresholds]

Required: No

Sub-Params: Vth, Vth\_min, Vth\_max, Vinh\_ac, Vinh\_dc, Vinl\_ac, Vinl\_dc,

Threshold\_sensitivity, Reference\_supply, Vcross\_low, Vcross\_high, Vdiff\_ac, Vdiff\_dc, Tslew\_ac, Tdiffslew\_ac

*Description:* The [Receiver Thresholds] keyword defines both a set of receiver input thresholds as well as their sensitivity to variations in a referenced supply. The subparameters are defined as follows:

Vth, Vth\_min, and Vth\_max are the ideal input threshold voltages at which the output of a digital logic receiver changes state. Vth is the nominal input threshold voltage under the voltage, temperature and process conditions that define 'typ'. Vth\_min is the minimum input threshold voltage at 'typ' conditions while Vth\_max is the maximum input threshold voltage at 'typ' conditions.

Vinh\_ac is the voltage that a low-to-high going input waveform must reach in order to guarantee that the receiver's output has changed state. In other words, reaching Vinh\_ac is sufficient to guarantee a receiver state change. Vinh\_ac is expressed as an offset from Vth.

Vinh\_dc is the voltage that an input waveform must remain above (more positive than) in order to guarantee that a receiver output will NOT change state. Vinh\_dc is expressed as an offset from Vth.

Vinl\_ac is the voltage that a high-to-low going input waveform must reach in order to guarantee that the receiver's output has changed state. In other words, reaching Vinl\_ac is sufficient to guarantee a receiver state change. Vinl\_ac is expressed as an offset from Vth.

Vinl\_dc is the voltage that an input waveform must remain below (more negative than) in order to guarantee that a receiver's output will NOT change state. Vinl\_dc is expressed as an offset from Vth.

Threshold\_sensitivity is a unit-less number that specifies how Vth varies with respect to the supply voltage defined by the Reference\_supply subparameter. Threshold\_sensitivity is defined as:

$$Threshold\_sensitivity = \frac{change\ in\ input\ threshold\ voltage}{change\ in\ referenced\ supply\ voltage}$$

Threshold\_sensitivity must be entered as a whole number or decimal, not as a fraction.

Reference\_supply indicates which supply voltage Vth tracks; i.e., it indicates which supply voltage change causes a change in input threshold. The legal arguments to this subparameter are as follows:

		*
Power_clamp_ref	The supply voltage defined by the	[POWER Clamp Reference] keyword
Gnd_clamp_ref	The supply voltage defined by the	[GND Clamp Reference] keyword
Pullup_ref	The supply voltage defined by the	[Pullup reference] keyword
Pulldown_ref	The supply voltage defined by the	[Pulldown reference] keyword
Ext ref	The supply voltage defined by the	[External Reference] keyword

Tslew\_ac and Tdiffslew\_ac measure the absolute difference in time between the point at which an input waveform crosses Vinl\_ac and the point it crosses Vinl\_ac. The purpose of this parameter is to document the maximum amount of time an input signal may take to transition between Vinl\_ac and Vinl\_ac and still allow the device to meet its input setup and hold specifications. Tslew\_ac is the parameter used for single ended receivers while Tdiffslew\_ac must be used for receivers with differential inputs.

Vcross\_low is the least positive voltage at which a differential receiver's input signals may cross while switching and still allow the receiver to meet its timing and functional specifications. Vcross\_low is specified with respect to 0 V.

Vcross\_high is the most positive voltage at which a differential receiver's input signals may cross while switching and still allow the receiver to meet its timing and functional specifications. Vcross\_high is specified with respect to 0 V.

Vdiff\_dc is the minimum voltage difference between the inputs of a differential receiver that guarantees the receiver will not change state.

Vdiff\_ac is the minimum voltage difference between the inputs of a differential receiver that guarantees the receiver will change state.

*Usage Rules*: [Receiver Thresholds] must follow all subparameters under the [Model] keyword and precede all other keywords of a model except [Model Spec].

The [Receiver Thresholds] keyword is valid if the model type includes any reference to input or I/O. For single ended receivers the Vinh\_ac, Vinh\_dc, Vinh\_ac, Vinh\_dc, Vth and Tslew\_ac subparameters are required and override the Vinh, Vinl, Vinh+/- and Vinl+/- subparameters declared under the [Model] or [Model Spec] keywords. For single ended receivers the Vth\_min, Vth\_max, Threshold\_sensitivity and Reference\_supply subparameters are optional. However, if the Threshold\_sensitivity subparameter is present then the Reference\_supply subparameter must also be present.

For differential receivers (i.e., the [Receiver Thresholds] keyword is part of a [Model] statement that describes a pin listed in the [Diff Pin] keyword), the Vcross\_low, Vcross\_high, Vdiff\_ac, Vdiff\_dc and Tdiffslew\_ac subparameters are required. The rest of the subparameters are not applicable. The Vdiff\_ac and Vdiff\_dc values override the value of the vdiff subparameter specified by the [Diff Pin] keyword. Note that Vcross\_low and Vcross\_high are valid over the device's minimum and maximum operating conditions.

## Subparameter Usage Rules:

Numerical arguments are separated from their associated subparameter by an equals sign (=); white space around the equals sign is optional. The argument to the Reference\_supply subparameter is separated from the subparameter by white space.

Vth at Minimum or Maximum Operating Conditions:

As described above, the Vth\_min and Vth\_max subparameters define the minimum and maximum input threshold values under typical operating conditions. There is no provision for directly specifying Vth under minimum or maximum operating conditions. Instead, these values are calculated using the following equation:

```
Vth(min/max) = Vth* + [(Threshold\_sensitivity) X (change in supply voltage)]
```

where Vth\* is either Vth, Vth\_min or Vth\_max as appropriate, and the supply voltage is the one indicated by the Reference\_supply subparameter. Vth\*

### Examples:

A basic 3.3 V single ended receiver using only the required subparameters.

```
[Receiver Thresholds]
Vth = 1.5V
Vinh_ac = +225mV
Vinh_dc = +100mV
Vinl_ac = -225mV
Vinl_dc = -100mV
Tslew_ac = 1.2ns
```

A single ended receiver using an external threshold reference. In this case the input threshold is the external reference voltage so Threshold\_sensitivity equals 1.

```
[Receiver Thresholds]
Vth = 1.0V
Threshold_sensitivity = 1
Reference_supply Ext_ref
Vinh_ac = +200mV
Vinh_dc = +100mV
```

```
Vinl_ac = -200mV
Vinl_dc = -100mV
Tslew_ac = 400ps
```

### A fully specified single ended 3.3 V CMOS receiver:

```
[Receiver Thresholds]
Vth = 1.5V
Vth_min = 1.45V
Vth_max = 1.53V
Threshold_sensitivity = 0.45
Reference_supply Power_clamp_ref
Vinh_ac = +200mV
Vinh_dc = +100mV
Vinl_ac = -200mV
Vinl_dc = -100mV
Tslew_ac = 400ps
```

#### A differential receiver:

[Receiver Thresholds]
Vcross\_low = 0.65V
Vcross\_high = 0.90V
Vdiff\_ac = +200mV
Vdiff\_dc = +100mV
Tdiffslew\_ac = 200ps

Keyword: [Add Submodel]

Required: No

Description: References a submodel to be added to an existing model.

*Usage Rules:* The [Add Submodel] keyword is invoked within a model to add the functionality that is contained in the submodel or list of submodels in each line that follows. The first column contains the submodel name. The second column contains a submodel mode under which the submodel is used.

If the top-level model type is one of the I/O or 3-state models, the submodel mode may be Driving, Non-Driving, or All. For example, if the submodel mode is Non-Driving, then the submodel is used only in the high-Z state of a 3-state model. Set the submodel mode to All if the submodel is to be used for all modes of operation.

The submodel mode cannot conflict with the top-level model type. For example, if the top-level model type is an Open or Output type, the submodel mode cannot be set to Non-Driving. Similarly, if the top-level model type is Input, the submodel mode cannot be set to Driving.

The submodel mode can be set to All to cover all permitted modes for any top-level model type including, for example, Input, Output, and I/O.

The [Add Submodel] keyword is not defined for Series or Series\_switch model types.

Refer to the Add Submodel description in Section 6A of this document for the descriptions of available submodels.

Example:

[Add Submodel]

Keyword: [Driver Schedule]

Required: No

Description: Describes the relative model switching sequence for referenced models to produce a multi-staged driver.

*Usage Rules:* The [Driver Schedule] keyword establishes a hierarchical order between models and should be placed under the [Model] which acts as the top-level model. The scheduled models are then referenced from the top-level model by the [Driver Schedule] keyword.

When a multi-staged buffer is modeled using the [Driver Schedule] keyword, all of its stages (including the first stage, or normal driver) have to be modeled as scheduled models.

If there is support for this feature in a EDA tool, the [Driver Schedule] keyword will cause it to use the [Pulldown], [Pulldown Reference], [Pullup], [Pullup Reference], [Voltage Range], [Ramp], [Rising Waveform] and [Falling Waveform] keywords from the scheduled models instead of the top-level model, according to the timing relationships described in the [Driver Schedule] keyword. Consequently, the keywords in the above list will be ignored in the top-level model. All of the remaining keywords not shown in the above list, and all of the subparameters will be used from the top-level model and should be ignored in the scheduled model(s).

However, both the top-level and the scheduled model(s) have to be complete models, i.e., all of the required keywords must be present and follow the syntactical rules.

For backwards compatibility reasons and for EDA tools which do not support multi-staged switching, the keywords in the above list can be used in the top-level [Model] to describe the overall characteristics of the buffer as if it was a composite model. It is not guaranteed, however, that such a top-level model will yield the same simulation results as a full multi-stage model. It is recommended that a "golden waveform" for the device consisting of a [Rising Waveform] table and a [Falling Waveform] table be supplied in the top-level model to serve as a reference for validation.

Even though some of the keywords are ignored in the scheduled model, it may still make sense in some cases to supply correct data with them. One such situation would arise when a [Model] is used both as a regular top-level model as well as a scheduled model.

The [Driver Schedule] table consists of five columns. The first column contains the model names of other models that exist in the .ibs file. The remaining four columns describe delays: Rise\_on\_dly, Rise\_off\_dly, Fall\_on\_dly, and Fall\_off\_dly. The t=0 time of each delay is the event when the EDA tool's internal pulse initiates a rising or falling transition. All specified delay values must be equal to or greater than 0. There are only five valid combinations in which these delay values can be defined:

- 1) Rise\_on\_dly with Fall\_on\_dly
- 2) Rise\_off\_dly with Fall\_off\_dly

- 3) Rise\_on\_dly with Rise\_off\_dly
- 4) Fall\_on\_dly with Fall\_off\_dly
- 5) All four delays defined

(be careful about correct sequencing)

The four delay parameters have the meaning as described below. (Note that this description applies to buffer types which have both pullup and pulldown structures. For those buffer types which have only a pullup or pulldown structure, the description for the missing structure can be omitted.)

Rise\_on\_dly is the amount of time that elapses from the internal simulator pulse initiating a RISING edge to the t=0 time of the waveform or ramp that turns the I-V table of the PULLUP device ON, and the t=0 time of the waveform or ramp that turns the I-V table of the PULLDOWN device OFF (if they were not already turned ON and OFF, respectively, by another event).

Rise\_off\_dly is the amount of time that elapses from the internal simulator pulse initiating a RISING edge to the t=0 time of the waveform or ramp that turns the I-V table of the PULLUP device OFF, and the t=0 time of the waveform or ramp that turns the I-V table of the PULLDOWN device ON (if they were not already turned ON and OFF, respectively, by another event).

Fall\_on\_dly is the amount of time that elapses from the internal simulator pulse initiating a FALLING edge to the t=0 time of the waveform or ramp that turns the I-V table of the PULLDOWN device ON, and the t=0 time of the waveform or ramp that turns the I-V table of the PULLUP device OFF (if they were not already turned ON and OFF, respectively, by another event).

Fall\_off\_dly is the amount of time that elapses from the internal simulator pulse initiating a FALLING edge to the t=0 time of the waveform or ramp that turns the I-V table of the PULLDOWN device OFF, and the t=0 time of the waveform or ramp that turns the I-V table of the PULLUP device ON (if they were not already turned ON and OFF, respectively, by another event).

In the above four paragraphs, the word "event" refers to the moment in time when the delay is triggered by the stimulus. This stimulus is provided to the top-level model by the simulation tool. The expiration of delays cannot generate events.

Note that some timing combinations may only be possible if the two halves of a complementary buffer are modeled separately as two open\_\* models.

No [Driver Schedule] table may reference a model which itself has within it a [Driver Schedule] keyword.

Use 'NA' when no delay value is applicable. For each scheduled model the transition sequence must be complete, i.e., the scheduled model must return to its initial state.

Only certain numerical entry combinations are permitted to define a complete transition sequence. Table 2 gives the initial scheduled model states for each permitted set of numerical entries. The numerical delay entries, r, r1, and r2 are relative to the internal simulator pulse rising edge, and f, f1, and f2 are the numerical delay entries relative to internal simulator pulse falling edge. For the cases where two delays are given relative to the same edge, the r2 entry is larger than the r1 entry, and the f2 entry is larger than the f1 entry. For cases below, the interchanging of such values corresponds to opposite direction switching. Once the scheduled model is set to its initial state, the switching is controlled by the internal simulator pulse and delays relative to it.

In Table 2, the scheduled model initial states depend on the initial state of the [Model]. This top-level [Model] state ('Low' or 'High') is a function of the stimulus pulse (or simulation control method) and the [Model] Polarity subparameter. For example, if a [Model] Polarity is Inverting and its stimulus pulse starts high, the [Model] initial state is 'Low' and all scheduled model initial states follow the settings under the 'Low' column. Two possible four-data ordering combinations are omitted because their initial states are ambiguous. Special rules to select the initial states would produce sequencing equivalent to the two-data combinations shown in the first two lines of the table.

Table 2 Scheduled Model Initial State

Table Numerical Delay Entries				[Model] In	nitial State
Rise_on	Rise_off	Fall_on	Fall_off	Low	High
R	NA	f	NA	Low	High
NA	r	NA	f	High	Low
r1	r2	NA	NA	Low	Low
r2	r1	NA	NA	High	High
NA	NA	f1	f2	High	High
NA	NA	f2	f1	Low	Low
r1	r2	f2	f1	Low	Low
r2	r1	f1	f2	High	High

The delay numbers r, r1, r2, and f, f1, f2 plus the associated model transitions should fit within the corresponding pulse width durations. Smaller pulse width stimuli may change the switching sequencing and is not supported.

*Other Notes:* The added models typically consist of Open\_sink (Open\_drain) or Open\_source models to provide sequentially increased drive strengths. The added drive may be removed within the same transition for a momentary boost or during the opposite transition.

The syntax also allows for reducing the drive strength.

Note that the Rise\_on\_dly, Rise\_off\_dly, Fall\_on\_dly, Fall\_off\_dly parameters are single value parameters, so typical, minimum and maximum conditions cannot be described with them directly. In order to account for those effects, one can refer to the fastest waveform table with the delay number and then insert an appropriate amount of horizontal lead in section in those waveforms which need more delay.

Notice that the C\_comp parameter of a multi-stage buffer is defined in the top-level model. The value of C\_comp therefore includes the total capacitance of the entire buffer, including all of its stages. Since the rising and falling waveform measurements include the effects of C\_comp, each of these waveforms must be generated with the total C\_comp present, even if the various stages of the buffer are characterized individually.

*Note:* In a future release, the [Driver Schedule] keyword may be replaced by a newer method of specification that is consistent with some other planned extensions. However, the [Driver Schedule] syntax will continue to be supported.

### Example:

```
[Driver Schedule]
 Model_name
                Rise_on_dly Rise_off_dly Fall_on_dly Fall_off_dly
 MODEL_OUT
                0.0ns
                                           0.0ns
 Examples of added multi-staged transitions
 M O SOURCE1
                                            0.5ns
                 0.5ns
                                                         NA
                              NA
              low (high-Z) to high
                                          high to low (high-Z)
 M_O_SOURCE2
                0.5n
                            1.5n
                                          NA
                                                        NA
               low to high to low
                                            low (high-Z)
 M_O_DRAIN1
                1.0n
                             NA
                                           1.5n
                                          high (high-Z) to low
              low to high (high-Z)
 M_O_DRAIN2
                                           1.5n
                                                        2.0n
                             NA
                  high (high-Z)
                                          high to low to high
```

# Keyword: [Temperature Range]

Required: Yes, if other than the preferred 0, 50, 100 degree Celsius range Description: Defines the temperature range over which the model is to operate.

Usage Rules: List the actual die temperatures (not percentages) in the typ, min, max format. 'NA' is allowed for min and max only.

Other Notes: The [Temperature Range] keyword also describes the temperature range over which the various I-V tables and ramp rates were derived. Refer to Section 9, "NOTES ON DATA DERIVATION METHOD" for rules on which temperature values to put in the 'min' and 'max' columns.

# Example:

variable	typ	min	max
[Temperature Range]	27.0	-50	130.0

## Keyword: [Voltage Range]

Required: Yes, if [Pullup Reference], [Pulldown Reference], [POWER Clamp Reference], and [GND Clamp Reference] are not present

*Description:* Defines the power supply voltage tolerance over which the model is intended to operate. It also specifies the default voltage rail to which the [Pullup] and [POWER Clamp] I-V data is referenced.

Usage Rules: Provide actual voltages (not percentages) in the typ, min, max format. 'NA' is allowed for the min and max values only.

Other Notes: If the [Voltage Range] keyword is not present, then all four of the keywords described below must be present: [Pullup Reference], [Pulldown Reference], [POWER Clamp Reference], and [GND Clamp Reference]. If the [Voltage Range] is present, the other keywords are optional and may or may not be used as required. It is legal (although redundant) for an optional keyword to specify the same voltage as specified by the [Voltage Range] keyword.

## Example:

variable	typ	min	max
[Voltage Range]	5.0V	4.5V	5.5V

### *Keyword:* [Pullup Reference]

Required: Yes, if the [Voltage Range] keyword is not present

Description: Defines a voltage rail other than that defined by the [Voltage Range] keyword as the reference voltage for the [Pullup] I-V data.

Usage Rules: Provide actual voltages (not percentages) in the typ, min, max format. 'NA' is allowed for the min and max values only.

Other Notes: This keyword, if present, also defines the voltage range over which the typ, min, and max dV/dt\_r values are derived.

## Example:

variable	typ	min	max
[Pullup Reference]	5.0V	4.5V	5.5V

## Keyword: [Pulldown Reference]

Required: Yes, if the [Voltage Range] keyword is not present

Description: Defines a power supply rail other than 0 V as the reference voltage for the [Pulldown] I-V data. If this keyword is not present, the voltage data points in the [Pulldown] I-V table are referenced to 0 V.

Usage Rules: Provide actual voltages (not percentages) in the typ, min, max format. 'NA' is allowed for the min and max values only.

Other Notes: This keyword, if present, also defines the voltage range over which the typ, min, and max dV/dt\_f values are derived.

# Example:

variable	typ	min	max
[Pulldown Reference]	0V	0V	0V

## Keyword: [POWER Clamp Reference]

Required: Yes, if the [Voltage Range] keyword is not present

Description: Defines a voltage rail other than that defined by the [Voltage Range] keyword as the reference voltage for the [POWER Clamp] I-V data.

Usage Rules: Provide actual voltages (not percentages) in the typ, min, max format. 'NA' is allowed for the min and max values only.

Other Notes: Refer to the "Other Notes" section of the [GND Clamp Reference] keyword.

# Example:

```
variable typ min max [POWER Clamp Reference] 5.0V 4.5V 5.5V
```

Keyword: [GND Clamp Reference]

Required: Yes, if the [Voltage Range] keyword is not present

Description: Defines a power supply rail other than 0 V as the reference voltage for the [GND Clamp] I-V data. If this keyword is not present, the voltage data points in the [GND Clamp] I-V table are referenced to 0 V.

Usage Rules: Provide actual voltages (not percentages) in the typ, min, max format. 'NA' is allowed for the min and max values only.

Other Notes: Power Supplies: It is intended that standard TTL and CMOS models be specified using only the [Voltage Range] keyword. However, in cases where the output characteristics of a model depend on more than a single supply and ground, or a [Pullup], [Pulldown], [POWER Clamp], or [GND Clamp] table is referenced to something other than the default supplies, use the additional 'reference' keywords.

## Example:

variable	typ	min	max
[GND Clamp Reference]	VO	0V	0V

Keyword: [External Reference]

Required: Yes, if a receiver's input threshold is determined by an external reference voltage

*Description:* Defines a voltage source that supplies the reference voltage used by a receiver for its input threshold reference.

*Usage Notes:* Provide actual voltages (not percentages) in the typ, min max format. 'NA' is allowed for the min and max values only. Note that the numerically largest value should be placed in 'max' column, while the numerically smallest value should be placed in the 'min' column.

# Example:

variable	typ	min	max
External Reference	1.00V	0.95V	1.05V

Keyword: [C Comp Corner]

Required: No

Description: Used to define C\_comp values associated with the typ/min/max corner Sub-Params: C\_comp\_pullup, C\_comp\_pulldown, C\_comp\_power\_clamp,

C\_comp\_gnd\_clamp

*Usage Rules:* If [C Comp Corner] is present, its value or values override any other C\_comp\* representations. The entries are values associated with each of the typ/min/max corners rather than entered by magnitude as with the other C\_comp subparameters.

The C\_comp subparameter under [C Comp Corner] is required only when C\_comp\_pullup, C\_comp\_pulldown, C\_comp\_power\_clamp, and C\_comp\_gnd\_clamp are not present. If the C\_comp subparameter is not present, at least one of the C\_comp\_pullup, C\_comp\_pulldown, C\_comp\_power\_clamp, or C\_comp\_gnd\_clamp subparameters is required. It is not illegal to include the C\_comp subparameter together with one or more of the remaining C\_comp\_\* subparameters, but in that case the simulator will have to make a decision whether to use C comp or the C\_comp\_pullup, C\_comp\_pulldown, C\_comp\_power\_clamp, and C\_comp\_gnd\_clamp subparameters. Under no circumstances should the simulator use the value of C\_comp simultaneously with the values of the other C\_comp\_\* subparameters.

C comp pullup, C comp pulldown, C comp power clamp, and C comp gnd clamp are intended to represent the parasitic capacitances of those structures whose I-V characteristics are described by the [Pullup], [Pulldown], [POWER Clamp] and [GND Clamp] I-V tables. For this reason, the simulator should generate a circuit netlist so that, if defined, each of the C comp \* capacitors is connected in parallel with its corresponding I-V table(s), whether or not the I-V table(s) exist(s). That is, the C\_comp\_\* capacitors are positioned between the signal pad and the nodes defined by the [Pullup Reference], [Pulldown Reference], [POWER Clamp Reference] and [GND Clamp Reference] keywords, or the [Voltage Range] keyword and GND.

The C\_comp and C\_comp\_\* subparameters define die capacitance. These values should not include the capacitance of the package. C\_comp and C\_comp\_\* are allowed to use "NA" for the min and max values only.

Other Notes: When C\_comp values are obtained by extraction under the corner process, voltage, and temperature conditions, the C comp\* entries are often positioned with the maximum values under the min column and the minimum values under the max column. C comp\* entries under other keywords are entered into columns by numerical magnitude. The [C Comp Corner] entries override all other C\_comp\* entries under other keywords.

# Example:

[C Comp Corner]   variable	typ	min	max
C_comp	7.0pF	9.0pF	5.0pF
C_comp_pullup	3.0pF	3.5pF	2.5pF   These four can be
C_comp_pulldown	2.0pF	2.5pF	1.5pF   used instead of
C_comp_power_clamp	1.0pF	1.5pF	0.5pF C_comp
C_comp_gnd_clamp	1.0pF	1.5pF	0.5pF

Keywords: [TTgnd], [TTpower]

Required:

Description: These keywords specify the transit time parameters used to estimate the transit time capacitances or develop transit time capacitance tables for the [GND Clamp] and [POWER Clamp] tables.

Usage Rules: For each of these keywords, the three columns hold the transit values corresponding to the typical, minimum and maximum [GND Clamp] or [POWER Clamp] tables, respectively.

The entries for TT(typ), TT(min), and TT(max) must be placed on a single line and must be separated by at least one white space. All three columns are required under these keywords. However, data is required only in the typical column. If minimum and/or maximum values are not available, the reserved word 'NA' must be used indicating the TT(typ) value by default.

The effective TT parameter values are intended to APPROXIMATE the effects. They may be different from the values found in the SPICE diode equations. Refer to Section 9, "NOTES ON DATA DERIVATION METHOD" for extracting the effective values.

## Example:

variable	TT(typ)	TT(min)	TT(max)
[TTgnd]	10n	12n	9n
[TTpower]	12n	NA	NA

Keywords: [Pulldown], [Pullup], [GND Clamp], [POWER Clamp]

Required: Yes, if they exist in the model

Description: The data points under these keywords define the I-V tables of the pulldown and pullup structures of an output buffer and the I-V tables of the clamping diodes connected to the GND and the POWER pins, respectively. Currents are considered positive when their direction is into the component.

*Usage Rules:* In each of these sections, the first column contains the voltage value, and the three remaining columns hold the typical, minimum, and maximum current values. The four entries, Voltage, I(typ), I(min), and I(max) must be placed on a single line and must be separated by at least one white space.

All four columns are required under these keywords. However, data is only required in the typical column. If minimum and/or maximum current values are not available, the reserved word 'NA' must be used. 'NA' can be used for currents in the typical column, but numeric values MUST be specified for the first and last voltage points on any I-V table. Each I-V table must have at least 2, but not more than 100, rows.

Other Notes: The I-V table of the [Pullup] and the [POWER Clamp] structures are 'Vcc relative', meaning that the voltage values are referenced to the Vcc pin. (Notethat, under these keywords, all references to 'Vcc' refer to the voltage rail defined by the [Voltage Range], [Pullup Reference], or [POWER Clamp Reference] keywords, as appropriate.) The voltages in the data tables are derived from the equation: Vtable = Vcc - Voutput.

Therefore, for a 5 V model, -5 V in the table actually means 5 V above Vcc, which is +10 V with respect to ground; and 10 V means 10 V below Vcc, which is -5 V with respect to ground. Vccrelative data is necessary to model a pullup structure properly, since the output current of a pullup structure depends on the voltage between the output and Vcc pins and not the voltage between the output and ground pins. Note that the [GND Clamp] I-V table can include quiescent input currents, or the currents of a 3-stated output, if so desired.

When tabulating data for ECL models, the data in the [Pulldown] table is measured with the output in the 'logic low' state. In other words, the data in the table represents the I-V characteristics of the output when the output is at the most negative of its two logic levels. Likewise, the data in the [Pullup] table is measured with the output in the 'logic one' state and represents the I-V characteristics when the output is at the most positive logic level. Note that in BOTH of these cases, the data is referenced to the Vcc supply voltage, using the equation: Vtable = Vcc - Voutput.

## Monotonicity Requirements:

To be monotonic, the I-V table data must meet any one of the following 8 criteria:

- 1- The CURRENT axis either increases or remains constant as the voltage axis is increased.
- 2- The CURRENT axis either increases or remains constant as the voltage axis is decreased.
- 3- The CURRENT axis either decreases or remains constant as the voltage axis is increased.
- 4- The CURRENT axis either decreases or remains constant as the voltage axis is decreased.
- 5- The VOLTAGE axis either increases or remains constant as the current axis is increased.
- 6- The VOLTAGE axis either increases or remains constant as the current axis is decreased.
- 7- The VOLTAGE axis either decreases or remains constant as the current axis is increased.
- 8- The VOLTAGE axis either decreases or remains constant as the current axis is decreased.

An IBIS syntax checking program shall test for non-monotonic data and provide a maximum of one warning per I-V table if non-monotonic data is found. For example:

"Warning: Line 300, Pulldown I-V table for model DC040403 is non-monotonic! Most simulators will filter this data to remove the non-monotonic data."

It is also recognized that the data may be monotonic if currents from both the output stage and the clamp diode are added together as most simulators do. To limit the complexity of the IBIS syntax checking programs, such programs will conduct monotonicity testing only on one I-V table at a time.

It is intended that the [POWER Clamp] and [GND Clamp] tables are summed together and then added to the appropriate [Pullup] or [Pulldown] table when a buffer is driving high or low, respectively.

From this assumption and the nature of 3-statable buffers, it follows that the data in the clamping table sections are handled as constantly present tables and the [Pullup] and [Pulldown] tables are used only when needed in the simulation.

The clamp tables of an Input or I/O buffer can be measured directly with a curve tracer, with the I/O buffer 3-stated. However, sweeping enabled buffers results in tables that are the sum of the clamping tables and the output structures. Based on the assumption outlined above, the [Pullup] and [Pulldown] tables of an IBIS model must represent the difference of the 3-stated and the

enabled buffer's tables. (Note that the resulting difference table can demonstrate a non-monotonic shape.) This requirement enables the simulator to sum the tables, without the danger of double counting, and arrive at an accurate model in both the 3-stated and enabled conditions.

Since in the case of a non 3-statable buffer, this difference table cannot be generated through lab measurements (because the clamping tables cannot be measured alone), the [Pullup] and [Pulldown] tables of an IBIS model can contain the sum of the clamping characteristics and the output structure. In this case, the clamping tables must contain all zeroes, or the keywords must be omitted.

# Example:

```
[Pulldown]
                        I(min)
   Voltage
             I(typ)
                                   I(max)
   -5.0V
            -40.0m
                       -34.0m
                                  -45.0m
   -4.0V
            -39.0m
                       -33.0m
                                  -43.0m
    0.0V
               0.0m
                         0.0m
                                    0.0m
    5.0V
                                   45.0m
             40.0m
                        34.0m
   10.0V
             45.0m
                                   49.0m
                        40.0m
                                          | Note: Vtable = Vcc - Voutput
[Pullup]
   Voltage
             I(typ)
                        I(min)
                                   I(max)
   -5.0V
             32.0m
                        30.0m
                                   35.0m
   -4.0V
             31.0m
                        29.0m
                                   33.0m
    0.0V
              0.0m
                         0.0m
                                    0.0m
   5.0V
            -32.0m
                       -30.0m
                                  -35.0m
   10.0V
            -38.0m
                       -35.0m
[GND Clamp]
   Voltage
             I(typ)
                        I(min)
                                   I(max)
          -3900.0m
                     -3800.0m
                                -4000.0m
   -5.0V
   -0.7V
            -80.0m
                       -75.0m
                                  -85.0m
   -0.6V
            -22.0m
                       -20.0m
                                  -25.0m
   -0.5V
             -2.4m
                        -2.0m
                                   -2.9m
   -0.4V
              0.0m
                         0.0m
                                    0.0m
   5.0V
              0.0m
                         0.0m
                                    0.0m
[POWER Clamp]
                                          | Note: Vtable = Vcc - Voutput
   Voltage
             I(typ)
                        I(min)
                                   I(max)
   -5.0V
           4450.0m
                          NA
                                     NA
   -0.7V
             95.0m
                                     NA
                          NA
   -0.6V
             23.0m
                          NA
                                     NA
   -0.5V
                                     NA
```

-0.4V	0.0m	NA	NA
0.0V	0.0m	NA	NA

Keywords: [ISSO PD], [ISSO PU]

Required: No

*Description:* The data points under the keyword [ISSO PD] define the effective current of the pulldown structure of a buffer as a function of the voltage on the pulldown reference node (the ground node), whereas the points under the keyword [ISSO PU] define the effective current of the pullup structure as a function of the voltage on the pullup reference node (the power node).

*Usage Rules:* The first column contains the voltage value at which the currents of the remaining three columns are obtained. The three remaining columns contain the typical, minimum, and maximum effective current values to be defined below of pullup/pulldown stage.

All four columns are required under this keyword. However, data is only required in the typical column. If minimum and/or maximum current values are not available, the reserved word 'NA' must be used. 'NA' can be used for currents in the typical column, but numeric values MUST be specified for the first and last voltage points in any table. Each table must have at least 2, but not more than 100, rows.

The [ISSO PD] table voltages are relative to the [Pulldown Reference] typ/min/max values (usually ground). The [ISSO PU] table voltages are relative to the [Pullup Reference] typ/min/max values (also usually the [Voltage Range] voltages). In the case of the [ISSO PU] table, the voltages follow the same Vtable = Vcc - Vmeasured convention as the [Pullup] table. Each of the tables are aligned with and span the typical -Vcc to Vcc voltages.

If the [ISSO\_PD] and [ISSO\_PU] keywords are not present, the effect of power supply variations on the I-V tables is not explicitly defined by the model.

The effective current table for the Isso\_pd current is extracted by the following process. The buffer is set to "logic zero." A Vtable voltage source is inserted between the [Pulldown Reference] node and the buffer as shown in Figure 7. This Vtable voltage is swept from -Vcc (typical) to +Vcc (typical) and is relative to the [Pulldown Reference] typ/min/max values for the corresponding columns. The output is connected to the GND (typical) value as shown in Figure 7.

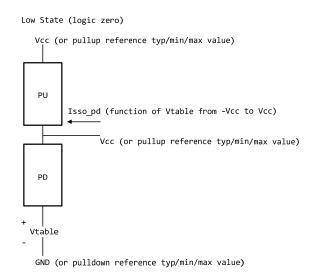


Figure 7 - Low State (Logic Zero) Isso\_pd Data Collection

The effective current table for the Isso\_pu current is extracted by the following process. The buffer is set to "logic one". A Vtable voltage source is inserted between the [Pullup Reference] node and the buffer as shown below. This Vtable voltage is swept from -Vcc (typical) to +Vcc (typical) and is relative to the [Pullup Reference] typ/min/max values for the corresponding columns. The output is connected to the GND (typical) value as shown in Figure 8.

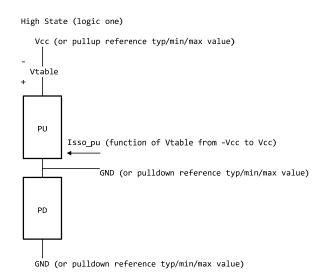


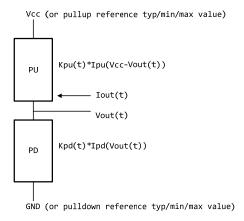
Figure 8 - High State (Logic One) Isso\_pu Data Collection

For each of these extractions, the corresponding [GND Clamp] and [POWER Clamp] currents need to be removed. Normally these are negligible. However, if on-die terminators exist, the extra currents that are associated with them should be removed from the [ISSO PD] and [ISSO PU] tables. The process details are not discussed here, but need to be solved by the modeler. Such details may depend upon the contents of the [GND Clamp] and [POWER Clamp] tables and the [GND Clamp Reference] and [POWER Clamp Reference] selections.

Currents are considered positive when their direction is into the component.

*Other Notes:* Simulators can use such tables to calculate modulation coefficients to modulate the original pulldown and pullup currents when a voltage variation on the pullup and pulldown reference nodes is revealed during power and/or ground bounce, and/or SSO simulation events.

To describe the modulation coefficients, a reference algorithm to generate an output response producing Vout(t) for a given load including clamp currents that requires an Iout(t) is shown in terms of pullup table currents Ipu(Vcc-Vout(t)) and pulldown table currents Ipd(Vout(t)). See Figure 9.



**Figure 9 - Reference Data Collection** 

When the supplies are modulated during simulation, the modulation coefficients Ksso pu(Vtable pu) and Ksso pd(Vtable pd) modify the equations as shown in Figure 10.

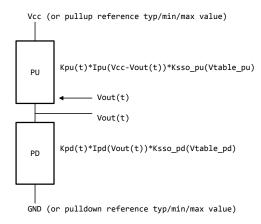


Figure 10 - Reference Data Collection with Supply Modulation

The Vtable\_pd and Vtable\_pu values may change at each time step. The Ksso\_pd(Vtable\_pd) and Ksso\_pu(Vtable\_pu) values are derived from the dynamic reference voltage variation and [ISSO PD] and [ISSO PU] table entries according to the formulas below:

$$Ksso\_pd(Vtable\_pd) = Isso\_pd(Vtable\_pd)/Isso\_pd(0)$$
  
 $Ksso\_pu(Vtable\_pu) = Isso\_pu(Vtable\_pu)/Isso\_pu(0)$ 

Note that the extraction setup equates the currents for each column at Vtable = 0 lines to the corresponding pulldown and pullup table currents:

$$Isso\_pd(0) = Ipd(Vcc)$$
  
 $Isso\_pu(0) = Ipu(Vcc)$ 

where Vcc are the typ/min/max values for the corresponding typ/min/max columns.

For example, for a typ/min/max [Voltage Range] of 5.0V, 4.5V and 5.5V, and with the negative reference set to GND, the Isso\_pu(0) and Isso\_pd(0) values for typ/min/max should be equal to the column values as shown in **Error! Reference source not found.** 

Table 3 - Example of Setting Isso\_pu and Isso\_pd Values

	Тур	min	max
Isso_pd(0)	Ipd(5.0)	Ipd(4.5)	Ipd(5.5)
Isso_pu(0)	Ipu(5.0)	Ipu(4.5)	Ipu(5.5)

With no modulation,  $Ksso_pd(0) = 1$  and  $Ksso_pu(0) = 1$ . However, if during simulation of the typical corner the Vcc voltage drops from 5.0 to 4.7, then Vtable\_pu = 5.0 - 4.7 = 0.3, and

 $Ksso\_pu(0.3)$  is calculated. If at the same time the ground reference voltage at the buffer increases to 0.2 V, then  $Ksso\_pd(0.2)$  is calculated. These two modulation factors are used in the reference model calculations to account for gate modulation effects associated with both output transistors.

These modulation factors are updated at each time step.

Note that the [ISSO PD] and [ISSO PU] keywords are designed for CMOS technology and may not be appropriate for bipolar or ECL technologies. A single [ISSO PU] or [ISSO PD] keyword table is appropriate for open technologies such as Open\_drain, Open\_source, Open\_sink, etc.

As a minor source of error, actual modulation effects may lag slightly from simulated modulationeffects due to internal delays within the physical device.

### Example:

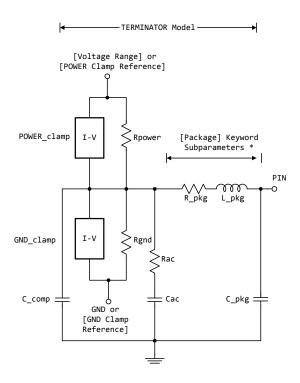
```
Assume [Voltage Range] is 1.8V (typ), 1.7V (min) and 1.95V (max).
 The table voltage entries are relative to the typ/min/max of the
 corresponding reference voltage for each table.
[ISSO PD]
            Relative to the [Pulldown Reference] voltage
                       I(min)
  Voltage
            I(typ)
                                  I(max)
  -1.8V
            10.0m
                       7.0m
                                  13.0m
  -0.5V
                       18.0m
             24.0m
                                  31.0m
  -0.2V
             27.0m
                       20.0m
                                  37.0m
   0.0V
             25.0m
                       19.0m
                                  34.0m
   0.2V
             18.0m
                       13.0m
                                  26.0m
   0.5V
             10.0m
                        7.0m
                                  16.0m
   0.7V
              5.0m
                        3.0m
                                   9.0m
   1.0V
              1.0m
                        0.7m
                                   3.0m
   1.8V
              0.0m
                        0.0m
                                   0.0m
[ISSO_PU]
              Relative to the [Pullup Reference] voltage)
  Voltage
                       I(min)
                                  I(max)
            I(typ)
  -1.8V
            -10.0m
                       -9.0m
                                 -14.0m
  -0.6V
            -28.0m
                      -19.0m
                                 -40.0m
  -0.4V
            -31.0m
                      -22.0m
                                 -43.0m
  -0.2V
            -29.0m
                      -21.0m
                                 -40.0m
   0.0V
            -27.0m
                      -19.0m
                                 -38.0m
   0.2V
            -21.0m
                      -14.0m
                                 -31.0m
            -14.0m
   0.4V
                       -9.0m
                                 -22.0m
              0.0m
                        0.0m
                                   0.0m
   1.8V
```

Keywords: [Rgnd], [Rpower], [Rac], [Cac]
Required: Yes, if they exist in the model

*Description:* The data for these keywords define the resistance values of Rgnd and Rpower connected to GND and the POWER pins, respectively, and the resistance and capacitance values for an AC terminator. See Figure 11.

*Usage Rules:* For each of these keywords, the three columns hold the typical, minimum, and maximum resistance values. The three entries for R(typ), R(min), and R(max), or the three entries for C(typ), C(min), and C(max), must be placed on a single line and must be separated by at least one white space. All three columns are required under these keywords. However, data is only required in the typical column. If minimum and/or maximum values are not available, the reserved word 'NA' must be used indicating the R(typ) or C(typ) value by default. Note that only one instance of any one of these keywords is permitted within any single [Model]. For example, [Rgnd] may not be used twice under the same [Model] description.

Other Notes: [Rpower] is connected to 'Vcc' and [Rgnd] is connected to 'GND'. However, [GND Clamp Reference] voltages, if defined, apply to [Rgnd]. [POWER Clamp Reference] voltages, if defined, apply to [Rpower]. Either or both [Rgnd] and [Rpower] may be defined and may coexist with [GND Clamp] and [POWER Clamp] tables. If the terminator consists of a series R and C (often referred to as either an AC or RC terminator), then both [Rac] and [Cac] are required. When [Rgnd], [Rpower], or [Rac] and [Cac] are specified, the Model\_type must be Terminator.



\* Note: More advanced package parameters are available within this standard, including more detailed power and ground net descriptions.

Figure 11 - [Rgnd], [Rpower], [Rac], [Cac] in Relation to Package and Buffer Data

#### Example:

variable [Rgnd] [Rpower]	R(typ) 330ohm 220ohm	R(min) 300ohm 200ohm	R(max) 360ohm   NA	Parallel Terminator
[Rac]	30ohm	NA	NA	
variable	C(typ) 50pF	C(min) NA	C(max)   NA	AC terminator

Keywords: [On], [Off]

Required: Yes, both [On] and [Off] for Series switch Model types only

Description: The 'On' state electrical models are positioned under [On]. The 'Off' state electrical models are positioned under [Off].

*Usage Rules:* These keywords are only valid for Series\_switch Model\_types. Only keywords associated with Series\_switch electrical models are permitted under [On] or [Off]. The Series electrical models describe the path for one state only and do not use the [On] and [Off] keywords.

In Series\_switch models, [On] or [Off] must be positioned before any of the [R Series], [L Series], RI Series], [C Series], [Rc Series], [Series Current], and [Series MOSFET] keywords. There is no provision for any of these keywords to be defined once, but to apply to both states.

### Example:

```
[On]
| ... On state keywords such as [R Series], [Series Current], [Series MOSFET]
[Off]
| ... Off state keywords such as [R Series], [Series Current]
```

Keywords: [R Series], [L Series], [RI Series], [C Series], [Lc Series], [Rc Series]

Required: Yes, if they exist in the model

Description: The data for these keywords allow the definition of Series or Series\_switch R, L or C paths.

*Usage Rules:* For each of these keywords, the three columns hold the typical, minimum, and maximum resistance values. The three entries must be placed on a single line and must be separated by at least one white space. All three columns are required under these keywords. However, data is only required in the typical column. If minimum and/or maximum values are not available, the reserved word 'NA' must be used.

Note that only one instance of any one of these keywords is permitted within any single [On] or [Off] keyword for [Model]s of type Series\_switch. For example, [L Series] may not be used twice under the same [Off] description. Similarly, only one instance of any one of these keyword is permitted within any single [Model] of type Series.

Other Notes: This series RLC model is defined to allow IBIS to model simple passive models and/or parasitics.

These keywords are valid only for Series or Series\_switch Model\_types.

The model is shown in Figure 12.

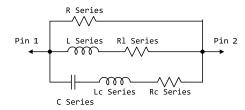


Figure 12 - Series Element Associations

[Rl Series] shall be defined only if [L Series] exists. [Rl Series] is 0 ohms if it is not defined in the path.

[Rc Series] and [Lc Series] shall be defined only if [C Series] exists. [Rc Series] is 0 ohms if it is not defined in the path. [Lc Series] is 0 henries if it is not defined in the path.

C\_comp values are ignored for series models.

# Example:

variable	R(typ)	R(min)	R(max)
[R Series]	8ohm	6ohm	12ohm
   variable [L Series]	L(typ) 5nH	L(min) NA	L(max) NA
variable	R(typ)	R(min)	R(max)
[Rl Series]	4ohm	NA	NA
   variable [C Series]	C(typ) 50pF	C(min) NA	C(max)   The other elements NA   are 0 impedance

Keyword: [Series Current]

Required: Yes, if they exist in the model

*Description:* The data points under this keyword define the I-V tables for voltages measured at Pin 1 with respect to Pin 2. Currents are considered positive if they flow into Pin 1. Pins 1 and 2 are listed under the [Series Pin Mapping] keyword under columns [Series Pin Mapping] and pin\_2, respectively.

*Usage Rules:* The first column contains the voltage value, and the remaining columns hold the typical, minimum, and maximum current values. The four entries, Voltage, I(typ), I(min), and I(max) must be placed on a single line and must be separated by at least one white space.

All four columns are required under these keywords. However, data is only required in the typical column. If minimum and/or maximum current values are not available, the reserved word 'NA' must be used. 'NA' can be used for currents in the typical column, but numeric values MUST be specified for the first and last voltage points on any I-V table. Each I-V table must have at least 2, but not more than 100 rows.

*Other Notes:* There is no monotonicity requirement. However the model supplier should realize that it may not be possible to derive a behavioral model from non-monotonic data. This keyword is valid only for Series or Series\_switch Model\_types.

The model is shown in Figure 13.

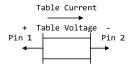


Figure 13 - [Series Current] Voltage Polarity and Current Direction

C\_comp values are ignored for [Series Current] models.

### Example:

```
[Series Current]
  Voltage I(typ) I(min)
                              I(max)
  -5.0V -3900.0m -3800.0m -4000.0m
  -0.7V
          -80.0m -75.0m
                             -85.0m
  -0.6V
           -22.0m
                    -20.0m
                              -25.0m
  -0.5V
           -2.4m
                    -2.0m
                              -2.9m
  -0.4V
            0.0m
                      0.0m
                               0.0m
   5.0V
             0.0m
                      0.0m
                                0.0m
```

Keyword: [Series MOSFET]

Required: Yes, for series MOSFET switches

*Description:* The data points under this keyword define the I-V tables for voltages measured at Pin 2 for a given Vds setting. Currents are considered positive if they flow into Pin 1. Pins 1 and 2 are listed under the [Series Pin Mapping] keyword under [Series Pin Mapping] and pin\_2 columns, respectively. See Figure 14.

Sub-Params: Vds

*Usage Rules:* The first column contains the voltage value, and the three remaining columns hold the typical, minimum, and maximum current values. The four entries, Voltage, I(typ), I(min), and I(max) must be placed on a single line and must be separated by at least one white space.

All four columns are required under this keyword. However, data is only required in the typical column. If minimum and/or maximum current values are not available, the reserved word 'NA' must be used. 'NA' can be used for currents in the typical column, but numeric values MUST be specified for the first and last voltage points on any I-V table. Each I-V table must have at least 2, but not more than 100 rows.

*Other Notes:* There is no monotonicity requirement. However the model supplier should realize that it may not be possible to derive a behavioral model from non-monotonic data.

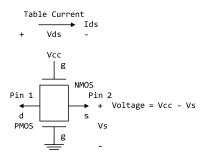


Figure 14 - [Series MOSFET] Voltage Polarities and Current Direction

Either of the FETs could be removed (or have zero current contribution). Thus this model covers all four conditions: off, single NMOS, single PMOS, and parallel NMOS/PMOS.

Voltage = Table Voltage = Vtable = Vcc - Vs Ids = Table Current for a given Vcc and Vds

Internal Logic that is generally referenced to the power rail is used to set the NMOS MOSFET switch to its 'ON' state. Internal logic, likewise referenced to ground, is used to set the PMOS device to its 'ON' state if the PMOS device is present. Thus, the [Voltage Range] settings provide the assumed gate voltages. If the [POWER Clamp Reference] exists, it overrides the [Voltage Range] value. The table entries are actually Vgs values of the NMOS device and Vcc - Vgs values of the PMOS device, if present. The polarity conventions are identical with those used for other tables that are referenced to power rails. Thus, the voltage column can be viewed as a table defining the source voltages Vs according to the convention: Vtable = Vcc - Vs. This convention remains even without the NMOS device.

If the switch is used in an application such as interfacing between 3.3 V and 5.0 V logic, the Vcc may be biased at a voltage (such as 4.3 V) that is different from a power rail voltage (such as 5.0 V) used to create the model. Just readjust the [Voltage Range] entries (or [POWER Clamp Reference] entries).

One fundamental assumption in the MOSFET switch model is that it operates in a symmetrical manner. The tables and expressions are given assuming that  $Vd \ge Vs$ . If Vd < Vs, then apply the same relationships under the assumption that the source and drain nodes are interchanged. A consequence of this assumption is that the Vds subparameter is constrained to values Vds > 0. It is assumed that with Vds = 0 the currents will be 0 mA. A further consequence of this assumption that would be embedded in the analysis process is that the voltage table is based on the side of the model with the lowest voltage (and that side is defined as the source). Thus the analysis must allow current to flow in both directions, as would occur due to reflections when the switch is connected in series with an unterminated transmission line.

The model data is used to create an On state relationship between the actual drain to source current, ids, and the actual drain to source voltage, vds:

$$ids = f(vds).$$

This functional relationship depends on the actual source voltage Vs and can be expressed in terms of the corresponding table currents associated with Vs (and expressed as a function of Vtable).

If only one [Series MOSFET] table is supplied (as a first order approximation), the functional relationship is assumed to be linearly related to the table drain to source current, Ids, for the given Vds subparameter value and located at the existing gate to source voltage value Vtable. This table current is denoted as Ids(Vtable, Vds). The functional relationship becomes:

```
ids = Ids(Vtable, Vds) * vds/Vds.
```

More than one [Series MOSFET] table under a [Model] keyword is permitted. However, the usage of this data is simulator dependent. Each table must begin with the [Series MOSFET] keyword and Vds subparameter. Each successive [Series MOSFET] table must have a different subparameter value for Vds. The number of tables for any specific [Model] must not exceed 100.

C\_comp values are ignored for [Series MOSFET] models.

### Examples:

1.8 57.7ma NA NA

```
An NMOS Example
[On]
[Series MOSFET]
Vds = 1.0
Voltage
             I(typ)
                       I(min)
                                  I(max)
    5.0V
            257.9m
                       153.3m
                                  399.5m
                                              Defines the Ids current as a
    4.0V
            203.0m
                       119.4m
                                  317.3m
                                              function of Vtable, for Vds = 1.0
    3.0V
            129.8m
                        74.7m
                                  205.6m
    2.0V
             31.2m
                        16.6m
                                   51.0m
    1.0V
                        46.7p
                                   56.7p
             52.7p
    0.0V
                         0.0p
                                    0.0p
              0.0p
 A PMOS/NMOS Example
[On]
[Series MOSFET]
Vds = 0.5
  Voltage
             I(typ)
                       I(min)
                                   I(max)
0.0 48.6ma NA NA
0.1 47.7ma NA NA
0.2 46.5ma NA NA
0.3 46.1ma NA NA
0.4 45.3ma NA NA
0.5 44.4ma NA NA
0.6 42.9ma NA NA
0.7 42.3ma NA NA
0.8 41.2ma NA NA
0.9 39.7ma NA NA
1.0 38.6ma NA NA
1.1 38.1ma NA NA
1.2 38.6ma NA NA
1.3 40.7ma NA NA
1.4 45.0ma NA NA
1.5 49.2ma NA NA
1.6 52.3ma NA NA
1.7 55.1ma NA NA
```

```
1.9 58.8ma NA NA
2.0 58.9ma NA NA
2.1 59.2ma NA NA
2.2 59.3ma NA NA
2.3 59.4ma NA NA
2.4 59.8ma NA NA
2.5 60.1ma NA NA
2.6 61.8ma NA NA
2.7 62.3ma NA NA
2.8 63.4ma NA NA
2.9 64.4ma NA NA
3.0 65.3ma NA NA
3.1 66.0ma NA NA
3.2 66.8ma NA NA
3.3 68.2ma NA NA
```

Keyword: [Ramp]

Required: Yes, except for inputs, terminators, Series, and Series\_switch model types Description: Defines the rise and fall times of a buffer. The ramp rate does not include packaging but does include the effects of the C\_comp or C\_comp\_\* parameters.

Sub-Params: dV/dt\_r, dV/dt\_f, R\_load

*Usage Rules:* The rise and fall time is defined as the time it takes the output to go from 20% to 80% of its final value. The ramp rate is defined as:

$$\frac{dv}{dt} = \frac{20\% \text{ to } 80\% \text{ voltage swing}}{\text{time it takes to swing the above voltage}}$$

The ramp rate must be specified as an explicit fraction and must not be reduced. The [Ramp] values can use 'NA' for the min and max values only. The R\_load subparameter is optional if the default 50 ohm load is used. The R\_load subparameter is required if a non-standard load is used.

## Example:

```
[Ramp] | min max | max | dV/dt_r | 2.20/1.06n | 1.92/1.28n | 2.49/650p | dV/dt_f | 2.46/1.21n | 2.21/1.54n | 2.70/770p | R_load = 300ohms
```

Keywords: [Rising Waveform], [Falling Waveform]

Required: No

Description: Describes the shape of the rising and falling edge waveforms of a driver.

Sub-Params: R\_fixture, V\_fixture, V\_fixture\_min, V\_fixture\_max, C\_fixture, L\_fixture, R\_dut,

L\_dut, C\_dut

*Usage Rules:* Each [Rising Waveform] and [Falling Waveform] keyword introduces a table of voltage versus time points that describe the shape of an output waveform. These voltage versus time points are taken under the conditions specified by the R/L/C/V\_fixture and R/L/C\_dut

subparameters. The table itself consists of one column of time points, then three columns of voltage points in the standard typ, min, and max format. The four entries must be placed on a single line and must be separated by at least one white space. All four columns are required. However, data is only required in the typical column. If minimum or maximum data is not available, use the reserved word 'NA'. The first value in the time column need not be '0'. Time values must increase as one parses down the table. The waveform table can contain a maximum of 1000 data rows. A maximum of 100 waveform tables are allowed per model.

Note that for backward compatibility, the existing [Ramp] keyword is still required. The data in the waveform table is taken with the effects of the C\_comp parameter included.

A waveform table must include the entire waveform; i.e., the first entry (or entries) in a voltage column must be the DC voltage of the output before switching and the last entry (or entries) of the column must be the final DC value of the output after switching. Each table must contain at least two entries. Thus, numerical values are required for the first and last entries of any column containing numerical data.

The data in all of the waveform tables should be time correlated. In other words, the edge data in each of the tables (rising and falling) should be entered with respect to a single point in time when the input stimulus is assumed to have initiated a logic transition. All waveform extractions should reference a common input stimulus time in order to provide a sufficiently accurate alignment of waveforms. The first line in each waveform table should be assumed to be the reference point in time corresponding to a logic transition. For example, assume that some internal rising edge logic transition starts at time = 0. Then a rising edge voltage-time table might be created starting at time zero. The first several table entries might be some "lead-in" time caused by some undefined internal buffer delay before the voltage actually starts transitioning. The falling edge stimulus (for the purpose of setting reference time for the voltage-time table) should also start at time = 0. And, the falling edge voltage-time table would be created starting at time zero with a possibly different amount of "lead-in" time caused by a possibly different but corresponding falling edge internal buffer delay. Any actual device differences in internal buffer delay time between rising and falling edges should appear as differing lead-in times between the rising and the falling waveforms in the tables just as any differences in actual device rise and fall times appear as differing voltage-time entries in the tables.

A [Model] specification can contain more than one rising edge or falling edge waveform table. However, each new table must begin with the appropriate keyword and subparameter list as shown below. If more than one rising or falling edge waveform table is present, then the data in each of the respective tables must be time correlated. In other words, the rising (falling) edge data in each of the rising (falling) edge waveform tables must be entered with respect to a common reference point on the input stimulus waveform.

The 'fixture' subparameters specify the loading conditions under which the waveform is taken. The  $R_dut$ ,  $C_dut$ , and  $L_dut$  subparameters are analogous to the package parameters  $R_pkg$ ,  $C_pkg$ , and  $L_pkg$  and are used if the waveform includes the effects of pin inductance/capacitance. Figure 15 shows the interconnection of these elements.

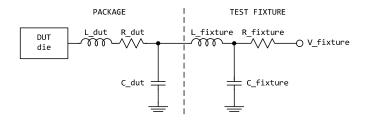


Figure 15 - [Rising Waveform] and [Falling Waveform] Fixtures

NOTE: The use of  $L_{dut}$ ,  $R_{dut}$ , and  $C_{dut}$  is strongly discouraged in developing waveform data from simulation models. Some simulators may ignore these parameters because they may introduce numerical time constant artifacts.

Only the R\_fixture and V\_fixture subparameters are required; the rest of the subparameters are optional. If a subparameter is not used, its value defaults to zero. The subparameters must appear in the text after the keyword and before the first row of the waveform table.

V\_fixture defines the voltage for typ, min, and max supply conditions. However, when the fixture voltage is related to the power supply voltages, then the subparameters V\_fixture\_min and V\_fixture\_max can be used to further specify the fixture voltage for min and max supply voltages.

NOTE: Test fixtures with R\_fixture and V\_fixture, V\_fixture\_min, and V\_fixture\_max only are strongly encouraged because they provide the BEST set of data needed to produce the best model for simulation. C\_fixture and L\_fixture can be used to produce waveforms which describe the typical test case setups for reference.

NOTE: In most cases two [Rising Waveform] tables and two [Falling Waveform] tables will be necessary for accurate modeling.

All tables assume that the die capacitance is included. Potential numerical problems associated with processing the data using the effective C\_comp (or C\_comp\_\* values as appropriate) for effective die capacitance may be handled differently among simulators.

### Example:

```
[Rising Waveform]
R fixture = 50
V_fixture = 0.0
 C_fixture = 50p
                         These are shown, but are generally not recommended
 L_fixture = 2n
 C_dut = 7p
 R_dut = 1m
 L_dut = 1n
                  V(typ)
 Time
                                      V(min)
                                                          V(max)
   0.0000s
                                     15.2200mV
                                                          43.5700mV
                 25.2100mV
   0.2000ns
                  2.3325mV
                                     -8.5090mV
                                                          23.4150mV
                                     15.9375mV
   0.4000ns
                  0.1484V
                                                          0.3944V
   0.6000ns
                  0.7799V
                                      0.2673V
                                                          1.3400V
   0.8000ns
                  1.2960V
                                      0.6042V
                                                          1.9490V
                                      0.9256V
   1.0000ns
                  1.6603V
                                                           2.4233V
```

1.2000ns 1.4000ns 1.6000ns 1.8000ns 2.0000ns	1.9460V 2.1285V 2.3415V 2.5135V 2.6460V	1.2050V 1.3725V 1.5560V 1.7015V 1.8085V	2.8130V 3.0095V 3.1265V 3.1600V 3.1695V
10.0000ns	2.7780V	2.3600V	3.1670V
 [Falling Wavefo	orm l		
R fixture = 50	OI III J		
V_fixture = 5.	5		
V_fixture_min =	= 4.5		
V_fixture_max :	= 5.5		
Time	V(typ)	V(min)	V(max)
0.0000s	5.0000V	4.5000V	5.5000V
0.2000ns	4.7470V	4.4695V	4.8815V
0.4000ns	3.9030V	4.0955V	3.5355V
0.6000ns	2.7313V	3.4533V	1.7770V
0.8000ns	1.8150V	2.8570V	0.8629V
1.0000ns	1.1697V	2.3270V	0.5364V
1.2000ns	0.7539V	1.8470V	0.4524V
1.4000ns	0.5905V	1.5430V	0.4368V
1.6000ns	0.4923V	1.2290V	0.4266V
1.8000ns	0.4639V	0.9906V	0.4207V
2.0000ns	0.4489V	0.8349V	0.4169V
10.0000ns	0.3950V	0.4935V	0.3841V

*Keyword:* [Composite Current]

Required: No

Description: Describes the shape of the rising and falling edge current waveforms from the power reference terminal of the buffer.

Usage Rules: The [Composite Current] keyword is positioned under the last row of the [Rising Waveform] table (for rising waveform currents) or [Falling Waveform] table (for falling waveform currents). The keywords are followed by a table of current versus time rows (I-T) that describe the shape of a current waveform. These I-T tables inherit the test fixture load of the [Rising Waveform] or [Falling Waveform] R/L/C/V\_fixture and R/L/C\_dut subparameters.

The [Composite Current] keyword is optional. It can be omitted, or it can be positioned under some or all of the rising and falling waveform tables.

The table itself consists of one column of time points, then three columns of current points in the standard typ, min, and max format. The four entries must be placed on a single line and must be separated by at least one white space. All four columns are required. However, data is only required in the typical column. If minimum or maximum data is not available, use the reserved word 'NA'. The first value in the time column need not be '0'. Time values must increase as one parses down the table. The waveform table can contain a maximum of 1000 data points.

The I-T table data must be time-correlated with the V-T data above it. That is, the I-T data should be entered with respect to the same point in time that the V-T table above it references and for the given \*\_fixture load. See the [Rising Waveform] and [Falling Waveform] section for more information about the common input stimulus time. Note that additional "lead-in" time may need

to be added to all V-T waveforms, as a portion of the I-T waveform data describes pre-driver current that may occur earlier in time than the V-T rising or falling edge transitions. Figure 16 illustrates a general configuration from which a [Rising Waveform] or [Falling Waveform] is extracted. The DUT die shows all of the available power and ground pin reference voltage terminals. For many buffers, only one power pin and one common ground pin terminal are used. The absolute GND is the reference for the V\_fixture voltage and the package model equivalent network. It can also serve as a reference for C\_comp, unless C\_comp is optionally split into component attached to the other reference voltages.

The [Composite Current] I-T table includes all of the current through the [Pullup Reference] terminal. If the [POWER Clamp Reference] terminal is the same as the [Pullup Reference] terminal (according to the [Pin Mapping] keyword table), the [Composite Current] entries include the currents through both the [POWER Clamp] and [Pullup] sections of the DUT (for example, when an on-die terminator is connected to the power reference terminal). Note that the terminals are shown in terms of separately defined reference voltages, but still exist even if they are defined with default [Voltage Range] or 0 V settings.

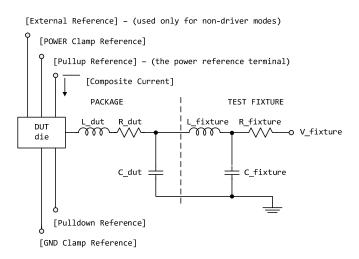


Figure 16 - [External Reference] - (used only for non-driver modes)

For \*\_ECL model types, the [Pullup] and [Pulldown] sections of the DUT share the same power reference terminal. The [Composite Current] includes the currents through both sections.

*Other Notes:* Figure 17 documents some expected internal paths for a useful special case where only one common power pin (VDDQ) and one common ground exists (GND).

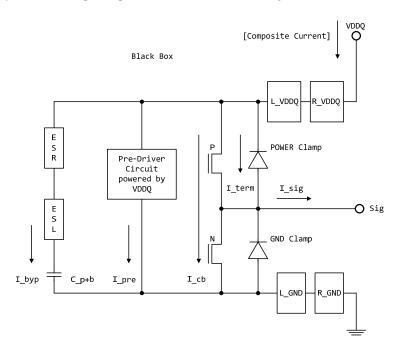


Figure 17 - [Composite Current] Internal Current Paths

Other elements in a more detailed typical (per buffer) model are:

I\_byp - Bypass current

I\_pre - Pre-Driver current

I\_cb - Crow-bar current

I\_term - Termination current (optional)

L\_VDDQ - On-die inductance of I/O Power

R\_VDDQ - On-die resistance of I/O Power

L GND - On-die inductance of Ground

R GND - On-die resistance of Ground

C\_p+b - Bypass + Parasitic Capacitance

ESR - Equivalent Series Resistance for on-die Decap

ESL - Equivalent Series Inductance for on-die Decap

While the [Composite Current] already includes the buffer I\_byp current, some Series model type elements may be used to document an equivalent bypass impedance to improve simulation results. Such an equivalent impedance can be extracted on a per buffer basis, but summed and expressed as a total equivalent impedance between the power and ground pins of the component with the Series model type keywords, including [C Series], [Lc Series], [Rc Series], and [R Series] under a separate [Model]. These elements are connected using the [Series Pin Mapping] keyword. Paths between several voltage rails can be modeled in this manner. The [Pin Mapping] keyword documents what buffers share common and often isolated power rails.

The C\_p+b value might include the detailed distribution of C\_comp when C\_comp\* is attached to several rails. If the C\_comp value and the C\_p+b value are about the same magnitude, the [C Series] value should be adjusted to avoid double counting.

The power reference terminal (VDDQ) is usually the [Pullup Reference], or the default [Voltage Range] terminal. The [Pulldown Reference] terminal is usually at the GND connection.

The [Composite Current] can still be defined for model types without the [Pullup] keywords (such as Open\_drain) because the [Pullup Reference] or [Voltage Range] are still required. Pre-driver and other internal paths still can exist.

In most cases six [Composite Current] tables are recommended for accurate modeling. The first four tables correspond to the recommended fixture conditions for [Rising Waveform] and [Falling Waveform] tables (normally 50 ohm loads to Vdd and GND). Two additional waveforms for no load conditions (such as with an R\_fixure of 1.0 Megaohm) are useful. However, some EDA tools process only the first four waveforms. So the additional open load waveforms for I-T tables should be in [Rising Waveform] and [Falling Waveform] tables that are positioned after the other V-T tables to maintain the best output response simulation accuracy.

For Open\_drain and Open\_source technologies, two tables are often specified (one for the [Rising Waveform] and one for the [Falling Waveform]). The tables should be positioned in front of any other optional waveform tables because some EDA tools process just the first two tables. Also, the open load tables may not yield meaningful simulations unless internal on-die terminators exist.

When the [Model] is configured for differential operation with the [Diff Pin] keyword, the individual I-T currents for each [Model] are used as an approximation, and may not accurately conform to the measured currents under actual differential operation.

The [Composite Current] table can be derived from currents measured at the [Pulldown Reference] (GND) node, but adjusted for the current flowing through the output pin and at other terminals.

The [Pin Mapping] keyword is used to document how buffers with common voltage rails are connected. The effective impedances for each buffer between the [Pullup Reference] and [Pulldown Reference] are then combined to form the total effective impedance between the voltage rails.

The [Composite Current] keyword does not accurately document the effects of controlled switching buffers such as those with [Submodel] or [Driver Schedule] keywords. The currents associated with [Submodel] switching under specified test load conditions can occur at different times under other load conditions. The scheduled models under the [Driver Schedule] keyword can be attached to different voltage rails in an undocumented manner.

#### Example:

```
[Rising Waveform]
R_fixture = 50.0
V_fixture = 0.0
 . . .
                  | Rising Waveform table
 . . .
[Composite Current]
 Time
                   I(typ)
                               I(min) I(max)
            4.243E-05
                        NA
                               NA
4.00E-11
            4.244E-05
                         NΑ
                               NA
8.00E-11
            4.242E-05
                         NA
                               NA
1.20E-10
            4.265E-05
                         NA
                               NA
1.60E-10
            3.610E-05
                         NA
                               NA
2.00E-10
            3.903E-03
                               NA
. .
3.80E-09
            2.012E-02
                         NA
                               NA
            2.012E-02
3.84E-09
                         NA
                               NA
3.88E-09
            2.012E-02
                         NΑ
                               NA
3.92E-09
            2.012E-02
                         NA
                               NA
3.96E-09
            2.012E-02
                         NA
                               NA
4.00E-09
            2.012E-02
                         NA
                                 NA
[Falling Waveform]
R_fixture = 50.0
V fixture = 1.8
  . . .
                  | Falling Waveform table
 . . .
[Composite Current]
 Time
                  I(typ)
                               I(min) I(max)
            4.302E-05
                        NA
                               NA
4.00E-11
            4.299E-05
                        NA
                               NA
8.00E-11
            4.304E-05
                         NA
                               NA
```

```
1.20E-10 4.287E-05 NA
1.60E-10 4.782E-05 NA
2.00E-10 1.459E-04 NA
                                         NA
                                         NA
                                         NA
. .
3.80E-09 4.933E-05
3.84E-09 5.211E-05
3.88E-09 5.490E-05
                                         NA
                                 NA
                                         NA
                                 NA
                                         NA
             5.441E-05
3.92E-09
                                 NA
                                         NA
              4.842E-05
3.96E-09
                                 NA
                                         NA
4.00E-09
                4.244E-05
                                         NA
 ... etc.
```

# **6A Add Submodel Description**

The [Add Submodel] keyword can be used under a top-level [Model] keyword to to add special-purpose functionality to the existing top-level model. This section describes the structure of the top-level model and the submodel.

### Top-Level Model:

When special-purpose functional detail is needed, the top-level model can call one or more submodels. The [Add Submodel] keyword is positioned after the initial set of required and optional subparameters of the [Model] keyword and among the keywords under [Model].

The [Add Submodel] keyword lists of name of each submodel and the permitted mode (Driving, Non-Driving or All) under which each added submodel is used.

### Submodel:

A submodel is defined using the [Submodel] keyword. It contains a subset of keywords and subparameters used for the [Model] keyword along with other keywords and subparameters that are needed for the added functionality.

The [Submodel] and [Submodel Spec] keywords are defined first since they are used for all submodels.

The only required subparameter in [Submodel] is Submodel\_type to define the list of submodel types. No subparameters under [Model] are permitted under the [Submodel] keyword.

The following set of keywords that are defined under the [Model] keyword are supported by the [Submodel] keyword:

```
[Pulldown]
[Pullup]
[GND Clamp]
[POWER Clamp]
[Ramp]
[Rising Waveform]
[Falling Waveform]
```

The [Voltage Range], [Pullup Reference], [Pulldown Reference], [GND Clamp Reference], and [POWER Clamp Reference] keywords are not permitted. The voltage settings are inherited from the top-level model. The following additional keywords are used only for the [Submodel] and are documented in this section:

```
[Submodel Spec]
[GND Pulse Table]
[POWER Pulse Table]
```

The application of these keywords depends upon the Submodel\_type entries listed below:

Dynamic\_clamp

Bus\_hold

Fall\_back

Permitted keywords that are not defined for any of these submodel types are ignored. The rules for what set of keywords are required are found under the Dynamic Clamp, Bus Hold, and Fall Back headings of this section.

Keyword: [Submodel]

Required: No

Description: Used to define a submodel, and its attributes.

Sub-Params: Submodel\_type

*Usage Rules:* Each submodel must begin with the keyword [Submodel]. The submodel name must match the one that is listed under an [Add Submodel] keyword and must not contain more than 20 characters. A .ibs file must contain enough [Submodel] keywords to cover all of the model names specified under the [Add Submodel] keyword.

Submodel\_type subparameter is required and must be one of the following:

Dynamic\_clamp, Bus\_hold, Fall\_back

The C\_comp subparameter is not permitted under the [Submodel] keyword. The total effective die capacitance including the submodel contributions are provided in the top-level model.

*Other Notes:* The following list of keywords that are defined under the [Model] keyword can be used under [Submodel]:

[Pulldown], [Pullup], [GND Clamp], [POWER Clamp], [Ramp], [Rising Waveform], and [Falling Waveform].

The following list of additional keywords can be used:

[Submodel Spec], [GND Pulse Table], and [POWER Pulse Table].

Example:

[Submodel] Dynamic\_clamp1
Submodel\_type Dynamic\_clamp

Keyword: [Submodel Spec]

Required: No

Description: The [Submodel Spec] keyword defines four columns under which specification and information subparameters are defined for submodels.

Sub-Params: V\_trigger\_r, V\_trigger\_f, Off\_delay

Usage Rules: The [Submodel Spec] is to be used only with submodels.

The following subparameters are used:

V\_trigger\_r Rising edge trigger voltage
V\_trigger\_f Falling edge trigger voltage

# Off\_delay Turn-off delay from V\_trigger\_r or V\_trigger\_f

For each subparameter contained in the first column, the remaining three hold its typical, minimum and maximum values. The entries of typical, minimum, and maximum be must be placed on a single line and must be separated by at least one white space. All four columns are required under the [Submodel Spec] keyword. However, data is required only in the typical column. If minimum and/or maximum values are not available, the reserved word 'NA' must be used to indicate the typical value by default.

The values in the minimum and maximum columns usually correspond to the values in the same columns for the inherited top-level voltage range or reference voltages in the top-level model. The V\_trigger\_r and V\_trigger\_f subparameters should hold values in the minimum and maximum columns that correspond to the voltage range or reference voltages of the top-level model. The Off\_delay subparameter, however, is an exception to this rule because in some cases it may be completely or partially independent from supply voltages and/or manufacturing process variations. Therefore the minimum and maximum entries for the Off\_delay subparameter should be ordered simply by their magnitude.

Unless noted, each [Submodel Spec] subparameter is independent of any other subparameter.

### V\_trigger\_r, V\_trigger\_f rules:

The voltage trigger values for the rising and falling edges provide the starting time when an action is initiated.

### Off\_delay rules:

The functionality of the Off\_delay subparameter is to provide an additional time related mechanism to turn off circuit elements.

### Example:

Dynamic Clamp Example	e:			
[Submodel Spec]				
Subparameter	typ	min	max	
V_trigger_r	3.6	2.9	4.3	Starts power pulse table
V_trigger_f	1.4	1.2	1.6	Starts gnd pulse table
Bus Hold Example:				
[Submodel Spec]				
Subparameter	typ	min	max	
V_trigger_r	3.1	2.4	3.7	Starts low to high bus hold transition
V_trigger_f	1.8	1.6	2.0	Starts high to low
T				bus hold transition
Bus_hold application   off:	with pullup	structure	triggere	d on and then clocked
[Submodel Spec]				
Subparameter	typ	min	max	
V_trigger_r	3.1	2.4	3.7	Low to high transition triggers the turn on process of the pullup

V_trigger_f	-10.0	-10.0	Not used, so trigger voltages are set out
Off_delay	5n	4n	of range   Time from rising edge
			trigger at which the pullup turned off

# **Dynamic Clamp:**

When the Submodel\_type subparameter under the [Submodel] keyword is set to Dynamic\_clamp, the submodel describes the dynamic clamp functionality.

The [GND Pulse Table] and [POWER Pulse Table] keywords are defined. An example for a complete dynamic clamp model is provided below.

*Keywords:* [GND Pulse Table], [POWER Pulse Table]

Required: No

*Description:* Used to specify the offset voltage versus time of [GND Clamp] and [POWER Clamp] tables within submodels.

*Usage Rules:* Each [GND Pulse Table] and [POWER Pulse Table] keyword introduces a table of voltage vs. time points that describe the shape of an offset voltage from the [GND Clamp Reference] voltage (or default ground) or the [POWER Clamp Reference] voltage (or default [Voltage Range] voltage). Note that these voltage values are inherited from the top-level model.

The table itself consists of one column of time points, then three columns of voltage points in the standard typ, min, and max format. The four entries must be placed on a single line and must be separated by at least one white space. All four columns are required. However, data is only required in the typical column. If minimum or maximum data is not available, use the reserved word 'NA'. Time values must increase as one parses down the table. The waveform table can contain of maximum of 100 rows.

Each table must contain at least two entries. Thus, numerical values are required for the first and last entries of any column containing numerical data.

The voltage entries in both the [Gnd Pulse Table] and [POWER Pulse Table] tables are directly measured offsets. At each instance, the [Gnd Pulse Table] voltage is ADDED to the [GND Clamp] table voltages to provide the shifted table voltages. At each instance, the [POWER Pulse Table] voltage is SUBTRACTED (because of polarity conventions) from the [POWER Clamp] table voltages to provide the shifted table voltages.

Only one [GND Pulse Table] and one [POWER Pulse Table] are allowed per model.

The [GND Pulse Table] and [POWER Pulse Table] interact with [Submodel Spec] subparameters V\_trigger\_f and V\_trigger\_r. Several modes of operation exist based on whether a pulse table and its corresponding trigger subparameter are given. These modes are classified as triggered and static.

### Triggered Mode:

For triggered mode, a pulse table must exist and include the entire waveform; i.e., the first entry (or entries) in a voltage column must be equal to the last entry.

Also, a corresponding [Submodel Spec] V\_trigger\_\* subparameter must exist. The triggered interaction is described:

The V\_trigger\_f subparameter under [Submodel Spec] is used to detect when the falling edge waveform at the die passes the trigger voltage. At that time, the [Gnd Pulse Table] operation starts. Similarly, the V\_trigger\_r subparameter is used to detect when the rising edge waveform at the die passes the trigger voltage. At that time, [POWER Pulse Table] operation starts. The [GND Pulse Table] dependency is shown in Figure 18.

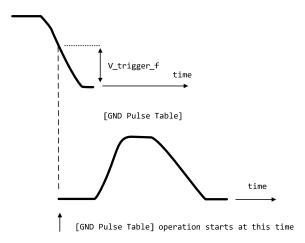


Figure 18 – [GND Pulse Table] Waveforms at Die

The V\_trigger\_r and [POWER Pulse Table] operate in a similar manner. When the V\_trigger\_r voltage value is reached on the rising edge, the [POWER Pulse Table] is started. Normally the offset voltage entries in the [POWER Pulse Table] are negative.

### Static Mode:

When the [GND Pulse Table] keyword does not exist, but the added model [GND Clamp] table does exist, the added model [GND Clamp] is used directly. Similarly, when the [POWER Pulse Table] keyword does not exist, but the added model [POWER Clamp] table does exist, the added model [POWER Clamp] is used directly.

This mode provides additional fixed clamping to an I/O\_\* buffer or a 3-state buffer when it is used as a driver.

Example of Dynamic\_clamp Model with both dynamic GND and POWER clamps:

```
1.6
                                                        | Falling edge trigger
V_trigger_f
                           1.4
                                       1.2
V_trigger_r
                           3.6
                                       2.9
                                                   4.3
                                                        Rising edge trigger
                           typ
                                       min
                                                  max
  [Voltage Range]
                             5.0
                                        4.5
                                                    5.5
 Note, the actual voltage range and reference voltages are inherited from
 the top-level model.
[GND Pulse Table]
                                                        | GND Clamp offset table
     Time
                    V(typ)
                                 V(min)
                                                 V(max)
       0
                      0
                                    0
                                                   0
    1e-9
                      0
                                    0
                                                   0
                                 0.8
    2e-9
                    0.9
                                                1.0
   10e-9
                    0.9
                                  0.8
                                                1.0
   11e-9
                      0
                                    0
                                                   0
[GND Clamp]
                                                        | Table to be offset
                   I(typ)
   Voltage
                                I(min)
                                               I(max)
    -5.000
               -3.300e+01
                              -3.000e+01
                                             -3.500e+01
    -4.000
               -2.300e+01
                              -2.200e+01
                                             -2.400e+01
    -3.000
                              -1.200e+01
               -1.300e+01
                                             -1.400e+01
    -2.000
                -3.000e+00
                               -2.300e+00
                                             -3.700e+00
    -1.900
                              -1.500e+00
                                             -2.800e+00
               -2.100e+00
    -1.800
               -1.300e+00
                              -8.600e-01
                                             -1.900e+00
    -1.700
               -6.800e-01
                              -4.000e-01
                                             -1.100e+00
    -1.600
                              -1.800e-01
                                             -5.100e-01
               -2.800e-01
    -1.500
               -1.200e-01
                              -9.800e-02
                                             -1.800e-01
               -7.500e-02
                              -7.100e-02
                                             -8.300e-02
    -1.400
    -1.300
               -5.750e-02
                              -5.700e-02
                                             -5.900e-02
    -1.200
               -4.600e-02
                              -4.650e-02
                                             -4.550e-02
    -1.100
               -3.550e-02
                              -3.700e-02
                                             -3.450e-02
    -1.000
                -2.650e-02
                              -2.850e-02
                                             -2.500e-02
                                             -1.650e-02
    -0.900
               -1.850e-02
                              -2.100e-02
    -0.800
               -1.200e-02
                              -1.400e-02
                                             -9.750e-03
    -0.700
               -6.700e-03
                              -8.800e-03
                                             -4.700e-03
    -0.600
               -3.000e-03
                              -4.650e-03
                                             -1.600e-03
    -0.500
                -9.450e-04
                              -1.950e-03
                                             -3.650e-04
    -0.400
               -5.700e-05
                              -2.700e-04
                                             -5.550e-06
    -0.300
                -1.200e-06
                              -1.200e-05
                                             -5.500e-08
    -0.200
                -3.000e-08
                               -5.000e-07
                                              0.000e+00
                               0.000e+00
                                              0.000e+00
    -0.100
                0.000e+00
     0.000
                0.000e+00
                               0.000e+00
                                              0.000e+00
     5.000
                0.000e+00
                               0.000e+00
                                              0.000e+00
[POWER Pulse Table]
                                                       | POWER Clamp offset table
     Time
                    V(typ)
                                 V(min)
                                                 V(max)
       Ω
                      0
                                    0
                                                   0
    1e-9
                     0
                                    0
                                                  0
                   -0.9
                                               -0.8
    2e-9
                                -1.0
   10e-9
                   -0.9
                                 -1.0
                                                -0.8
   11e-9
                      0
                                    0
                                                  0
```

[POWER Clamp]			1	Table to be	e offset
   Voltage 	I(typ)	I(min)	I(max)		
-5.000 -4.000 -3.000	1.150e+01 7.800e+00 4.350e+00	1.100e+01 7.500e+00 4.100e+00	1.150e+01 8.150e+00 4.700e+00		
-2.000 -1.900	1.100e+00 8.000e-01	8.750e-01 6.050e-01	1.300e+00 1.000e+00		
-1.800 -1.700	5.300e-01 2.900e-01	3.700e-01 1.800e-01	7.250e-01 4.500e-01		
-1.600 -1.500 -1.400	1.200e-01 3.650e-02 1.200e-02	6.850e-02 2.400e-02 1.100e-02	2.200e-01 6.900e-02 1.600e-02		
-1.300 -1.200	6.300e-03 4.200e-03	6.650e-03 4.750e-03	6.100e-03 3.650e-03		
-1.100 -1.000 -0.900	2.900e-03 1.900e-03 1.150e-03	3.500e-03 2.450e-03 1.600e-03	2.350e-03 1.400e-03 7.100e-04		
-0.800 -0.700	5.500e-04 1.200e-04	9.150e-04 4.400e-04	2.600e-04 5.600e-05		
-0.600 -0.500 -0.400	5.400e-05 1.350e-05 8.650e-07	1.550e-04 5.400e-05 7.450e-06	1.200e-05 1.300e-06 4.950e-08		
-0.300 -0.200	6.250e-08 0.000e+00	7.550e-07 8.400e-08	0.000e+00 0.000e+00		
-0.100	0.000e+00 0.000e+00	0.000e-08 0.000e+00	0.000e+00 0.000e+00		

### **Bus Hold:**

When the Submodel\_type subparameter under the [Submodel] keyword is set to Bus\_hold, the added model describes the bus hold functionality. However, while described in terms of bus hold functionality, active terminators can also be modeled.

Existing keywords and subparameters are used to describe bus hold models. The [Pullup] and [Pulldown] tables both are used to define an internal buffer that is triggered to switch to its opposite state. This switching transition is specified by a [Ramp] keyword or by the [Rising Waveform] and [Falling Waveform] keywords. The usage rules for these keywords are the same as under the [Model] keyword. In particular, at least either the [Pullup] or [Pulldown] keyword is required. Also, the [Ramp] keyword is required, even if the [Rising Waveform] and [Falling Waveform] tables exist. However, the voltage ranges and reference voltages are inherited from the top-level model.

For bus hold submodels, the [Submodel Spec] keyword, V\_trigger\_r, and V\_trigger\_f are required. The Off\_delay subparameter is optional, and can only be used if the submodel consists of a pullup or a pulldown structure only, and not both. Devices which have both pullup and pulldown structures controlled in this fashion can be modeled using two submodels, one for each half of the circuit.

The transition is triggered by action at the die using the [Submodel Spec] V\_trigger\_r and V\_trigger\_f subparameters as described next. In all subsequent discussions, "low" means the pulldown structure is on or active, and the pullup structure is off or inactive if either or both exist. The opposite settings are referred to as "high".

If the starting voltage is below V\_trigger\_f, then the bus hold model is set to the low state causing additional pulldown current. If the starting voltage is above V\_trigger\_r, the bus hold model is set to the high state for additional pullup current.

Under some unusual cases, the above conditions can be both met or not met at all. To resolve this, the EDA tool should compute the starting voltage with the bus hold model set to low. If the starting voltage is equal to or less than the average of V\_trigger\_r and V\_trigger\_f, keep the bus hold model in the low state. Otherwise, set the bus hold model to the high state.

When the input passes through V\_trigger\_f during a high-to-low transition at the die, the bus hold output switches to the low state. Similarly, when the input passes though V\_trigger\_r during a low-to-high transition at the die, the bus hold output switches to the high state.

If the bus hold submodel has a pullup structure only, V\_trigger\_r provides the time when its pullup is turned on and V\_trigger\_f or Off\_delay provides the time when it is turned off, whichever occurs first. Similarly, if the submodel has a pulldown structure only, V\_trigger\_f provides the time when its pulldown is turned on and V\_trigger\_r or Off\_delay provides the time when it is turned off, whichever occurs first. The required V\_trigger\_r and V\_trigger\_f voltage entries can be set to values outside of the input signal range if the pullup or pulldown structures are to be held on until the Off\_delay turns them off.

The starting mode for each of the submodels which include the Off\_delay subparameter of the [Submodel Spec] keyword is the off state. Also, while two submodels provide the desired operation, either of the submodels may exist without the other to simulate turning on and off only a pullup or a pulldown current.

Table 4 through Table 7 summarize the bus hold initializations and switching transitions:

Initial Vdie Value

Initial Bus Hold Submodel State

Table 4 Bus Hold Without Off\_Delay — Initialization

Table 5 Bus Hold Without Off\_Delay — Transitions

Prior Bus Hold Submodel State	Vdie transition through V_trigger_r/f	Bus Hold Transition
Low	V_trigger_r	low-to-high
Low	V_trigger_f	no change
High	V_trigger_r	no change
High	V_trigger_f	high-to-low

Table 6 Bus Hold With Off\_Delay (Requires Either [Pullup] or [Pulldown] Only) — Initialization

[Pullup] or [Pulldown] Table	Initial Bus Hold Submodel State (Off Mode)
[Pullup]	low
[Pulldown]	high

Table 7 Bus Hold With Off\_Delay (Requires Either [Pullup] or [Pulldown] Only) — Transitions

Prior Bus Hold Submodel State	Vdie transition through V_trigger_r/f	<b>Bus Hold Transition</b>	Off_delay Transition
Low	V_trigger_r	low-to-high	high-to-low
Low	V_trigger_f	no change	no change
High	V_trigger_r	no change	no change
High	V_trigger_f	high-to-low	low-to-high

Note: if Vdie passes again through the V\_trigger\_r/f thresholds before the Off\_delay time is reached, the bus hold state follows the change documented in the first table, overriding the Off\_delay transition.

No additional keywords are needed for this functionality.

# Examples:

```
Complete Bus Hold Model Example:
[Submodel]
                 Bus_hold_1
                 Bus_hold
Submodel_type
[Submodel Spec]
   Subparameter
                          typ
                                     min
                                                max
V_trigger_f
                          1.3
                                     1.2
                                                     | Falling edge trigger
                                                1.4
V_trigger_r
                                                      Rising edge trigger
                          3.1
                                     2.6
                                                4.6
                          typ
                                                max
 [Voltage Range]
                           5.0
                                      4.5
                                                  5.5
 Note, the actual voltage range and reference voltages are inherited from
 the top-level model.
[Pulldown]
-5V
        -100uA
                   -80uA
                             -120uA
-1V
        -30uA
                   -25uA
                             -40uA
```

```
0
                               0
ΟV
         0
1V
         30uA
                    25uA
                             40uA
3V
         50uA
                    45uA
                             50uA
         100uA
                    80uA
                             120uA
5W
10v
         120uA
                    90uA
                             150uA
[Pullup]
-5V
        100uA
                   80uA
                            120uA
-1V
        30uA
                   25uA
                            40uA
0V
        0
                    0
                             0
1V
        -30uA
                   -25uA
                            -40uA
3V
       -50uA
                   -45uA
                            -50uA
       -100uA
                  -80uA
                            -120uA
5V
       -120uA
                   -90uA
                            -150uA
[Ramp]
                       typ
                                                      2.0/0.35n
2.0/0.35n
dV/dt_r
                       2.0/0.50n
                                        2.0/0.75n
dV/dt_f
                       2.0/0.50n
                                        2.0/0.75n
R_{load} = 500
 Complete Pulldown Timed Latch Example:
[Submodel]
                Timed_pulldown_latch
                Bus_hold
Submodel_type
[Submodel Spec]
   Subparameter
                         typ
                                    min
                                                max
V_trigger_r
                          3.1
                                     2.6
                                                4.6
                                                     | Rising edge trigger
                                                       Values could be set out
                                                       of range to disable the
                                                       trigger
V_trigger_f
                         1.3
                                    1.2
                                                1.4
                                                     Falling edge trigger
Off_delay
                          3n
                                     2n
                                                5n
                                                     Delay to turn off the
                                                     pulldown table
 Note that if the input signal goes above the V_trigger_r value, the
 pulldown structure will turn off even if the timer didn't expire yet.
                                    min
                                                max
                          typ
                                                5.5
 [Voltage Range]
                                    4.5
                         5.0
 Note, the actual voltage range and reference voltages are inherited from
 the top-level model.
[Pulldown]
        -100uA
-5V
                   -80uA
                             -120uA
        -30uA
-1V
                   -25uA
                             -40uA
        0
0V
                    0
                             0
```

1V 3V 5V	30uA 50uA 100uA	25uA 45uA 80uA	40uA 50uA 120uA			
10v	120uA	90uA	150uA			
				Open_drain	functionality.	
 [Ramp]						
Ì		typ		min	max	
dV/dt_r	:	2.0	/0.50n	2.0/0.75n	2.0/0.35n	
dV/dt_f	-	2.0	/0.50n	2.0/0.75n	2.0/0.35n	
R_load	= 500					
=====			=======	========	=========	========

### Fall Back:

When the Submodel\_type subparameter under the [Submodel] keyword is set to Fall\_back, the added model describes the fall back functionality. This submodel can be used to model drivers that reduce their strengths and increase their output impedances during their transitions. The fall back submodel is specified in a restrictive manner consistent with its intended use with a driver model operating only in Driving mode. In a Non-Driving mode, no action is specified. For example, a fall back submodel added to an Input or Terminator model would be inactive.

Existing keywords and subparameters are used to describe fall back models. However, only one [Pullup] or [Pulldown] table, but not both, is allowed. The switching transition is specified by a [Ramp] keyword or by the [Rising Waveform] and [Falling Waveform] keywords. The [Ramp] keyword is required, even if the [Rising Waveform] and [Falling Waveform] tables exist. However, the voltage ranges and reference voltages are inherited from the top-level model.

For fall back submodels, the [Submodel Spec] keyword, V\_trigger\_r, and V\_trigger\_f are required. Unlike the bus hold model, the Off\_delay subparameter is not permitted. Devices which have both pullup and pulldown structures can be modeled using two submodels, one for the rising cycle and one for the falling cycle.

In all following discussion, "low" means the pulldown structure is on or active, and the pullup structure is off or inactive. The opposite settings are referred to as "high".

The transition is triggered by action at the die using the [Submodel Spec] V\_trigger\_r and V\_trigger\_f subparameters. The initialization and transitions are shown in Table 8 through Table 10.

Table 8 Fall Back – Initial State

[Pullup] or [Pulldown] Table	Initial Fall Back Submodel State (Off Mode)
[Pullup]	Low
[Pulldown]	High

Table 9 Fall Back – Driver Rising Cycle

Prior State Vdie Rising Edge Vdie > V_trigger
---

		Transition	Transition
Low	<= V_trigger_r	low-to-high	high-to-low
Low	> V_trigger_r	stays low	stays low
III ah	<= V_trigger_r	stays high	high-to-low
High	> V_trigger_r	stays high	stays high

Table 10 Fall Back - Driver Falling Cycle

Prior State	Vdie	Falling Edge Transition	Vdie < V_trigger_f Transition
III:ah	=> V_trigger_f	high-to-low	low-to-high
High	< V_trigger_f	stays high	stays high
Low	=> V_trigger_f	stays low	low-to-high
Low	< V_trigger_f	stays low	stays low

One application is to configure the submodel with only a pullup structure. At the beginning of the rising edge cycle, the pullup is turned on to the high state. When the die voltage passes V\_trigger\_r, the pullup structure is turned off. Because only the pullup structure is used, the off state is low corresponding to a high-Z state. During the falling transition, the pullup remains in the high-Z state if the V\_trigger\_f is set out of range to avoid setting the submodel to the high state. So a temporary boost in drive occurs only during the first part of the rising cycle.

A similar submodel consisting of only a pulldown structure could be constructed to provide added drive strength only at the beginning of the falling cycle. The complete IBIS model would have both submodels to give added drive strength for both the start of the rising and the start of the falling cycles.

No additional keywords are needed for this functionality.

### Examples:

```
Complete Dynamic Output Model Example Using Two Submodels:
[Submodel]
                 Dynamic_Output_r
                 Fall_back
Submodel_type
[Submodel Spec]
   Subparameter
                                     min
                          typ
                                                max
V_trigger_f
                        -10.0
                                   -10.0
                                              -10.0
                                                       Falling edge trigger
                                                       set out of range to
                                                       disable trigger
V_trigger_r
                          3.1
                                     2.6
                                                4.6
                                                      Rising edge trigger
                                       min
                                                  max
                            typ
 [Voltage Range]
                            5.0
                                       4.5
                                                  5.5
 Note, the actual voltage range and reference voltages are inherited from
 the top-level model.
```

```
[Pullup]
                      120mA
-5V
       100mA
              80mA
0V
                0
                        0
      -200mA
               -160mA
                       -240mA
10v
 [Pulldown] table is omitted to signify Open_source functionality.
______
[Ramp]
                  typ
                               min
                                            max
                                           1.58/0.35n
1.58/0.35n
                              1.43/0.75n
                  1.5/0.50n
dV/dt_r
dV/dt_f
                   1.5/0.50n
                               1.43/0.75n
R_{load} = 50
[Submodel] Dynamic_Output_f
Submodel_type Fall_back
[Submodel Spec]
  Subparameter typ
                            min
                                      max
V_trigger_r
                   10.0
                             10.0
                                      10.0 | Rising edge trigger
                                           set out of range to
                                           disable trigger
V_trigger_f
                   1.3 1.2
                                      1.4 Falling edge trigger
                                     max
                             min
                     typ
                                       5.5
 [Voltage Range]
                              4.5
                     5.0
 Note, the actual voltage range and reference voltages are inherited from
 the top-level model.
[Pulldown]
                       -120mA
      -100mA
-5V
               -80mA
0V
       0
                0
                        0
      200mA
               160mA
                       240mA
10v
 [Pullup] table is omitted to signify Open_drain functionality.
|-----
[Ramp]
                   typ
                               min
                                            max
                                           1.58/0.35n
1.58/0.35n
dV/dt_r
                              1.43/0.75n
                  1.5/0.50n
dV/dt_f
                   1.5/0.50n
                               1.43/0.75n
R_load = 50
```

# **6B Multi-Lingual Model Extensions**

### Introduction:

The SPICE, VHDL-AMS and Verilog-AMS languages are supported by IBIS. This chapter describes how models written in these languages can be referenced and used by IBIS files.

Table 11 shows the keywords used by the language extensions within the IBIS framework.

Table 11 Language Extension Keywords

Keyword	Description
[External Circuit] [End External Circuit]	References enhanced descriptions of structures on the die, including digital and/or analog, active and/or passive circuits
[External Model] [End External Model]	Same as [External Circuit], except limited to the connection format and usage of the [Model] keyword, with one additional feature added: support for true differential buffers
[Node Declarations] [End Node Declarations]	Lists on-die connection points related to the [Circuit Call] keyword
[Circuit Call] [End Circuit Call]	Instantiates [External Circuit]s and connects them to each other and/or die pads

The placement of these keywords within the hierarchy of IBIS is shown below:

## **Languages Supported:**

IBIS files can reference other files which are written using the SPICE, VHDL-AMS, or Verilog-AMS languages. In this document, these languages are defined as follows:

"SPICE" refers to SPICE 3, Version 3F5 developed by the University of California at Berkeley, California. Many vendor-specific EDA tools are compatible with most or all of this version.

"VHDL-AMS" refers to "IEEE Standard VHDL Analog and Mixed-Signal Extensions", approved March 18, 1999 by the IEEE-SA Standards Board and designated IEEE Std. 1076.1-1999, or later.

"Verilog-AMS" refers to the Analog and Mixed-Signal Extensions to Verilog-HDL as documented in the Verilog-AMS Language Reference, Version 2.0, or later. This document is maintained by Accellera (formerly Open Verilog International), an independent organization. Verilog-AMS is a superset that includes Verilog-A and the Verilog Hardware Description Language IEEE 1364-2001, or later.

"VHDL-A(MS)" refers to the analog subset of VHDL-AMS described above.

"Verilog-A(MS)" refers to the analog subset of Verilog-AMS described above.

In addition, the "IEEE Standard Multivalue Logic System for VHDL Model Interoperability (Std\_logic\_1164)", designated IEEE Std. 1164-1993 or later, is required to promote common digital data types for IBIS files referencing VHDL-AMS. Also, the Accellera Verilog-AMS Language Reference Manual Version 2.2 or later, is required to promote common digital data types for IBIS files referencing Verilog-AMS.

Note that, for the purposes of this section, keywords, subparameters and other data used without reference to the external languages just described are referred to collectively as "native" IBIS.

#### Overview:

The four keyword pairs discussed in this chapter can be separated into two groups based on their functionalities. The [External Model], [End External Model], [External Circuit], and [End External Circuit] keywords are used as pointers to the models described by one of the external languages. The [Node Declarations], [End Node Declarations], [Circuit Call], and [End Circuit Call] keywords are used to describe how [External Circuit]s are connected to each other and/or to the die pads.

The [External Model] and [External Circuit] keywords are very similar in that they both support the same external languages, and they can both be used to describe passive and/or active circuitry. The key difference between the two keywords is that [External Model] can only be placed under the [Model] keyword, while [External Circuit] can only be placed outside the [Model] keyword, as illustrated in the portion of the keyword hierarchy, shown above.

The intent behind [External Model] is to provide an upgrade path from native IBIS [Model]s to the external languages (one exception to this is the support for true differential buffers). Thus, the [External Model] keyword can be used to replace the usual I-V and V-T tables, C\_comp, C\_comp\_pullup, C\_comp\_pulldown, C\_comp\_power\_clamp, C\_comp\_gnd\_clamp subparameters, [Ramp], [Driver Schedule], [Submodel] keywords, etc. of a [Model] by any modeling technique that the external languages allow. For [External Model]s, the connectivity, test load and specification parameters (such as Vinh and Vinl) are preserved from the [Model] keyword and the simulator is expected to carry out the same type of connections and measurements as is usually done with the [Model] keyword. The only difference is that the model itself is described by an external language.

In the case of the [External Circuit], however, one can model a circuit having any number of ports (see definitions below). For example, the ports may include impedance or buffer strength selection controls in addition to the usual signal and supply connections. The connectivity of an [External Circuit] is defined by the [Node Declarations] and [Circuit Call] keywords. Currently, the test loads and measurement parameters for an [External Circuit] can only be defined inside the model description itself. The results of measurements can be reported to the user or tool via other means.

The [Circuit Call] keyword acts similarly to subcircuit calls in SPICE, instantiating the various [External Circuit]s and connecting them together. Please note that models described by the [External Model] keyword are connected according to the rules and assumptions of the [Model] keyword. [Circuit Call] is not necessary for these cases and must not be used.

### Definitions:

For the purposes of this document, several general terms are defined below.

circuit - any arbitrary collection of active or passive electrical elements treated as a unit

node - any electrical connection point; also called die node (may be digital or analog; may be a connection internal to a circuit or between circuits)

pad - a special case of a node. A pad connects a buffer or other circuitry to a package; also called die pad.

port - access point in an [External Model] or [External Circuit] definition for digital or analog signals

pseudo-differential circuits - combination of two single-ended circuits which drive and/or receive complementary signals, but where no internal current relationship exists between them

true differential circuits - circuits where a current relationship exists between two outputs or inputs which drive or receive complementary signals

### General Assumptions:

### Ports under [Model]s:

The use of ports under native IBIS must be understood before the multi-lingual extensions can be correctly applied. The [Model] keyword assumes, but does not explicitly require, naming ports on circuits. These ports are automatically connected by IBIS-compliant tools without action by the user. For example, the [Voltage Reference] keyword implies the existence of power supply rails which are connected to the power supply ports of the circuit described by the [Model] keyword.

For multi-lingual modeling, ports must be explicitly named in the [External Model] or [External Circuit]; the ports are no longer assumed by EDA tools. To preserve compatibility with the assumptions of [Model], a list of pre-defined port names has been created where the ports are reserved with fixed functionality. These reserved ports are defined in Table 12.

Table 12 Port Names in Multi-Lingual Modeling

Port	Name	Description
1	D_drive	Digital input to a model unit

Table 12 Port Names in Multi-Lingual Modeling

Port	Name	Description
2	D_enable	Digital enable for a model unit
3	D_receive	Digital receive port of a model unit, based on data on A_signal (and/or A_signal_pos and A_signal_neg)
4	A_puref	Voltage reference port for pullup structure
5	A_pcref	Voltage reference port for power clamp structure
6	A_pdref	Voltage reference port for pulldown structure
7	A_gcref	Voltage reference port for ground clamp structure
8	A_signal	I/O signal port for a model unit
9	A_extref	External reference voltage port
10	D_switch	Digital input for control of a series switch model
11	A_gnd	Global reference voltage port
12	A_pos	Non-inverting port for series or series switch models
13	A_neg	Inverting port for series or series switch models
14	A_signal_pos	Non-inverting port of a differential model
15	A_signal_neg	Inverting port of a differential model

The first letter of the port name designates it as either digital ('D') or analog ('A'). Reserved ports 1 through 13 are assumed or implied under the native IBIS [Model] keyword. Again, for multilingual models, these ports must be explicitly assigned by the user in the model if their functions are to be used. A\_gnd is a universal reference node, similar to SPICE ideal node "0." Ports 14 and 15 are only available under [External Model] for support of true differential buffers.

Under the [Model] description, power and ground reference ports are created and connected by IBIS-compliant tools as defined by the [Power Clamp Reference], [GND Clamp Reference], [Pullup Reference], [Pulldown Reference] and/or [Voltage Range] keywords. The A\_signal port is connected to the die pad, to drive or receive an analog signal.

### Ports under [External Model]s:

The [External Model] keyword may only appear under the [Model] keyword and it may only use the same ports as assumed with the native IBIS [Model] keyword. However, [External Model] requires that reserved ports be explicitly declared in the referenced language(s); tools will continue to assume the connections to these ports.

For [External Model], reserved analog ports are usually assumed to be die pads. These ports would be connected to the component pins through [Package Model]s or [Pin] parasitics. Digital ports under [External Model] would connect to other internal digital circuitry.

Two standard [Model] structures—an I/O buffer and a Series Switch—are shown, with their associated port names, in Figure 19 and Figure 20.

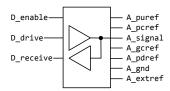


Figure 19 - Port Names for I/O Buffer

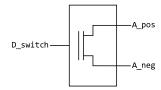


Figure 20 - Port Names for Series Switch

### Ports under [External Circuit]s:

The [External Circuit] keyword allows the user to define any number of ports and port functions on a circuit. The [Circuit Call] keyword instantiates [External Circuit]s and connects their ports to specific die nodes (this can include pads). In this way, the ports of an [External Circuit] declaration become specific component die nodes. Note that, if reserved digital port names are used with an [External Circuit], those ports will be connected automatically as defined in the port list above (under [External Circuit], reserved analog port names do not retain particular meanings).

Figure 21 illustrates the use of [External Circuit]. Buffer A is an instance of [External Circuit] "X". Similarly, Buffer B is an instance of [External Circuit] "Z". These instances are created through [Circuit Call]s. [External Circuit] "Y" defines an on-die interconnect circuit. Nodes "a" through "e" and nodes "f" through "j" are specific instances of the ports defined for [External Circuit]s "X" and "Z". These ports become the internal nodes of the die and must be explicitly declared with the [Node Declarations] keyword. The "On-die Interconnect" [Circuit Call] creates an instance of the [External Circuit] "Y" and connects the instance with the appropriate power, signal, and ground die pads. The "A" and "B" [Circuit Call]s connect the individual ports of each buffer instance to the "On-die Interconnect" [Circuit Call].

Note that the "Analog Buffer Control" signal is connected directly to the pad for pin 3. This connection is also made through an entry under the [Circuit Call] keyword.

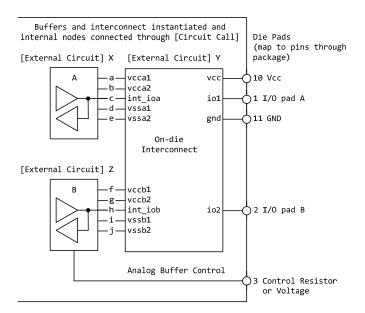


Figure 21 - Example Showing [External Circuit] Ports

The [Model], [External Model] and [External Circuit] keywords (with [Circuit Call]s and [Node Declarations] as appropriate) may be combined together in the same IBIS file or even within the same [Component] description.

### Port types and states:

The intent of native IBIS is to model the circuit block between the region where analog signals are of interest, and the digital logic domain internal to the component. For the purposes of this discussion, the IBIS circuit block is called a "model unit" in Figure 22 and Figure 23 and the document text below.

The multi-lingual modeling extensions maintain and expand this approach, assuming that both digital signals and/or analog signals can move to and from the model unit. All VHDL-AMS and Verilog-AMS models, therefore, must have digital ports and analog ports. In certain cases, digital ports may not be required, as in the case of interconnects; see [External Circuit] below. Routines to convert signals from one format to the other are the responsibility of the model author.

Digital ports under AMS languages must follow certain constraints on type and state. In VHDL-AMS models, analog ports must have type 'electrical'. Digital ports must have type 'std\_logic' as defined in IEEE Standard Multivalue Logic System for VHDL Model Interoperability (Std\_logic\_1164), or later. In Verilog-AMS models, analog ports must be of discipline 'electrical' or a subdiscipline thereof. Digital ports must be of discipline 'logic' as defined in the Accellera Verilog-AMS Language Reference Manual Version 2.2, or later and be constrained to states as defined in IEEE Std. 1164-1993, or later.

The digital ports delivering signals to the AMS model, D\_drive, D\_enable, and D\_switch, must be limited to the '1' or '0' states for VHDL-AMS, or, equivalently, to the 1 or 0 states for Verilog-AMS. The D\_receive digital port may only have the '1', '0', or 'X' states in VHDL-AMS, or, equivalently, the 1, 0, or X states in Verilog-AMS. All digital ports other than the foregoing predefined ports may use any of the logic states allowed by IEEE Std. 1164-1993, or later.

SPICE, VHDL-A(MS), Verilog-A(MS) versus VHDL-AMS and VERILOG-AMS

SPICE, VHDL-A(MS), Verilog-A(MS) cannot process digital signals. All SPICE, VHDL-A(MS), Verilog-A(MS) input and output signals must be in analog format. Consequently, IBIS multilingual models using SPICE, VHDL-A(MS) or Verilog-A(MS) require analog-to-digital (A\_to\_D) and/or digital-to-analog (D\_to\_A) converters to be provided by the EDA tool. The converter subparameters are declared by the user, as part of the [External Model] or [External Circuit] syntax, with user-defined names for the ports which connect the converters to the analog ports of the SPICE, VHDL-A(MS), or Verilog-A(MS) model. The details behind these declarations are explained in the keyword definitions below.

To summarize, Verilog-AMS and VHDL-AMS contain all the capability needed to ensure that a model unit consists of only digital ports and/or analog ports. SPICE, VHDL-A(MS) and Verilog-A(MS), however, need extra data conversion, provided by the EDA tool, to ensure that any digital signals can be correctly processed.

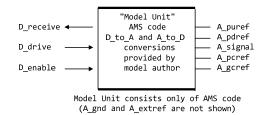


Figure 22 - AMS Model Unit, Using an I/O Buffer as an Example

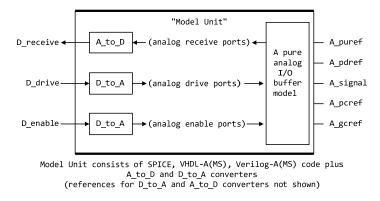


Figure 23 - An Analog-Only Model Unit, Using an I/O Buffer as an Example

## **Keyword Definitions:**

**Keywords:** [External Model], [End External Model]

Required: No

*Description:* Used to reference an external file written in one of the supported languages containing an arbitrary circuit definition, but having ports that are compatible with the [Model] keyword, or having ports that are compatible with the [Model] keyword plus an additional signal port for true differential buffers.

Sub-Params: Language, Corner, Parameters, Ports, D\_to\_A, A\_to\_D

*Usage Rules:* The [External Model] keyword must be positioned within a [Model] section and it may only appear once for each [Model] keyword in a .ibs file. It is not permitted under the [Submodel] keyword.

[Circuit Call] may not be used to connect an [External Model].

A native IBIS [Model]'s data may be incomplete if the [Model] correctly references an [External Model]. Any native IBIS keywords that are used in such a case must contain syntactically correct data and subparameters according to native IBIS rules. In all cases, [Model]s which reference [External Model]s must include the following keywords and subparameters:

Model\_type

Vinh, Vinl (as appropriate to Model\_type)

[Voltage Range] and/or [Pullup Reference], [Pulldown Reference], [POWER Clamp Reference], [GND Clamp Reference], [External Reference]

[Ramp]

In models without the [External Model] keyword, data for [Ramp] should be measured using a load that conforms to the recommendations in Section 9, "NOTES ON DATA DERIVATION METHOD". However, when used within the scope of [External Model], the [Ramp] keyword is intended strictly to provide EDA tools with a quick first-order estimate of driver switching characteristics. When using [External Model], therefore, data for [Ramp] may be measured using a different load, if it results in data that better represent the driver's behavior in standard operation. Also in this case, the R\_load subparameter is optional, regardless of its value, and will be ignored by EDA simulators. For example, the 20% to 80% voltage and time intervals for a differential buffer may be measured using the typical differential operating load appropriate to that buffer's technology. Note that voltage and time intervals must always be recorded explicitly rather than as a reduced fraction, in accordance with [Ramp] usage rules.

The following keywords and subparameters may be omitted, regardless of Model\_type, from a [Model] using [External Model]:

C\_comp, C\_comp\_pullup, C\_comp\_pulldown, C\_comp\_power\_clamp, C\_comp\_gnd\_clamp [Pulldown], [Pullup], [POWER Clamp], [GND Clamp]

### Subparameter Definitions:

Language:

Accepts 'SPICE', 'VHDL-AMS', 'Verilog-AMS', 'VHDL-A(MS)' or 'Verilog-A(MS)' as arguments. The Language subparameter is required and must appear only once.

Corner

Three entries follow the Corner subparameter on each line:

corner name file name circuit name

The corner\_name entry is 'Typ', 'Min', or 'Max'. The file\_name entry points to the referenced file in the same directory as the .ibs file.

Up to three Corner lines are permitted. A 'Typ' line is required. If 'Min' and/or 'Max' data is missing, the tool may use 'Typ' data in its place. However, the tool should notify the user of this action.

The circuit\_name entry provides the name of the circuit to be simulated within the referenced file. For SPICE files, this is normally a ".subckt" name. For VHDL-AMS files, this is normally an "entity(architecture)" name pair. For Verilog-AMS files, this is normally a "module" name.

No character limits, case-sensitivity limits or extension conventions are required or enforced for file\_name and circuit\_name entries. However, the total number of characters in each Corner line must comply with the rules in Section 3. Furthermore, lower-case file\_name entries are recommended to avoid possible conflicts with file naming conventions under different operating systems. Case differences between otherwise identical file\_name entries or circuit\_name entries should be avoided. External languages may not support case-sensitive distinctions.

#### Parameters:

Lists names of parameters that can be passed into an external model file. Each Parameters assignment must match a name or keyword in the external file or language. The list of Parameters may span several lines by using the word Parameters at the start of each line. The Parameters subparameter is optional, and the external model must operate with default settings without any Parameters assignments.

Parameter passing is not supported in SPICE. VHDL-AMS and VHDL-A(MS) parameters are supported using "generic" names, and Verilog-AMS and Verilog-A(MS) parameters are supported using "parameter" names.

### Ports:

Ports are interfaces to the [External Model] which are available to the user and tool at the IBIS level. They are used to connect the [External Model] to die pads. The Ports parameter is used to identify the ports of the [External Model] to the simulation tool. The port assignment is by position and the port names do not have to match exactly the names inside the external file. The list of port names may span several lines if the word Ports is used at the start of each line.

Model units under [External Model] may only use reserved ports. The reserved, pre-defined port names are listed in the General Assumptions heading above. As noted earlier, digital and analog reserved port functions will be assumed by the tool and connections made accordingly. All the ports appropriate to the particular Model\_type subparameter entry must be explicitly listed (see below). Note that the user may connect SPICE, Verilog-A(MS) and VHDL-A(MS) models to A\_to\_D and D\_to\_A converters using custom names for analog ports within the model unit, as long as the digital ports of the converters use the digital reserved port names.

The rules for pad connections with [External Model] are identical to those for [Model]. The [Pin Mapping] keyword may be used with [External Model]s but is not required. If used, the [External Model] specific voltage supply ports—A\_puref, A\_pdref, A\_gcref, A\_pcref, and A\_extref—are connected as defined under the [Pin Mapping] keyword. In all cases, the voltage levels connected on the reserved supply ports are defined by the [Power Clamp Reference], [GND Clamp Reference], [Pullup Reference], [Pulldown Reference], and/or [Voltage Range] keywords, as in the case of [Model].

### Digital-to-Analog/Analog-to-Digital Conversions:

These subparameters define all digital-to-analog and analog-to-digital converters needed to properly connect digital signals with the analog ports of referenced external SPICE, Verilog-A(MS) or VHDL-A(MS) models. These subparameters must be used when [External Model] references a file written in the SPICE, Verilog-A(MS), or VHDL-A(MS) languages. They are not permitted with Verilog-AMS or VHDL-AMS external files.

#### D to A:

As assumed in [Model], some interface ports of [External Model] circuits expect digital input signals. As SPICE, Verilog-A(MS), or VHDL-A(MS) models understand only analog signals, some conversion from digital to analog format is required. For example, input logical states such as '0' or '1,' implied in [Model], must be converted to actual input voltage stimuli, such as a voltage ramp, for SPICE simulation.

The D\_to\_A subparameter provides information for converting a digital stimulus, such as '0' or '1', into an analog voltage ramp (a digital 'X' input is ignored by D\_to\_A converters). Each digital port which carries data for conversion to analog format must have its own D\_to\_A line.

The D\_to\_A subparameter is followed by eight arguments:

d\_port port1 port2 vlow vhigh trise tfall corner\_name

The d\_port entry holds the name of the digital port. This entry is used for the reserved port names D\_drive, D\_enable, and D\_switch. The port1 and port2 entries hold the SPICE, Verilog-A(MS) or VHDL-A(MS) analog input port names across which voltages are specified. These entries are used for the user-defined port names, together with another port name, used as a reference.

Normally port1 accepts an input signal and port2 is the reference for port1. However, for an opposite polarity stimulus, port1 could be connected to a reference port and port2 could serve as the input.

The vlow and vhigh entries accept analog voltage values which must correspond to the digital off and on states, where the vhigh value must be greater than the vlow value. For example, a 3.3 V ground-referenced buffer would list vlow as 0 V and vhigh as 3.3 V. The trise and tfall entries are times, must be positive, and define input ramp rise and fall times between 0 and 100 percent.

The corner\_name entry holds the name of the external model corner being referenced, as listed under the Corner subparameter.

At least one D\_to\_A line must be present, corresponding to the 'Typ' corner model, for each digital line to be converted. Additional D\_to\_A lines for other corners may be omitted. In this case, the typical corner D\_to\_A entries will apply to all model corners and the 'Typ' corner\_name entry may be omitted.

### A to D:

The A\_to\_D subparameter is used to generate a digital state ('0', '1', or 'X') based on analog voltages generated by the SPICE, Verilog-A(MS) or VHDL-A(MS) model or analog voltages present at the pad/pin. This allows an analog signal from the external SPICE, Verilog-A(MS) or VHDL-A(MS) circuit or pad/pin to be read as a digital signal by the simulation tool.

The A\_to\_D subparameter is followed by six arguments:

d\_port port1 port2 vlow vhigh corner\_name

The d\_port entry lists the reserved port name D\_receive. As with D\_to\_A, the port1 entry would normally contain the reserved name A\_signal (see below) or a user-defined port name, while port2 may list any other analog reserved port name, used as a reference. The voltage measurements are taken in this example from the port1 entry with respect to the port2 entry. These ports must also be named by the Ports subparameter.

The vlow and vhigh entries list the low and high analog threshold voltage values. The reported digital state on D\_receive will be '0' if the measured voltage is lower than the vlow value, '1' if above the vhigh value, and 'X' otherwise.

The corner\_name entry holds the name of the external model corner being referenced, as listed under the Corner subparameter.

At least one A\_to\_D line must be supplied corresponding to the 'Typ' corner model. Other A\_to\_D lines for other corners may be omitted. In this case, the typical corner A\_to\_D entries will apply to all model corners.

IMPORTANT: measurements for receivers in IBIS are normally assumed to be conducted at the die pads/pins. In such cases, the electrical input model data comprises a "load" which affects the waveform seen at the pads. However, for models measure the analog input response at the die pads or inside the circuit (this does not preclude tools from reporting digital D\_receive and/or analog port responses in addition to at-pad A\_signal response). If at-pad measurements are desired, the A\_signal port would be named in the A\_to\_D line under port1. The A\_to\_D converter then effectively acts "in parallel" with the load of the circuit. If internal measurements are desired (e.g., if the user wishes to view the signal after processing by the receiver), the user-defined signal port would be named in the A\_to\_D line under port1. The A\_to\_D converter is effectively "in series" with the receiver model. The vhigh and vlow parameters should be adjusted as appropriate to the measurement point of interest.

Note that, while the port assignments and SPICE, Verilog-A(MS) or VHDL-A(MS) model must be provided by the user, the D\_to\_A and A\_to\_D converters will be provided automatically by the tool (the converter parameters must still be declared by the user). There is no need for the user to develop external SPICE, Verilog-A(MS) or VHDL-A(MS) code specifically for these functions.

A conceptual diagram of the port connections of a SPICE, Verilog-A(MS) or VHDL-A(MS) [External Model] is shown in Figure 24. The example illustrates an I/O buffer. Note that the drawing implies that the D\_receive state changes in response to the analog signal my\_receive, not A\_signal:

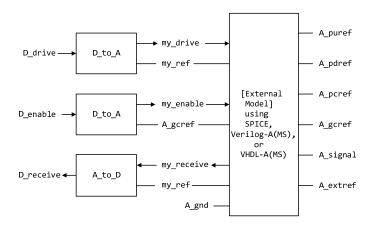


Figure 24 - Example of an [External Model] I/O Buffer Using SPICE, Verilog-A(MS), or VHDL-A(MS)

#### Pseudo-Differential Buffers:

Pseudo-differential buffers may be described using a pair of [External Model]s which may or may not be identical. Each of the analog I/O signal ports (usually A\_signal) is connected to a specific pad through the [Pin] list in the usual fashion, and the two ports are linked together as a differential pair through the [Diff Pin] keyword.

The reserved signal name A\_signal is required for the I/O signal ports of [External Model]s connected to pads used in a pseudo-differential configuration.

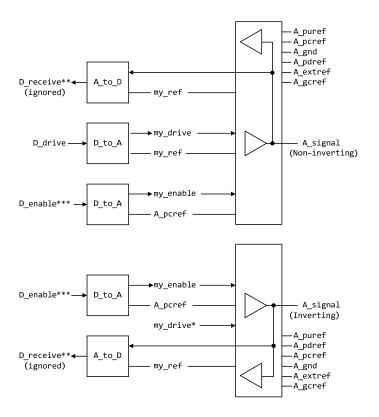
Users should note that, in pseudo-differential buffers, only one formal signal port is used to stimulate the two [External Model] digital inputs (D\_drive). One of these inputs will reflect the timing and polarity of the formal signal port named by the user, while the other input is inverted and (potentially) delayed with respect to the formal port as defined under the [Diff Pin] keyword. THIS SECOND PORT IS AUTOMATICALLY CREATED BY THE SIMULATION TOOL. Users do not have to create special structures to invert or delay the driven digital signal. Simulation tools will correctly implement the two input ports once the [Diff Pin] keyword has been detected in the .ibs file. This approach is identical to that used in native IBIS.

The D\_to\_A adapters used for SPICE, Verilog-A(MS) or VHDL-A(MS) files can be set up to control ports on pseudo-differential buffers. If SPICE, Verilog-A(MS) or VHDL-A(MS) is used as an external language, the [Diff Pin] vdiff subparameter overrides the contents of vlow and vhigh under A\_to\_D.

IMPORTANT: For pseudo-differential buffers under [External Model], the analog input response may only be measured at the die pads. The [Diff Pin] parameter is required, and controls both the polarity and the differential thresholds used to determine the D\_receive port response (the D\_receive port will follow the state of the non-inverting pin/pad as referenced to the inverting

pin/pad). For SPICE, Verilog-A(MS) or VHDL-A(MS) models, the A\_to\_D line must name the A\_signal port under either port1 or port2, as with a single-ended buffer. The A\_to\_D converter then effectively acts "in parallel" with the load of the buffer circuit. The vhigh and vlow parameters will be overriden by the [Diff Pin] vdiff declarations.

The port relationships are shown in Figure 25.



- \* This signal is automatically created, by inverting and delaying D\_drive based on the information in [Diff Pin].
- \*\* Pseudo-differential buffers must have A\_to\_D entries, but D\_receive is determined by the state of A\_signal (Inverting) and A\_signal (Non-inverting) according to the [Diff Pin] declaration.
- \*\*\*  $\ensuremath{\text{D}}\xspace_{-}$  enable is shared between the separate buffers. This sharing is handled by the EDA tool.

Figure 25 -Example SPICE, Verilog-A(MS) or VHDL-A(MS) Implementation

<u>Figure 26Figure 26</u> illustrates the same concepts with a \*-AMS model. Note that the state of D\_receive is determined by the tool automatically by observing the A\_signal ports. The outputs of the actual receiver circuits in the \*-AMS models are not used for determining D\_receive.

A\_puref (ignored) A\_pcref A\_gnd A\_gcref D drive A\_pdref -A\_signal (Non-inverting) D\_enable\*\*\* A\_puref D\_enable\*\*\* -A\_pcref A\_signal (Inverting) (D\_drive\*) -A\_gcref -A pdref A\_gnd D\_receive\*\* (ignored)

- \* This signal is automatically created, by inverting and delaying D\_drive based on the information in [Diff Pin] (digital output will be based on evaluation of signals %% and && also using [Diff Pin]).
- \*\* D\_receive for pseudo-differential buffers is determined by the state of A\_signal (Inverting) and A\_signal (Non-inverting) according to the [Diff Pin] declaration.
- \*\*\* D\_enable is shared between the separate buffers. This sharing is handled by the EDA tool.

Figure 26 - Example \*-AMS Implementation

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Two additional differential timing test loads are available:

Rref\_diff, Cref\_diff

These subparameters are also available under the [Model Spec] keyword for typical, minimum, and maximum corners.

These timing test loads require both sides of the differential model to be operated. They can be used with the existing timing test loads Rref, Cref, and Vref. The existing timing test loads and Vmeas are used if Rref\_diff and Cref\_diff are NOT given.

### True Differential Models:

True differential buffers may be described using [External Model]. In a true differential [External Model], the differential I/O ports which connect to die pads use the reserved names A\_signal\_pos and A signal neg, as shown in Figure 27.

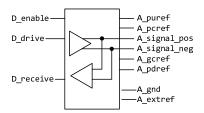


Figure 27 - Port Names for True Differential I/O Buffer

IMPORTANT: All true differential models under [External Model] assume single-ended digital port connections (D\_drive, D\_enable, D\_receive).

The [Diff Pin] keyword is still required within the same [Component] definition when [External Model] describes a true differential buffer. The [Model] names or [Model Selector] names referenced by the pair of pins listed in an entry of the [Diff Pin] MUST be the same.

The D\_to\_A or A\_to\_D adapters used for SPICE, Verilog-A(MS) or VHDL-A(MS) files may be set up to control or respond to true differential ports. An example is shown in Figure 28.

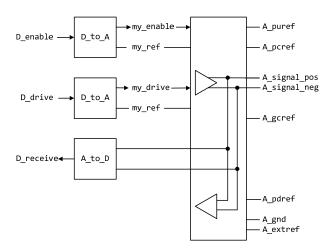


Figure 28 - Example SPICE, Verilog-A(MS) or VHDL-A(MS) Implementation of a True Differential Buffer

If at-pad or at-pin measurement using a SPICE, Verilog-A(MS) or VHDL-A(MS) [External Model] is desired, the vlow and vhigh entries under the A\_to\_D subparameter must be consistent with the values of the [Diff Pin] vdiff subparameter entry (the vlow value must match -vdiff, and the vhigh value must match +vdiff). The logic states produced by the A\_to\_D conversion follow the same rules as for single-ended buffers, listed above. An example is shown at the end of this section.

IMPORTANT: For true-differential buffers under [External Model], the user can choose whether to measure the analog input response at the die pads or internal to the circuit (this does not preclude tools from reporting digital D\_receive and/or analog responses in addition to at-pad A\_signal response). If at-pad measurements for a SPICE, Verilog-A(MS) or VHDL-A(MS) model are desired, the A\_signal\_pos port would be named in the A\_to\_D line under port1 and A\_signal\_neg under port2. The A\_to\_D converter then effectively acts "in parallel" with the load of the buffer circuit. If internal measurements are desired (e.g., if the user wishes to view the signal after processing by the input buffer), the user-defined analog signal port would be named in the A\_to\_D line under port1. The A\_to\_D converter is "in series" with the receiver buffer model. The vhigh and vlow parameters should be adjusted appropriate to the measurement point of interest, so long as they as they are consistent with the [Diff Pin] vdiff declarations.

Note that the thresholds refer to the state of the non-inverting signal, using the inverting signal as a reference. Therefore, the output signal is considered high when, for example, the non-inverting input is +200 mV above the inverting input. Similarly, the output signal is considered low when the same non-inverting input is -200 mV "above" the inverting input.

EDA tools will report the state of the D\_receive port for true differential \*-AMS [External Model]s according to the AMS code written by the model author; the use of [Diff Pin] does not affect the

reporting of D\_receive in this case. EDA tools are free to additionally report the state of the I/O pads according to the [Diff Pin] vdiff subparameter.

For SPICE, Verilog-A(MS) or VHDL-A(MS) and \*-AMS true differential [External Model]s, the EDA tool must not override or change the model author's connection of the D\_receive port.

Four additional Model\_type arguments are available under the [Model] keyword. One of these must be used when an [External Model] describes a true differential model:

I/O\_diff, Output\_diff, 3-state\_diff, Input\_diff

Two additional differential timing test loads are available:

Rref diff, Cref diff

These subparameters are also available under the [Model Spec] keyword for the typical, minimum, and maximum corner cases.

These timing test loads require that both the inverting and non-inverting ports of the differential model refer to valid buffer model data (not terminations, supply rails, etc.). The differential test loads may also be combined with the single-ended timing test loads Rref, Cref, and Vref. Note that the single-ended timing test loads plus Vmeas are used if Rref\_diff and Cref\_diff are NOT supplied.

### Series and Series Switch Models:

Native IBIS did not define the transition characteristics of digital switch controls. Switches were assumed to either be on or off during a simulation and I-V characteristics could be defined for either or both states. The [External Model] format allows users to control the state of a switch through the D\_switch port. As with other digital ports, the use of SPICE, Verilog-A(MS) or VHDL-A(MS) in an [External Model] requires the user to declare D\_to\_A ports, to convert the D\_switch signal to an analog input to the SPICE, Verilog-A(MS) or VHDL-A(MS) model (whether the port's state may actually change during a simulation is determined by the EDA tool used).

Series and Series\_switch devices both are described under the [External Model] keyword using the reserved port names A\_pos and A\_neg. Note that the [Series Pin Mapping] keyword must be present and correctly used elsewhere in the file, in order to properly set the logic state of the switch. The A\_pos port is defined in the first entry of the [Series Pin Mapping] keyword, and the A\_neg port is defined in the pin2 entry. For series switches, the [Series Switch Groups] keyword is required.

## Ports required for various Model\_types:

As [External Model] makes use of the [Model] keyword's Model\_type subparameter, not all digital and analog reserved ports may be needed for all Model\_types. Table 13 and Table 14 below define which reserved port names are required for various Model\_types.

Model type D drive D\_enable **D**\_receive D\_switch A signal A\_pos A neg I/O\* X X X X 3-state\* X X X Output\*, X X

Table 13 {Caption needed}

Open*						
Input		X	X			
Terminator			X			
Series					X	X
Series_switch				X	X	X

## Table 14 {Caption needed}

Model_type	D_drive	D_enable	D_receive	A_signal_pos	A_signal_neg
I/O_diff	X	X	X	X	X
3-state_diff	X	X		X	X
Output_diff	X			X	X
Input_diff			X	X	X

## Examples:

## Example [External Model] using SPICE:

```
[Model] ExBufferSPICE
Model_type I/O
Vinh = 2.0
Vinl = 0.8
  Other model subparameters are optional
                    typ
                             min
                                     max
[Voltage Range]
                    3.3
                             3.0
                                     3.6
[Ramp]
dV/dt_r
                 1.57/0.36n 1.44/0.57n
                                             1.73/0.28n
dV/dt_f
                 1.57/0.35n
                              1.46/0.44n
                                             1.68/0.28n
[External Model]
Language SPICE
  Corner corner_name file_name
                                           circuit_name (.subckt name)
                        buffer_typ.spi buffer_io_typ
           Тур
Corner
Corner
           Min
                         buffer_min.spi buffer_io_min
Corner
                        buffer_max.spi buffer_io_max
  Parameters - Not supported in SPICE
Ports List of port names (in same order as in SPICE)
Ports A_signal my_drive my_enable my_receive my_ref
Ports A_puref A_pdref A_pcref A_gcref A_extref
D_to_A d_port port1 port2 vlow vhigh trise tfall corner_name D_to_A D_drive my_drive my_ref 0.0 3.3 0.5n 0.3n Typ D_to_A D_enable my_enable A_gcref 0.0 3.3 0.5n 0.3n Typ
```

```
A_to_D d_port
                port1
                         port2
                                      vlow vhigh corner_name
A_to_D D_receive my_receive my_ref 0.8 2.0
                                                   Тур
 Note: A_signal might also be used instead of a user-defined interface port
 for measurements taken at the die pads
[End External Model]
Example [External Model] using VHDL-AMS:
[Model] ExBufferVHDL
Model_type I/O
Vinh = 2.0
Vinl = 0.8
 Other model subparameters are optional
                         min
                                max
                 typ
[Voltage Range]
                3.3
                         3.0
                                3.6
[Ramp]
dV/dt_r
              1.57/0.36n 1.44/0.57n
                                       1.73/0.28n
              1.57/0.35n 1.46/0.44n 1.68/0.28n
dV/dt_f
[External Model]
Language VHDL-AMS
 Corner corner_name file_name
                                     entity(architecture)
                     buffer_typ.vhd buffer(buffer_io_typ)
Corner
         Тур
                    buffer_min.vhd buffer(buffer_io_min)
Corner
         Min
Corner
         Max
                    buffer_max.vhd buffer(buffer_io_max)
Parameters List of parameters
Parameters delay rate
Parameters preemphasis
Ports List of port names (in same order as in VHDL-AMS)
Ports A_signal A_puref A_pdref A_pcref A_gcref
Ports D_drive D_enable D_receive
[End External Model]
Example [External Model] using Verilog-AMS:
[Model] ExBufferVerilog
Model_type I/O
Vinh = 2.0
Vinl = 0.8
 Other model subparameters are optional
                         min
                                max
                 typ
[Voltage Range]
                 3.3
                         3.0
                                3.6
[Ramp]
              1.57/0.36n 1.44/0.57n 1.73/0.28n
dV/dt_r
```

```
1.57/0.35n 1.46/0.44n 1.68/0.28n
dV/dt_f
[External Model]
Language Verilog-AMS
 Corner corner_name file_name
                                     circuit_name (module)
          Тур
                      buffer_typ.v buffer_io_typ
                      buffer_min.v buffer_io_min
buffer_max.v buffer_io_max
Corner
          Min
Corner
          Max
 Parameters List of parameters
Parameters delay rate
Parameters preemphasis
 Ports List of port names (in same order as in Verilog-AMS)
Ports A_signal A_puref A_pdref A_pcref A_gcref
Ports D_drive D_enable D_receive
End External Modell
Example [External Model] using VHDL-A(MS):
[Model] ExBufferVHDL_analog
Model_type I/O
Vinh = 2.0
Vinl = 0.8
  Other model subparameters are optional
                           min
                                  max
                   typ
[Voltage Range]
                  3.3
                           3.0
                                  3.6
[Ramp]
               1.57/0.36n 1.44/0.57n
dV/dt_r
                                         1.73/0.28n
dV/dt_f
               1.57/0.35n
                            1.46/0.44n
                                         1.68/0.28n
[External Model]
Language VHDL-A(MS)
 Corner corner_name file_name
                                       circuit_name entity(architecture)
Corner
                      buffer_typ.vhd buffer(buffer_io_typ)
         Tvp
                       buffer_min.vhd buffer(buffer_io_min)
Corner
          Min
Corner
          Max
                      buffer_max.vhd buffer(buffer_io_max)
 Parameters List of parameters
Parameters delay rate
Parameters preemphasis
 Ports List of port names (in same order as in VHDL-A(MS))
Ports A_signal my_drive my_enable my_receive my_ref
Ports A_puref A_pdref A_pcref A_gcref A_extref
D_to_A d_port port1 port2 vlow vhigh trise tfall D_to_A D_drive my_drive my_ref 0.0 3.3 0.5n 0.3n
                                     vlow vhigh trise tfall corner_name
D_to_A D_enable my_enable A_gcref 0.0 3.3 0.5n 0.3n
```

```
A_to_D d_port
                 port1
                          port2
                                        vlow vhigh corner_name
A_to_D D_receive my_receive my_ref 0.8 2.0
                                                     Tvp
  Note: A_signal might also be used instead of a user-defined interface port
 for measurements taken at the die pads
Example [External Model] using Verilog-A(MS):
[Model] ExBufferVerilog_analog
Model_type I/O
Vinh = 2.0
Vinl = 0.8
  Other model subparameters are optional
                  typ
                          min
                                 max
[Voltage Range]
                          3.0
                 3.3
                                 3.6
[Ramp]
               1.57/0.36n 1.44/0.57n
dV/dt_r
                                        1.73/0.28n
dV/dt_f
               1.57/0.35n 1.46/0.44n
                                        1.68/0.28n
[External Model]
Language Verilog-A(MS)
| Corner corner_name file_name
                                     circuit_name (module)
                     buffer_typ.va buffer_io_typ
Corner
         Тур
Corner
         Min
                      buffer_min.va buffer_io_min
Corner
         Max
                      buffer_max.va buffer_io_max
| Parameters List of parameters
Parameters delay rate
Parameters preemphasis
| Ports List of port names (in same order as in Verilog-A(MS))
Ports A_signal my_drive my_enable my_receive my_ref
Ports A_puref A_pdref A_pcref A_gcref A_extref
D_to_A d_port port1 port2 vlow vhigh trise tfall corner_name D_to_A D_drive my_drive my_ref 0.0 3.3 0.5n 0.3n Typ
D_to_A D_enable my_enable A_gcref 0.0 3.3 0.5n 0.3n
                    port1
                                 port2
                                        vlow vhigh corner_name
 A_to_D d_port
A_to_D D_receive my_receive my_ref 0.8 2.0
  Note: A_signal might also be used instead of a user-defined interface port
 for measurements taken at the die pads
[End External Model]
Example of True Differential [External Model] using SPICE:
[Model] Ext_SPICE_Diff_Buff
Model_type I/O_diff
Rref_diff = 100
```

```
Other model subparameters are optional
                         min
                                max
                  typ
[Voltage Range]
                 3.3
                         3.0
                                3.6
[Ramp]
dV/dt_r
              1.57/0.36n
                          1.44/0.57n
                                        1.73/0.28n
dV/dt f
              1.57/0.35n
                           1.46/0.44n
                                        1.68/0.28n
[External Model]
Language SPICE
 Corner corner_name file_name
                                 circuit_name (.subckt name)
Corner
                     diffio.spi diff_io_typ
Corner
         Min
                     diffio.spi diff_io_min
                     diffio.spi diff_io_max
Corner
         Max
 Ports List of port names (in same order as in SPICE)
Ports A_signal_pos A_signal_neg my_receive my_drive my_enable
Ports A_puref A_pdref A_pcref A_gcref A_extref my_ref A_gnd
 D_to_A d_port
                  port1
                             port2
                                      vlow vhigh trise tfall corner_name
         D_drive my_drive
                             my_ref
                                      0.0 3.3
                                                 0.5n 0.3n Typ
D to A
                                                 0.6n 0.3n Min
D_to_A
         D_drive my_drive
                             my_ref
                                      0.0 3.0
                                                       0.3n
D_to_A
         D_drive my_drive
                             my_ref
                                      0.0
                                           3.6
                                                 0.4n
         D_enable my_enable
                             my_ref
                                                 0.5n 0.3n
                                      0.0 3.3
D_to_A
                                                             Тур
D_to_A
         D_enable my_enable
                             my_ref
                                      0.0 3.0
                                                 0.6n 0.3n Min
         D_enable my_enable my_ref
                                      0.0 3.6
                                                 0.4n 0.3n Max
D_to_A
A_to_D d_port
                    port1
                                  port2
                                                vlow
                                                       vhigh corner_name
                                                -200m
                                                       200m Typ
         D_receive A_signal_pos A_signal_neg
A_to_D
A_to_D
         D_receive A_signal_pos A_signal_neg
                                                -200m
                                                       200m
                                                             Min
A_to_D
         D_receive A_signal_pos A_signal_neg
                                                -200m 200m Max
[End External Model]
Example of True Differential [External Model] using VHDL-AMS:
[Model] Ext_VHDL_Diff_Buff
Model_type I/O_diff
Rref_diff = 100
                         min
                 typ
                                max
```

```
[Voltage Range]
                 3.3
                          3.0
                                 3.6
[Ramp]
               1.57/0.36n
                          1.44/0.57n
dV/dt r
                                         1.73/0.28n
dV/dt_f
               1.57/0.35n
                           1.46/0.44n
                                        1.68/0.28n
 Other model subparameters are optional
[External Model]
Language VHDL-AMS
 Corner corner_name
                       file_name
                                       entity(architecture)
Corner
                       diffio_typ.vhd buffer(diff_io_typ)
         Typ
```

```
diffio_min.vhd buffer(diff_io_min)
diffio_max.vhd buffer(diff_io_max)
Corner
         Max
 Parameters List of parameters
Parameters delay rate
Parameters preemphasis
 Ports List of port names (in same order as in VHDL-AMS)
Ports A_signal_pos A_signal_neg D_receive D_drive D_enable
Ports A_puref A_pdref A_pcref A_gcref
[End External Model]
Example of Pseudo-Differential [External Model] using SPICE:
 Note that [Pin] and [Diff Pin] declarations are shown for clarity
[Pin] signal_name model_name R_pin L_pin C_pin
1 Example_pos Ext_SPICE_PDiff_Buff
2 Example_neg Ext_SPICE_PDiff_Buff
 . . .
[Diff Pin] inv_pin vdiff tdelay_typ tdelay_min tdelay_max
            2
                 200mV
                         0ns
                                  0ns
[Model] Ext_SPICE_PDiff_Buff
Model_type I/O
 Other model subparameters are optional
                         min
                                 max
[Voltage Range]
                          3.0
                3.3
                                 3.6
[Ramp]
dV/dt_r
              1.57/0.36n
                           1.44/0.57n
                                        1.73/0.28n
dV/dt_f
               1.57/0.35n
                           1.46/0.44n
                                         1.68/0.28n
[External Model]
Language SPICE
 Corner corner_name file_name
                                  circuit_name (.subckt name)
                       diffio.spi diff_io_typ
Corner
          Тур
                       diffio.spi diff_io_min
Corner
          Min
                       diffio.spi diff_io_max
Corner
Ports List of port names (in same order as in SPICE)
Ports A_signal my_drive my_enable my_ref
Ports A_puref A_pdref A_pcref A_gcref A_gnd A_extref
                             port2
D_to_A d_port port1
                                     vlow vhigh trise tfall corner_name
D_to_A D_drive my_drive my_ref 0.0 3.3 0.5n 0.3n Typ
D_to_A
         D_drive my_drive my_ref
                                      0.0 3.0 0.6n 0.3n Min
```

Min

Corner

```
D_drive my_drive my_ref 0.0 3.6
                                              0.4n 0.3n Max
D_to_A
        D_enable my_enable A_pcref 0.0 3.3
D_to_A
                                              0.5n 0.3n
                                                          Typ
D_to_A D_enable my_enable A_pcref 0.0 3.0
                                              0.6n 0.3n Min
D_to_A D_enable my_enable A_pcref 0.0 3.6 0.4n 0.3n Max
 A_to_D d_port
                  port1
                           port2
                                     vlow vhigh corner_name
A_to_D D_receive A_signal my_ref
                                      0.8
                                           2.0
                                                  Typ
                                      0.8
                                             2.0
A to D
         D_receive A_signal my_ref
                                                  Min
A_to_D
         D_receive A_signal my_ref
                                      0.8
                                            2.0
                                                  Max
 This example shows the evaluation of the received signals at the die
 pads. [Diff Pin] defines the interpretation of the A_to_D output
 polarity and levels and overrides the A_to_D settings shown above.
[End External Model]
```

Keywords: [External Circuit], [End External Circuit]

Required: No

Description: Used to reference an external file containing an arbitrary circuit description using one of the supported languages.

Sub-Params: Language, Corner, Parameters, Ports, D\_to\_A, A\_to\_D

*Usage Rules:* Each [External Circuit] keyword must be followed by a unique name that differs from any name used for any [Model] or [Submodel] keyword.

The [External Circuit] keyword may appear multiple times. It is not scoped by any other keyword.

Each instance of an [External Circuit] is referenced by one or more [Circuit Call] keywords discussed later. (The [Circuit Call] keyword cannot be used to reference a [Model] keyword.)

The [External Circuit] keyword and contents may be placed anywhere in the file, outside of any [Component] keyword group or [Model] keyword group, in a manner similar to that of the [Model] keyword.

Subparameter Definitions:

Language:

Accepts 'SPICE', 'VHDL-AMS', 'Verilog-AMS', 'VHDL-A(MS)' or 'Verilog-A(MS)' as arguments. The Language subparameter is required and must appear only once.

Corner

Three entries follow the Corner subparameter on each line:

corner\_name file\_name circuit\_name

The corner\_name entry is 'Typ', 'Min', or 'Max'. The file\_name entry points to the referenced file in the same directory as the .ibs file.

Up to three Corner lines are permitted. A 'Typ' line is required. If 'Min' and/or 'Max' data is missing, the tool may use 'Typ' data in its place. However, the tool should notify the user of this action.

The circuit\_name entry provides the name of the circuit to be simulated within the referenced file. For SPICE files, this is normally a ".subckt" name. For VHDL-AMS files, this is normally an "entity(architecture)" name pair. For Verilog-AMS files, this is normally a "module" name.

No character limits, case-sensitivity limits or extension conventions are required or enforced for file\_name and circuit\_name entries. However, the total number of characters in each Corner line must comply with Section 3. Furthermore, lower-case file\_name entries are recommended to avoid possible conflicts with file naming conventions under different operating systems. Case differences between otherwise identical file\_name entries or circuit\_name entries should be avoided. External languages may not support case-sensitive distinctions.

#### Parameters:

Lists names of parameters that may be passed into an external circuit file. Each Parameters assignment must match a name or keyword in the external file or language. The list of Parameters can span several lines by using the word Parameters at the start of each line. The Parameters subparameter is optional, and the external circuit must operate with default settings without any Parameters assignments.

Parameter passing is not supported in SPICE. VHDL-AMS and VHDL-A(MS) parameters are supported using "generic" names, and Verilog-AMS and Verilog-A(MS) parameters are supported using "parameter" names.

### Ports:

Ports are interfaces to the [External Circuit] which are available to the user and tool at the IBIS level. They are used to connect the [External Circuit] to die pads. The Ports parameter is used to identify the ports of the [External Circuit] to the simulation tool. The port assignment is by position and the port names do not have to match exactly the names inside the external file. The list of port names may span several lines if the word Ports is used at the start of each line.

The Ports parameter is used to identify the ports of the [External Circuit] to the simulation tool. The port assignment is by position and the port names do not have to match exactly the port names in the external file. The list of port names may span several lines if the word Ports is used at the start of each line.

[External Circuit] allows any number of ports to be defined, with any names which comply with Section 3 format requirements. Reserved port names may be used, but ONLY DIGITAL PORTS will have the pre-defined functions listed in the General Assumptions heading above. User-defined and reserved port names may be combined within the same [External Circuit].

The [Pin Mapping] keyword cannot be used with [External Circuit] in the same [Component] description.

Digital-to-Analog/Analog-to-Digital Conversions:

These subparameters define all digital-to-analog and analog-to-digital converters needed to properly connect digital signals with the analog ports of referenced external SPICE, Verilog-A(MS) or VHDL-A(MS) models. These subparameters must be used when [External Circuit] references a file written in the SPICE, Verilog-A(MS) or VHDL-A(MS) language. They are not permitted with Verilog-AMS or VHDL-AMS external files.

## D to A:

As assumed in [Model] and [External Model], some interface ports of [External Circuit]s expect digital input signals. As SPICE, Verilog-A(MS) or VHDL-A(MS) models understand only analog

signals, some conversion from digital to analog format is required. For example, input logical states such as '0' or '1' must be converted to actual input voltage stimuli, such as a voltage ramp, for SPICE simulation.

The D\_to\_A subparameter provides information for converting a digital stimulus, such as '0' or '1', into an analog voltage ramp (a digital 'X' input is ignored by D\_to\_A converters). Each digital port which carries data for conversion to analog format must have its own D\_to\_A declaration.

The D\_to\_A subparameter is followed by eight arguments:

d\_port port1 port2 vlow vhigh trise tfall corner\_name

The d\_port entry holds the name of the digital port. This entry may contain user-defined port names or the reserved port names D\_drive, D\_enable, and D\_switch. he port1 and port2 entries hold the SPICE, Verilog-A(MS) or VHDL-A(MS) analog input port names across which voltages are specified. These entries contain user-defined port names. One of these port entries must name a reference for the other port (for example, A\_gnd).

Normally, port1 accepts an input signal and port2 is the reference for port1. However, for an opposite polarity stimulus, port1 could be connected to a voltage reference and port2 could serve as the input.

The vlow and vhigh entries accept voltage values which correspond to fully-off and fully-on states, where the vhigh value must be greater than the vlow value. For example, a 3.3 V ground-referenced buffer would list vlow as 0 V and vhigh as 3.3 V. The trise and tfall entries are times, must be positive and define input ramp rise and fall times between 0 and 100 percent.

The corner\_name entry holds the name of the external circuit corner being referenced, as listed under the Corner subparameter.

Any number of D\_to\_A subparameter lines is allowed, so long as each contains a unique port name entry and at least one unique port1 or port2 entry (i.e., several D\_to\_A declarations may use the same reference node under port1 or port2). At least one D\_to\_A line must be present, corresponding to the 'Typ' corner model, for each digital line to be converted. Additional D\_to\_A lines for other corners may be omitted. In this case, the typical corner D\_to\_A entries will apply to all model corners and the 'Typ' corner name entry may be omitted.

## A to D:

The A\_to\_D subparameter is used to generate a digital state ('0', '1', or 'X') based on analog voltages from the SPICE, Verilog-A(MS) or VHDL-A(MS) model or from the pad/pin. This allows an analog signal from the external SPICE, Verilog-A(MS) or VHDL-A(MS) circuit to be read as a digital signal by the simulation tool.

The A to D subparameter is followed by six arguments:

d\_port port1 port2 vlow vhigh corner\_name

The d\_port entry lists port names to be used for digital signals going. As with D\_to\_A, the port1 entry would contain a user-defined analog signal. Port2 would list another port name to be used as a reference. The voltage measurements are taken from the port1 entry with respect to the port2 entry. These ports must also be named by the Ports subparameter.

The vlow and vhigh entries list the low and high analog threshold voltage values. The reported digital state on D\_receive will be '0' if the measured voltage is lower than the vlow value, '1' if above the vhigh value, and 'X' otherwise.

The corner\_name entry holds the name of the external model corner being referenced, as listed under the Corner subparameter.

Any number of A\_to\_D subparameter lines is allowed, so long as each line contains at least one column entry which is distinct from the column entries of all other lines. In practice, this means that A\_to\_D subparameter lines describing different corners will have identical port names. Other kinds of variations described through A\_to\_D subparameter lines should use unique port names. For example, a user may wish to create additional A\_to\_D converters for individual analog signals to monitor common mode behaviors on differential buffers.

At least one A\_to\_D line must be supplied corresponding to the 'Typ' corner model. Other A\_to\_D lines for other corners may be omitted. In this case, the typical corner D\_to\_A entries will apply to all model corners.

IMPORTANT: measurements for receivers in IBIS may be conducted at the die pads or the pins. In such cases, the electrical input model data comprises a "load" which affects the waveform seen. However, for [External Circuit]s, the user may choose whether to measure the analog input response in the usual fashion or internal to the circuit (this does not preclude tools from reporting digital D\_receive and/or analog responses in addition to normal A\_signal response). If native IBIS measurements are desired, the A\_signal port would be named in the A\_to\_D line under port1. The A\_to\_D converter then effectively acts "in parallel" with the load of the circuit. If internal measurements are desired (e.g., if the user wishes to view the signal after processing by the receiver), the user-defined analog signal port would be named in the A\_to\_D line under port1. The A\_to\_D converter is effectively "in series" with the receiver model. The vhigh and vlow parameters should be adjusted appropriate to the measurement point of interest.

Note that, while the port assignments and SPICE, Verilog-A(MS) or VHDL-A(MS) model data must be provided by the user, the D\_to\_A and A\_to\_D converters will be provided automatically by the tool. There is no need for the user to develop external SPICE, Verilog-A(MS) or VHDL-A(MS) code specifically for these functions.

The [Diff Pin] keyword is NOT required for true differential [External Circuit] descriptions. Pseudo-differential buffers are not supported under [External Circuit]. Use the existing [Model]

and [External Model] keywords to describe these structures.

Note that the EDA tool is responsible for determining the specific measurement points for reporting timing and signal quality for [External Circuit]s.

In all other respects, [External Circuit] behaves exactly as [External Model].

Examples:

## Model B as an [External Circuit] Example [External Circuit] using SPICE:

```
Ports List of port names (in same order as in SPICE)
Ports A_signal int_in int_en int_out A_control
Ports A_puref A_pdref A_pcref A_gcref
D_to_A d_port port1
                        port2 vlow vhigh trise tfall corner_name
D_to_A D_drive int_in my_gcref 0.0 3.3 0.5n 0.3n Typ
       D_drive int_in my_gcref 0.0 3.0 D_drive int_in my_gcref 0.0 3.6
                                           0.6n 0.3n
D to A
                                                       Min
D_to_A
                                           0.4n 0.3n
D_to_A D_enable int_en my_gnd 0.0 3.3
                                           0.5n 0.3n Typ
D_to_A D_enable int_en my_gnd
                                0.0 3.0
                                            0.6n 0.3n Min
D_to_A
       D_enable int_en my_gnd
                                 0.0 3.6
                                            0.4n 0.3n Max
A_to_D d_port
                  port1
                          port2
                                     vlow vhigh corner_name
        D_receive int_out my_gcref 0.8 2.0
D_receive int_out my_gcref 0.8 2.0
A_to_D
A to D
                                                 Min
         D_receive int_out my_gcref 0.8 2.0
A_to_D
 Note, the A_signal port might also be used and int_out not defined in
 a modified .subckt.
[End External Circuit]
 _____
 Example [External Circuit] using VHDL-AMS:
 _____
[External Circuit] BUFF-VHDL
Language VHDL-AMS
                                   entity(architecture)
 Corner corner_name file_name
Corner
         Тур
                     buffer_typ.vhd bufferb(buffer_io_typ)
                     buffer_min.vhd bufferb(buffer_io_min)
Corner
         Min
Corner
         Max
                    buffer_max.vhd bufferb(buffer_io_max)
 Parameters List of parameters
Parameters delay rate
Parameters preemphasis
Ports List of port names (in same order as in VHDL-AMS)
Ports A_signal A_puref A_pdref A_pcref A_gcref A_control
Ports D_drive D_enable D_receive
[End External Circuit]
Example [External Circuit] using Verilog-AMS:
[External Circuit] BUFF-VERILOG
Language Verilog-AMS
 Corner corner_name file_name
                                circuit_name (module)
                    buffer_typ.v bufferb_io_typ
Corner
         Тур
                    buffer_min.v bufferb_io_min
Corner
         Min
Corner
         Max
                    buffer_max.v bufferb_io_max
```

```
| Parameters List of parameters
Parameters delay rate
Parameters preemphasis
Ports List of port names (in same order as in Verilog-AMS)
Ports A_signal A_puref A_pdref A_pcref A_gcref A_control
Ports D_drive D_enable D_receive
[End External Circuit]
 Interconnect Structure as an [External Circuit]
 Example [External Circuit] using SPICE:
 -----
[External Circuit] BUS_SPI
Language SPICE
                   file_name circuit_name (.subckt name)
bus_typ.spi Bus_typ
 Corner corner_name file_name
Corner
         Тур
                   bus_min.spi Bus_min
Corner
         Min
Corner
         Max
                    bus_max.spi Bus_max
 Parameters - Not supported in SPICE
 Ports are in same order as defined in SPICE
Ports vcc gnd iol io2
Ports int_ioa vccal vcca2 vssal vssa2
Ports int_iob vccb1 vccb2 vssb1 vssb2
 No A_to_D or D_to_A required, as no digital ports are used
[End External Circuit]
Example [External Circuit] using VHDL-AMS:
[External Circuit] BUS_VHD
Language VHDL-AMS
 Corner corner_name file_name entity(architecture)
              bus.vhd
                             Bus(Bus_typ)
Corner
         Typ
Corner
         Min
                               Bus(Bus_min)
Corner
         Max
                   bus.vhd
                                Bus(Bus_max)
 Parameters List of parameters
Parameters r1 11
Parameters r2 12 temp
Ports are in the same order as defined in VHDL-AMS
Ports vcc gnd iol io2
Ports int_ioa vccal vcca2 vssal vssa2
Ports int_iob vccbl vccb2 vssbl vssb2
```

```
Example [External Circuit] using Verilog-AMS:
[External Circuit] BUS_V
Language Verilog-AMS
 Corner corner_name file_name circuit_name (module)
Corner
         Tvp
              bus.v Bus_typ
Corner
         Min
                     bus.v
                              Bus_min
Corner
         Max
                    bus.v
                              Bus_max
 Parameters List of parameters
Parameters r1 11
Parameters r2 12 temp
 Ports are in the same order as defined in Verilog-AMS
Ports vcc gnd iol io2
Ports int_ioa vccal vcca2 vssal vssa2
Ports int_iob vccbl vccb2 vssb1 vssb2
[End External Circuit]
```

The scope of the following keywords is limited to the [Component] keyword. They apply to the specific set of pin numbers and internal nodes only within that [Component].

## **Keywords:** [Node Declarations], [End Node Declarations]

*Required:* Yes, if any internal nodes exist on the die as listed in [Circuit Call], and/or if any die pads need to be explicitly defined.

Description: Provides a list of internal die nodes and/or die pads for a [Component] to make unambiguous interconnection descriptions possible.

*Usage Rules*: All die node and die pad names that appear under any [Circuit Call] keyword within the same [Component] must be listed under the [Node Declarations] keyword.

If used, the [Node Declarations] keyword must appear before any [Circuit Call] keyword(s) under the [Component] keyword. Only one [Node Declarations] keyword is permitted for each [Component] keyword. Since the [Node Declarations] keyword is part of the [Component] keyword, all internal node or pad references apply only to that [Component] (i.e., they are local).

The internal die node and/or die pad names within [Node Declarations] must be unique and therefore different from the pin names used in the [Pin] keyword. Each node and/or pad name must be separated by at least one white space. The list may span several lines and is terminated by the [End Node Declarations] keyword.

The names of die nodes and die pads can be composed of any combination of the legal characters outlined in Section 3.

## Example:

```
|
| Die pads:
pad_2a pad_2b pad_4 pad_11 | List of die pads
|
[End Node Declarations]
```

Keywords: [Circuit Call], [End Circuit Call]

Required: Yes, if any [External Circuit]s are present in a [Component].

Description: This keyword is used to instantiate [External Circuit]s and to connect their ports to the die nodes or die pads.

Sub-Params: Signal\_pin, Diff\_signal\_pins, Series\_pins, Port\_map

*Usage Rules:* The [Circuit Call] keyword must be followed by the name of an [External Circuit] that exists in the same [Component].

When a [Circuit Call] keyword defines any connections that involve one or more die pads (and consequently pins), the corresponding pins on the [Pin] list must use the reserved word 'CIRCUITCALL' in the third column instead of a model name.

Each [External Circuit] must have at least one corresponding [Circuit Call] keyword. Multiple [Circuit Call] keywords may appear under a [Component] using the same [External Circuit] name, if multiple instantiations of an [External Circuit] are needed.

## Signal pin, Diff signal pins, or Series pins:

The purpose of these subparameters is to identify which [External Circuit] needs to be stimulated in order to obtain a signal on a certain pin. These subparameters must be used only when the [External Circuit] that is referenced by the [Circuit Call] keyword makes use of the stimulus signal of the simulator. Any given [Circuit Call] keyword must contain no more than one instance of only one of these three subparameters. The subparameter is followed by one or two pin names which must be defined by the [Pin] keyword.

Signal\_pin is used when the referenced [External Circuit] has a single analog signal port (I/O) connection to one pin. The subparameter is followed by a pin name that must match one of the pin names under the [Pin] keyword.

Diff\_signal\_pins is used when the referenced [External Circuit] describes a true differential model which has two analog signal port (I/O) connections, each to a separate pin. The subparameter is followed by two pin names, each of which must match one of the pin names under the [Pin] keyword. The first and second pin names correspond to the non-inverting and inverting signals of the differential model, respectively. The two pin names must not be identical.

Series\_pins is used when the referenced [External Circuit] describes a Series or Series\_switch model which has two analog signal port (I/O) connections to two pins. The subparameter is followed by two pin names, each of which must match one of the pin names under the [Pin] keyword. The first and second pin names correspond to the positive and negative ports of the Series or Series\_switch model, respectively. However, the polarity order matters only when the model is polarity sensitive (as with the [Series Current] keyword). The two pin names must not be identical.

## Port\_map:

The Port\_map subparameter is used to connect the ports of an [External Circuit] to die nodes or die pads.

Every occurrence of the Port\_map subparameter must begin on a new line and must be followed by two arguments, the first being a port name, and the second being a die node, die pad, or a pin name. The first argument of Port\_map must contain a port name that matches one of the port names in the corresponding [External Circuit] definition. No port name may be listed more than once within a [Circuit Call] statement. Only those port names need to be listed with the Port\_map subparameter which are connected to a die node or a die pad. This includes reserved and/or user-defined port

The second argument of the Port\_map subparameter contains the name of a die node, die pad, or a pin. The names of die nodes, die pads, and pins may appear multiple times as Port\_map subparameter arguments within the same [Circuit Call] statement to signify a common connection between multiple ports, such as common voltage supply.

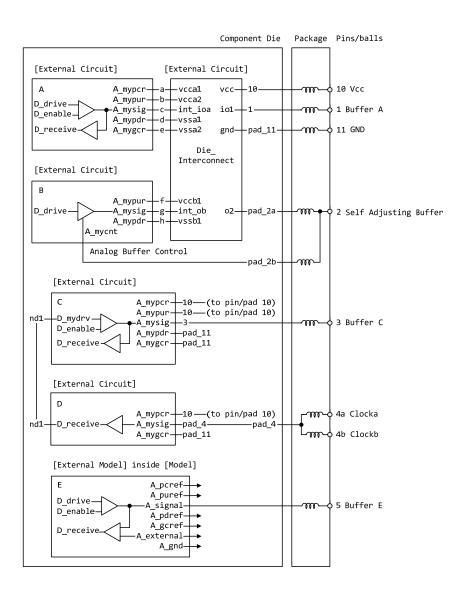
Please note that a pin name in the second argument does not mean that the connection is made directly to the pin. Since native IBIS does not have a mechanism to declare die pads explicitly, connections to die pads are made through their corresponding pin names (listed under the [Pin] keyword). This convention must only be used with native IBIS package models where a one-to-one path between the die pads and pins is assumed. When a package model other than native IBIS is used with a [Component], the second argument of Port\_map must have a die pad or die node name. These names are matched to the corresponding port name of the non-native package model by name (not by position). In this case, the package model may have an arbitrary circuit topology between the die pads and the pins. A one-to-one mapping is not required.

### Examples:

## NOTE REGARDING THIS EXAMPLE:

The pad\_\* to pin connections in Figure 29 and in the example lines with the comment, "explicit pad connection", are shown for reference. The connection syntax has not yet been defined. Therefore, the connections for pad\_\* to pin are not supported in this specification.

For the examples below please refer to Figure 29 and the example provided for the [Node Declarations] keyword.



#### Notes

- 1) The ports of the [External Model] E are automatically connected by the tool, taking the [Pin Mapping] keyword into consideration, if exists.
- 2) The package model shown in this drawing assumes the capabilities of a non-native IBIS package model are available to the model author.

Figure 29 - Reference Example for [Node Declarations] Keyword

```
[Circuit Call] A
                                  Instantiates [External Circuit] named "A"
Signal_pin 1
 mapping port
                        pad/node
Port_map
          A_mypcr
                                    Port to internal node connection
                                    Port to internal node connection
Port_map
          A_mypur
                         b
Port_map
           A_{mysig}
                         С
                                    Port to internal node connection
Port_map
           A_mypdr
                         d
                                    Port to internal node connection
                                    Port to internal node connection
Port_map
          A_mygcr
                         е
[End Circuit Call]
[Circuit Call] B
                                  | Instantiates [External Circuit] named "B"
.
Signal_pin 2
                         pad/node
 mapping port
                         f
                                    Port to internal node connection
Port_map
           A_mypur
                                    Port to internal node connection
Port map
           A_mysig
Port_map
           A_mypdr
                         h
                                    Port to internal node connection
Port_map
                         pad_2b
                                   Port to explicit pad connection
          A_mycnt
[End Circuit Call]
[Circuit Call] C
                                  | Instantiates [External Circuit] named "C"
Signal_pin 3
 mapping port
                         pad/node
                         10
                                    Port to implicit pad connection
Port_map
           A_mypcr
Port_map
           A_mypur
                         10
                                    Port to implicit pad connection
Port_map
           A_mysig
                         3
                                    Port to implicit pad connection
                                    Port to explicit pad connection
Port_map
           A_mypdr
                         pad_11
                         pad_11
Port_map
           A_mygcr
                                    Port to explicit pad connection
                         nd1
                                   Port to internal node connection
Port_map
          D_mydrv
End Circuit Call
[Circuit Call] D
                                  | Instantiates [External Circuit] named "D"
.
Signal_pin 4a
 mapping port
                         pad/node
          A_my_pcref
                         10
                                    Port to implicit pad connection
Port_map
                         pad_4
                                    Port to explicit pad connection
Port_map
           A_my_signal
                         pad_11
Port_map
           A_my_gcref
                                    Port to explicit pad connection
                         nd1
Port_map
           D_receive
                                   Port to internal node connection
```

```
[End Circuit Call]
[Circuit Call] Die_Interconnect
                                 | Instantiates [External Circuit] named
                                    "Die_Interconnect"
 mapping port
                        pad/node
Port_map
          VCC
                        10
                                   Port to implicit pad connection
                                   Port to explicit pad connection
                        pad_11
          gnd
Port_map
Port_map
          io1
                                   Port to implicit pad connection
Port_map
                        pad_2a
                                   Port to explicit pad connection
          02
                                   Port to internal node connection
Port_map
          vcca1
Port_map
          vcca2
                        b
                                   Port to internal node connection
                                   Port to internal node connection
          int_ioa
Port_map
                        C
Port_map
          vssa1
                                   Port to internal node connection
          vssa2
                                   Port to internal node connection
Port_map
                        е
          vccb1
                        f
                                   Port to internal node connection
Port_map
Port_map
          int_ob
                        g
                                   Port to internal node connection
Port_map
         vssb1
                                  Port to internal node connection
[End Circuit Call]
```

# 6C ALGORITHMIC MODELING INTERFACE (AMI) Introduction:

Executable shared library files to model advanced Serializer-Deserializer (SERDES) devices are supported by IBIS. This chapter describes how executable models written for these devices can be referenced and used by IBIS files.

The shared objects use the following keywords within the IBIS framework:

```
[Algorithmic Model]
[End Algorithmic Model]
```

The placement of these keywords within the hierarchy of IBIS is shown in the following diagram:

```
| |-- [Component]
| | | ...
| | ...
| | ...
| |-- [Model]
| | |...
| | |-- [Algorithmic Model]
| | | |-- [End Algorithmic Model]
| | | | ...
| | | | ...
```

Figure 30- Partial keyword hierarchy

## **General Assumptions:**

This approach breaks SERDES device modeling into two parts – electrical and algorithmic. The combination of the transmitter's analog back-end, the serial channel and the receiver's analog front-end are assumed to be linear and time invariant. There is no limitation that the equalization has to be linear and time invariant. The "analog" portion of the channel is characterized by means of an impulse response leveraging the pre-existing IBIS standard for device models.

The transmitter equalization, receiver equalization and clock recovery circuits are assumed to have a high-impedance (electrically isolated) connection to the analog portion of the channel. This makes it possible to model these circuits based on a characterization of the analog channel. The behavior of these circuits is modeled algorithmically through the use of executable code provided by the SERDES vendor. This proposal defines the functions of the executable models, the methods for passing data to and from these executable models and how the executable models are called from the EDA platform.

## **KEYWORD DEFINITIONS:**

**Keywords:** [Algorithmic Model], [End Algorithmic Model]

Required: No

Description: Used to reference an external compiled model. This compiled model encapsulates signal processing functions. In the case of a receiver it may additionally include clock and data recovery functions. The compiled model can receive and modify waveforms with the analog channel, where the analog channel consists of the transmitter output stage, the transmission channel itself and the receiver input stage. This data exchange is implemented through a set of software functions. The signature of these functions is elaborated in Section 1010 of this document. The function interface must comply with the ANSI "C" language.

Sub-Params: Executable

*Usage Rules:* The [Algorithmic Model] keyword must be positioned within a [Model] section and it may appear only once for each [Model] keyword in a .ibs file. It is not permitted under the [Submodel] keyword.

The [Algorithmic Model] always processes a single waveform regardless whether the model is single ended or differential. When the model is differential the waveform passed to the [Algorithmic Model] must be a difference waveform.

[Algorithmic Model], [End Algorithmic Model] Begins and ends an Algorithmic Model section, respectively.

### Executable:

Three entries follow the Executable subparameter on each line:

Platform\_Compiler\_Bits File\_Name Parameter\_File

The Platform\_Compiler\_Bits entry provides the name of the operating system, compiler and its version and the number of bits the shared object library is compiled for. It is a string without white spaces, consisting of three fields separated by an underscore '\_'. The first field consists of the name of the operating system followed optionally by its version. The second field consists of the name of the compiler followed by optionally by its version. The third field is an integer indicating the platform architecture. If the version for either the operating system or the compiler contains an underscore, it must be converted to a hyphen '-'. This is so that an underscore is only present as a separation character in the entry.

The architecture entry can be either '32' or '64'. Examples of Platform\_Compiler\_Bits:

Linux\_gcc3.2.3\_32 Solaris5.10\_gcc4.1.1\_64 Solaris\_cc5.7\_32 Windows\_VisualStudio7.1.3088\_32 Formatted: Font: (Default) Times New Roman, 12 pt

```
HP-UX_accA.03.52_32
```

The EDA tool will check for the compiler information and verify if the shared object library is compatible with the operating system and platform.

Multiple occurrences, without duplication, of Executable are permitted to allow for providing shared object libraries for as many combinations of operating system platforms and compilers for the same algorithmic model.

The File\_Name provides the name of the shared library file. The shared object library should be in the same directory as the IBIS (.ibs) file.

The Parameter\_File entry provides the name of the parameter file with an extension of .ami. This must be an external file and should reside in the same directory as the .ibs file and the shared object library file. It will consist of reserved and model specific (user defined) parameters for use by the EDA tool and for passing parameter values to the model.

The model parameter file must be organized in the parameter tree format as discussed in "NOTES ON ALGORITHMIC MODELING INTERFACE AND PROGRAMMING GUIDE", Section 1019 of this document.

Example of RX model in [Algorithmic Model]

```
[Algorithmic Model]

Executable Windows_VisualStudio_32 example_rx.dll example_rx_params.ami

[End Algorithmic Model]

Example of TX model in [Algorithmic Model]:

[Algorithmic Model]

Executable Windows_VisualStudio_32 tx_getwave.dll tx_getwave_params.ami

Executable Solaris_cc_32 libtx_getwave.so tx_getwave_params.ami

[End Algorithmic Model]
```

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### 6D TEST LOAD AND DATA DESCRIPTION

### Introduction:

The [Test Load] and [Test Data] keywords are top-level keywords to provide reference waveforms against which IBIS model simulation results can be compared to determine the accuracy of the IBIS data and simulator implementation.

## **KEYWORD DEFINITIONS:**

Keyword: [Test Data]

Required: No

Description: Indicates the beginning of a set of Golden Waveforms and references the conditions under which they were derived. An IBIS file may contain any number of [Test Data] sections representing different driver and load combinations. Golden Waveforms are a set of waveforms simulated using known ideal test loads. They are useful in verifying the accuracy of behavioral simulation results against the transistor level circuit model from which the IBIS model parameters originated.

Sub-Params: Test\_data\_type, Driver\_model, Driver\_model\_inv, Test\_load

*Usage Rules:* The name following the [Test Data] keyword is required. It allows a tool to select which data to analyze.

The Test\_data\_type subparameter is required, and its value must be either 'Single\_ended' or 'Differential.' The value of Test\_data\_type must match the value of Test\_load\_type found in the load called by Test\_load.

The Driver\_model subparameter is required. Its value specifies the "device-under-test" and must be a valid [Model] name. Driver\_model\_inv is only legal if Test\_data\_type is Differential. Driver\_model\_inv is not required but may be used in the case in which a differential driver uses two different models for the inverting and non-inverting pins.

The Test\_load subparameter is required and indicates which [Test Load] was used to derive the Golden Waveforms. It must reference a valid [Test Load] name.

### Example:

[Test Data] Data1 Test\_data\_type Single\_ended Driver\_model Buffer1 Test\_load Load1

Keywords: [Rising Waveform Near], [Falling Waveform Near], [Rising Waveform Far], [Falling Waveform Far], [Diff Rising Waveform Near], [Diff Rising Waveform Far], [Diff Falling Waveform Far]

Required: At least one Rising/Falling waveform is required under the scope of the [Test Data] keyword.

Description: Describes the shape of the rising and falling Golden Waveforms of a given driver and a given [Test Load] measured at the driver I/O pad (near) or receiver I/O pad (far). A model developer may use the [Rising Waveform Near/Far] and [Falling Waveform Near/Far] keywords to document Golden Waveforms whose purpose is to facilitate the correlation of reference waveforms and behavioral simulations.

Usage Rules: The process, temperature, and voltage conditions under which the Golden Waveforms are generated must be identical to those used to generate the I-V and V-T tables. The Golden Waveforms must be generated using unpackaged driver and receiver models. The simulator must NOT use the Golden Waveform tables in the construction of its internal stimulus function.

The tables must conform to the format described under the [Rising Waveform] and [Falling Waveform] keywords.

Both differential and single-ended waveforms are allowed regardless of the value of Test\_data\_type. If Test\_data\_type is Single\_ended then differential waveforms will be ignored. If Test\_data\_type is Differential, a single-ended waveform refers to the model specified by Driver\_model and the non-inverting driver output.

## Example:

•			
[Rising Wavefo	orm Far]		
Time	V(typ)	V(min)	V(max)
0.0000s	25.2100mV	15.2200mV	43.5700mV
0.2000ns	2.3325mV	-8.5090mV	23.4150mV
0.4000ns	0.1484V	15.9375mV	0.3944V
0.6000ns	0.7799V	0.2673V	1.3400V
0.8000ns	1.2960V	0.6042V	1.9490V
1.0000ns	1.6603V	0.9256V	2.4233V
1.2000ns	1.9460V	1.2050V	2.8130V
1.4000ns	2.1285V	1.3725V	3.0095V
1.6000ns	2.3415V	1.5560V	3.1265V
1.8000ns	2.5135V	1.7015V	3.1600V
2.0000ns	2.6460V	1.8085V	3.1695V
10.0000ns	2.7780V	2.3600V	3.1670V
[Falling Wavef	form Far]		
Time	V(typ)	V(min)	V(max)
0.0000s	5.0000V	4.5000V	5.5000V
0.2000ns	4.7470V	4.4695V	4.8815V
0.4000ns	3.9030V	4.0955V	3.5355V
0.6000ns	2.7313V	3.4533V	1.7770V
0.8000ns	1.8150V	2.8570V	0.8629V
1.0000ns	1.1697V	2.3270V	0.5364V
1.2000ns	0.7539V	1.8470V	0.4524V
1.4000ns	0.5905V	1.5430V	0.4368V
1.6000ns	0.4923V	1.2290V	0.4266V
1.8000ns	0.4639V	0.9906V	0.4207V
2.0000ns	0.4489V	0.8349V	0.4169V
10.0000ns	0.3950V	0.4935V	0.3841V

Keyword: [Test Load]

Required: No

Description: Defines a generic test load network and its associated electrical parameters for reference by Golden Waveforms under the [Test Data] keyword. The Golden Waveform tables correspond to a given [Test Load] which is specified by the Test\_load subparameter under the [Test Data] keyword.

Sub-Params: Test\_load\_type, C1\_near, Rs\_near, Ls\_near, C2\_near, Rp1\_near, Rp2\_near, Td, Zo, Rp1\_far, Rp2\_far, C2\_far, Ls\_far, Rs\_far, C1\_far, V\_term1, V\_term2, Receiver\_model, Receiver\_model inv, R diff\_near, R diff\_far.

*Usage Rules:* The Test\_load\_type subparameter is required, and its value must be either 'Single\_ended' or 'Differential.'

The subparameters specify the electrical parameters associated with a fixed generic test load. Figure 31 describes the single\_ended test load.

All subparameters except Test\_load\_type are optional. If omitted, series elements are shorted and shunt elements are opened by default.

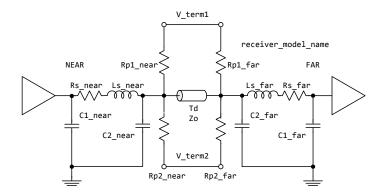


Figure 31 - [Test Load] Elements and Placement

If the Td subparameter is present, then the Zo subparameter must also be present. If the Td subparameter is not present, then the simulator must remove the transmission line from the network and short the two nodes to which it was connected.

 $V_{term1}$  defines the termination voltage for parallel termination resistors Rp1\_near and Rp1\_far. This voltage is not related to the [Voltage Range] keyword. If either Rp1\_near or Rp1\_far is used, then  $V_{term1}$  must also be used.

V\_term2 defines the termination voltage for parallel termination resistors Rp2\_near and Rp2\_far. If either Rp2\_near or Rp2\_far is used, then V\_term2 must also be used.

Receiver\_model is optional and indicates which, if any, receiver is connected to the far end node. If not used, the network defaults to no receiver.

Receiver\_model\_inv is not required but may be used in the case in which a differential receiver uses two different models for the inverting and non-inverting pins. Receiver\_model\_inv is ignored if Test\_load\_type is Single-ended.

If Test\_load\_type is Differential, then the test load is a pair of the above circuits. If the R\_diff\_near or R\_diff\_far subparameter is used, a resistor is connected between the near or far nodes of the two circuits. If Test\_load\_type is Single\_ended, R\_diff\_near and R\_diff\_far are ignored.

## Example:

```
[Test Load] Load1
Test_load_type Single_ended
C1_near
            = 1p
Rs_near
            = 10
Ls_near
            = 1n
            = 1p
C2_near
Rp1_near
            = 100
Rp2_near
            = 100
Td
            = 1ns
            = 50
Zo
Rp1_far
            = 100
Rp2_far
            = 100
C2_far
            = 1p
Ls_far
            = 1n
Rs_far
            = 10
            = 1p
C1_far
R_diff_far = 100
Receiver_model Input1
 variable
                typ
                                 min
                                                 max
V_term1
                 1.5
                                  1.4
                                                  1.6
V_term2
                 0.0
                                  0.0
                                                  0.0
  Example of a transmission line and receiver test load
[Test Load] Tline_rcv
Td
            = 1n
            = 50
Zo
Receiver_model Input1
```

## 7 PACKAGE MODELING

The [Package Model] keyword is optional. If more than the default RLC package model is desired, use the [Define Package Model] keyword.

Use the [Package Model] keyword within a [Component] to indicate the package model for that component. The specification permits .ibs files to contain the following additional list of package model keywords. Note that the actual package models can be in a separate cpackage\_file\_name>.pkg file or can exist in the IBIS files between the [Define Package Model] ...
[End Package Model] keywords for each package model that is defined. For reference, these keywords are listed in Error! Reference source not found. Full descriptions follow. EDA tools that do not support these keywords will ignore all entries between the [Define Package Model] and [End Package Model] keywords.

Table 15 Package Modeling Keywords

Keyword	Notes
[Define Package Model]	Required if the [Package Model] keyword is used
[Manufacturer]	(note 1)
[OEM]	(note 1)
[Description]	(note 1)
[Number Of Sections]	(note 2)
[Number Of Pins]	(note 1)
[Pin Numbers]	(note 1)
[Model Data]	(note 2)
[Resistance Matrix]	Optional when [Model Data] is used
[Inductance Matrix]	(note 3)
[Capacitance Matrix]	(note 3)
[Bandwidth]	Required (for Banded_matrix matrices only)
[Row]	(note 3)
[End Model Data]	(note 2)
[End Package Model]	(note 1)

- Note 1 Required when the [Define Package Model] keyword is used
- Note 2 Either the [Number Of Sections] or the [Model Data]/[End Model Data] keywords are required. Note that [Number of Sections] and the [Model Data]/[End Model Data] keywords are mutually exclusive.
- Note 3 Required when the [Define Package Model] keyword is used and the [Number Of Sections] keyword is not used.

When package model definitions occur within a .ibs file, their scope is "local"—they are known only within that .ibs file and no other. In addition, within that .ibs file, they override any globally defined package models that have the same name.

Usage Rules for the .Pkg File:

Package models are stored in a file whose name looks like:

<filename>.pkg.

The <filename> provided must adhere to the rules given in Section 3, "GENERAL SYNTAX RULES AND GUIDELINES". Use the '.pkg' extension to identify files containing package models. The .pkg file must contain all of the required elements of a normal .ibs file, including [IBIS Ver], [File Name], [File Rev], and the [End] keywords. Optional elements include the [Date], [Source], [Notes], [Disclaimer], [Copyright], and [Comment Char] keywords. All of the elements follow the same rules as those for a normal .ibs file.

Note that the [Component] and [Model] keywords are not allowed in the .pkg file. The .pkg file is for package models only.

**Keyword:** [Define Package Model]

Required: Yes

Description: Marks the beginning of a package model description.

*Usage Rules:* If the .pkg file contains data for more than one package, each section must begin with a new [Define Package Model] keyword. The length of the package model name must not exceed 40 characters in length. Blank characters are allowed. For every package model name defined under the [Package Model] keyword, there must be a matching [Define Package Model] keyword.

Example:

[Define Package Model] QS-SMT-cer-8-pin-pkgs

Keyword: [Manufacturer]

Required: Yes

Description: Declares the manufacturer of the component(s) that use this package model.

*Usage Rules:* The length of the manufacturer's name must not exceed 40 characters (blank characters are allowed, e.g., Texas Instruments). In addition, each manufacturer must use a consistent name in all .ibs and .pkg files.

Example:

[Manufacturer] Quality Semiconductors Ltd.

Keyword: [OEM]
Required: Yes

Description: Declares the manufacturer of the package.

*Usage Rules:* The length of the manufacturer's name must not exceed 40 characters (blank characters are allowed). In addition, each manufacturer must use a consistent name in all .ibs and .pkg files.

Other Notes: This keyword is useful if the semiconductor vendor sells a single IC in packages from different manufacturers.

Example:

[OEM] Acme Packaging Co.

Keyword: [Description]

Required: Yes

*Description:* Provides a concise yet easily human-readable description of what kind of package the [Package Model] is representing.

Usage Rules: The description must be less than 60 characters in length, must fit on a single line, and may contain spaces.

Example:

[Description] 220-Pin Quad Ceramic Flat Pack

Keyword: [Number Of Sections]

Required: No

Description: Defines the maximum number of sections that make up a 'package stub'. A package stub is defined as the connection between the die pad and the corresponding package pin; it can include (but is not limited to) the bondwire, the connection between the bondwire and pin, and the pin itself. This keyword must be used if a modeler wishes to describe any package stub as other than a single, lumped L/R/C. The sections of a package stub are assumed to connect to each other in a series fashion.

*Usage Rules:* The argument is a positive integer greater than zero. This keyword, if used, must appear in the specification before the [Pin Numbers] keyword. The maximum number of sections includes sections between the Fork and Endfork subparameters.

Example:

[Number Of Sections] 3

*Keyword:* [Number Of Pins]

Required: Yes

Description: Tells the parser how many pins to expect.

*Usage Rules:* The field must be a positive decimal integer. The [Number Of Pins] keyword must be positioned before the [Pin Numbers] keyword.

Example:

[Number Of Pins] 128

Keyword: [Pin Numbers]

Required: Yes

Description: Tells the parser the set of names that are used for the package pins and also defines pin ordering. If the [Number Of Sections] keyword is present it also lists the elements for each section of a pin's die to pin connection.

Sub-Params: Len, L, R, C, Fork, Endfork

*Usage Rules:* Following the [Pin Numbers] keyword, the names of the pins are listed. There must be as many names listed as there are pins (as given by the preceding [Number Of Pins] keyword). Pin names can not exceed 5 characters in length. The first pin name given is the "lowest" pin, and the last pin given is the "highest." If the [Number Of Sections] keyword is used then each pin name must be followed by one or more of the legal subparameter combinations listed below. If the [Number Of Sections] keyword is not present then subparameter usage is NOT allowed.

## Subparameters:

The Len, L, R, and C subparameters specify the length, inductance, capacitance and resistance of each section of each stub on a package.

The Fork and Endfork subparameters are used to denote branches from the main package stub.

Len The length of a package stub section. Lengths are given in terms of arbitrary 'units'.

L The inductance of a package stub section, in terms of henries/unit length. For example, if the total inductance of a section is 3.0nH and the length of the section is 2 'units,' the inductance would be listed as L = 1.5nH (i.e., 3.0 / 2).

C The capacitance of a package stub section, in terms of farads/unit length.

R The DC (ohmic) resistance of a package stub section, in terms of ohms/unit length.

Fork This subparameter indicates that the sections following (up to the Endfork subparameter) are part of a branch off of the main package stub. This subparameter has no arguments.

Endfork This subparameter indicates the end point of a branch. For every Fork subparameter there must be a corresponding Endfork subparameter. As with the Fork subparameter, the Endfork subparameter has no arguments.

Specifying a Len or L/R/C value of zero is allowed. If Len = 0 is specified, then the L/R/C values are the total for that section. If a non-zero length is specified, then the total L/R/C for a section is calculated by multiplying the value of the Len subparameter by the value of the L, R, or C subparameter. However, if a non-zero length section is specified, the L and C for that section should be treated as distributed elements.

Using The Subparameters to Describe Package Stub Sections:

A section description begins with the Len subparameter and ends with the slash (/) character. The value of the Len, L, R, and C subparameters and the subparameter itself are separated by an equals sign (=); white space around the equals sign is optional. The Fork and Endfork subparameters are placed between section descriptions (i.e., between the concluding slash of one section and the 'Len' parameter that starts another). A particular section description can contain no data (i.e., the description is given as 'Len = 0 /').

Legal Subparameter Combinations for Section Descriptions:

- A) A single Len = 0 subparameter, followed by a slash. This is used to describe a section with no data.
- B) Len, and one or more of the L, R, and C subparameters. If the Len subparameter is given as zero, then the L/R/C subparameters represent lumped elements. If the Len subparameter is non-zero, then the L/R/C subparameters represent distributed elements.
- C) Single Fork or Endfork subparameter. Normally, a package stub is described as several sections, with the Fork and Endfork subparameters surrounding a group of sections in the middle of the complete package stub description. However, it is legal for the Fork/Endfork subparameters to appear at the end of a section description. The package pin is connected to the last section of a package stub description not surrounded by a Fork/Endfork statements. See the examples below.

## Package Stub Boundaries:

A package stub description starts at the connection to the die and ends at the point at which the package pin interfaces with the board or substrate the IC package is mounted on. Note that in the case of a component with through-hole pins, the package stub description should include only the portion of the pin not physically inserted into the board or socket. However, it is legal for a package stub description to include both the component and socket together if this is how the component is intended to be used.

### Examples:

```
A three-section package stub description that includes a bond wire (lumped
 inductance), a trace (treated as a transmission line with DC resistance),
 and a pin modeled as a lumped {\it L/C} element.
[Pin Numbers]
Al Len=0 L=1.2n/ Len=1.2 L=2.0n C=0.5p R=0.05/ Len=0 L=2.0n C=1.0p/
 Pin A2 below has a section with no data
A2 Len=0 L=1.2n/ Len=0/ Len=1.2 L=2.0n C=0.5p R=0.05/ Len=0 L=2.0n C=1.0p/
 A section description using the Fork and Endfork subparameters. Note that
 the indentation of the Fork and Endfork subparameters are for readability
 are not required.
A1 Len=0 L=2.3n /
                          bondwire
Len=1.2 L=1.0n C=2.5p /
                           first section
                          indicates the starting of a branch
Fork
Len=1.0 L=2.0n C=1.5p /
                          section
Endfork
                          ending of the branch
Len=0.5 L=1.0 C=2.5p/
                          second section
Len=0.0 L=1.5n /
                         pin
 Here is an example where the Fork/Endfork subparameters are at the end of a
 package stub description.
B13 Len=0 L=2.3n /
                          bondwire
Len=1.2 L=1.0n C=2.5p /
                         first section
Len=0.5 L=1.0 C=2.5/
                          second section, pin connects here
                          indicates the starting of a branch
Len=1.0 L=2.0n C=1.5p / section
```

Endfork | ending of the branch

Keyword: [Model Data]

Required: Yes

*Description:* Indicates the beginning of the formatted package model data, that can include the [Resistance Matrix], [Inductance Matrix], [Capacitance Matrix], [Bandwidth], and [Row] keywords.

Example:
[Model Data]

Keyword: [End Model Data]

Required: Yes

Description: Indicates the end of the formatted model data.

Other Notes: In between the [Model Data] and [End Model Data] keywords is the package model data itself. The data is a set of three matrices: the resistance (R), inductance (L), and capacitance (C) matrices. Each matrix can be formatted differently (see below). Use one of the matrix keywords below to mark the beginning of each new matrix.

Example:

[End Model Data]

Keywords: [Resistance Matrix], [Inductance Matrix], [Capacitance Matrix]

Required: [Resistance Matrix] is optional. If it is not present, its entries are assumed to be zero. [Inductance Matrix] and [Capacitance Matrix] are required.

Sub-Params: Banded\_matrix, Sparse\_matrix, or Full\_matrix

Description: The subparameters mark the beginning of a matrix, and specify how the matrix data is formatted. See Figure 32.

*Usage Rules:* For each matrix keyword, use only one of the subparameters. After each of these subparameters, insert the matrix data in the appropriate format (these formats are described in detail below).

*Other Notes:* The resistance, inductance, and capacitance matrices are also referred to as "RLC matrices" within this specification.

When measuring the entries of the RLC matrices, either with laboratory equipment or field-solver software, currents are defined as ENTERING the pins of the package from the board (General Syntax Rule #11). The corresponding voltage drops are to be measured with the current pointing "in" to the "+" sign and "out" of the "-" sign.

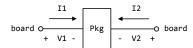


Figure 32 - Package Matrix Voltage Polarities and Current Directions

It is important to observe this convention in order to get the correct signs for the mutual inductances and resistances.

## Example:

[Resistance Matrix] Banded\_matrix
[Inductance Matrix] Sparse\_matrix
[Capacitance Matrix] Full\_matrix

#### RLC Matrix Notes:

For each [Resistance Matrix], [Inductance Matrix], or [Capacitance Matrix], a different format can be used for the data. The choice of formats is provided to satisfy different simulation accuracy and speed requirements.

Also, there are many packages in which the resistance matrix can have no coupling terms at all. In this case, the most concise format (Banded\_matrix) can be used.

There are two different ways to extract the coefficients that are reported in the capacitance and inductance matrices. For the purposes of this specification, the coefficients reported in the capacitance matrices shall be the 'electrostatic induction coefficients' or 'Maxwell's capacitances.' The Maxwell capacitance Kij is defined as the charge induced on conductor "j" when conductor "i" is held at 1 volt and all other conductors are held at zero volts. Note that Kij ( when i  $\neq$  j) will be a negative number and should be entered as such. Likewise, for the inductance matrix the coefficients for Lij are defined as the voltage induced on conductor "j" when conductor "i"'s current is changed by 1 amp/sec and all other conductors have no current change.

One common aspect of all the different formats is that they exploit the symmetry of the matrices they describe. This means that the entries below the main diagonal of the matrix are identical to the corresponding entries above the main diagonal. Therefore, only roughly one-half of the matrix needs to be described. By convention, the main diagonal and the UPPER half of the matrix are provided.

In the following text, we use the notation [I, J] to refer to the entry in row I and column J of the matrix. Note that I and J are allowed to be alphanumeric strings as well as integers. An ordering of these strings is defined in the [Pin Numbers] section. In the following text, "Row 1" means the row corresponding to the first pin.

Also note that the numeric entries of the RLC matrices are standard IBIS floating point numbers. As such, it is permissible to use multiplier "suffix" notation. Thus, an entry of the C matrix could be given as 1.23e-12 or as 1.23p or 1.23pF.

Full matrix:

When the Full\_matrix format is used, the couplings between every pair of elements are specified explicitly. Assume that the matrix has N rows and N columns. The Full\_matrix is specified one row at a time, starting with Row 1 and continuing down to Row N.

Each new row is identified with the Row keyword.

Keyword: [Row]
Required: Yes

Description: Indicates the beginning of a new row of the matrix.

Usage Rules: The argument must be one of the pin names listed under the [Pin Numbers] keyword.

Example:

[Row]

Following a [Row] keyword is a block of numbers that represent the entries for that row. Suppose that the current row is number M. Then the first number listed is the diagonal entry, [M,M]. Following this number are the entries of the upper half of the matrix that belong to row M: [M, M+1], [M, M+2], ... up to [M,N].

For even a modest-sized package, this data will not all fit on one line. You can break the data up with new-line characters so that the 120 character line length limit is observed.

An example: suppose the package has 40 pins and that we are currently working on Row 19. There is 1 diagonal entry, plus 40 - 19 = 21 entries in the upper half of the matrix to be specified, for 22 entries total. The data might be formatted as follows:

```
[Row]
5.67e-9
         1.1e-9
                  0.8e-9
                           0.6e-9
                                    0.4e-9
                                             0.2e-9
                                                       0.1e-9
                                                                 0.09e-9
8e-10
          7e-10
                  6e-10
                           5e-10
                                    4e-10
                                             3e-10
                                                       2e-10
                                                                 1e-10
9e - 11
          8e-11
                  7e-11
                           6e-11
                                    5e-11
```

In the above example, the entry 5.67e-9 is on the diagonal of row 19.

Observe that Row 1 always has the most entries, and that each successive row has one fewer entry than the last; the last row always has just a single entry.

Banded\_matrix:

A Banded\_matrix is one whose entries are guaranteed to be zero if they are farther away from the main diagonal than a certain distance, known as the "bandwidth." Let the matrix size be N x M, and let the bandwidth be B. An entry [I,J] of the matrix is zero if:

$$|I - J| > B$$

where |.| denotes the absolute value.

The Banded\_matrix is used to specify the coupling effects up to B pins on either side. Two variations are supported. One allows for the coupling to circle back on itself. This is technically a simple form of a bordered block diagonal matrix. However, its data can be completely specified in terms of a Banded\_matrix for an N x M matrix consisting of N rows and M = N + B columns. The

second variation is just in terms of an N x N matrix where no circle back coupling needs to be specified.

The bandwidth for a Banded matrix must be specified using the [Bandwidth] keyword:

Keyword: [Bandwidth]

Required: Yes (for Banded\_matrix matrices only)

Description: Indicates the bandwidth of the matrix.

*Usage Rules:* The bandwidth field must be a non-negative integer. This keyword must occur after the [Resistance Matrix], etc., keywords, and before the matrix data is given.

Example:

[Bandwidth] 10

Specify the banded matrix one row at a time, starting with row 1 and working up to higher rows. Mark each row with the [Row] keyword, as above. As before, symmetry is exploited: do not provide entries below the main diagonal.

For the case where coupling can circle back on itself, consider a matrix of N pins organized into N rows, 1 ... N, and M columns, 1 ... N, 1 ... B. The first row only needs to specify the entries [1,1] through [1,1+B] since all other entries are guaranteed to be zero. The second row will need to specify the entries [2,2] through [2,2+B], and so on. For row K, the entries [K,K] through [K,K+B] are given when K + B is less than or equal to the size of the matrix N. When K + B exceeds N, the entries in the last columns, 1 ... B, specify the coupling to the first rows. For row K, the entries [K,K] ... [K,N] [K,1] ... [K,R] are given where R = mod(K + B - 1, N) + 1. All rows will contain B + 1 entries. To avoid redundant entries, the bandwidth is limited to  $B \le int((N - 1)/2)$ .

For the case where coupling does not circle back on itself, the process is modified. Only N columns need to be considered. When K+B finally exceeds the size of the matrix N, the number of entries in each row starts to decrease; the last row (row N) has only 1 entry. This construction constrains the bandwidth to B < N.

As in the Full\_matrix, if all the entries for a particular row do not fit into a single 120-character line, the entries can be broken across several lines.

It is possible to use a bandwidth of 0 to specify a diagonal matrix (a matrix with no coupling terms.) This is sometimes useful for resistance matrices.

Sparse matrix:

A Sparse\_matrix is expected to consist mostly of zero-valued entries, except for a few nonzeros. Unlike the Banded\_matrix, there is no restriction on where the nonzero entries can occur. This feature is useful in certain situations, such as for Pin Grid Arrays (PGAs).

As usual, symmetry can be exploited to reduce the amount of data by eliminating from the matrix any entries below the main diagonal.

An N x N Sparse\_matrix is specified one row at a time, starting with row 1 and continuing down to row N. Each new row is marked with the [Row] keyword, as in the other matrix formats.

Data for the entries of a row is given in a slightly different format, however. For the entry [I, J] of a row, it is necessary to explicitly list the name of pin J before the value of the entry is given. This specification serves to indicate to the parser where the entry is put into the matrix.

The proper location is not otherwise obvious because of the lack of restrictions on where nonzeros can occur. Each (Index, Value) pair is listed upon a separate line. An example follows. Suppose that row 10 has nonzero entries [10,10], [10,11], [10,15], and [10,25]. The following row data would be provided:

10	
	Value
	5.7e-9
	1.1e-9
	1.1e-9
	1.1e-9
	10

Note that each of the column indices listed for any row must be greater than or equal to the row index, because they always come from the upper half of the matrix. When alphanumeric pin names are used, special care must be taken to ensure that the ordering defined in the [Pin Numbers] section is observed.

With this convention, please note that the Nth row of an N x N matrix has just a single entry (the diagonal entry).

Keyword: [End Package Model]

Required: Yes

Description: Marks the end of a package model description.

Usage Rules: This keyword must come at the end of each complete package model description.

Optionally, add a comment after the [End Package Model] keyword to clarify which package model has just ended. For example,

```
[Define Package Model] My_Model

| ... content of model ...

|

[End Package Model] | end of My_Model

Example:
```

## Package Model Example

[End Package Model]

The following is an example of a package model file following the package modeling specifications. For the sake of brevity, an 8-pin package has been described. For purposes of illustration, each of the matrices is specified using a different format.

```
Example:
[IBIS Ver]
               5.0
              example.pkg
[File Name]
[File Rev]
               0.1
[Date]
               August 29, 2008
               Quality Semiconductors. Data derived from Helmholtz Inc.'s
[Source]
               field solver using 3-D Autocad model from Acme Packaging.
[Notes]
               Example of couplings in packaging
[Disclaimer]
              The models given below may not represent any physically
              realizable 8-pin package. They are provided solely for the
               purpose of illustrating the .pkg file format.
 ______
[Define Package Model] QS-SMT-cer-8-pin-pkgs
[Manufacturer]
                      Quality Semiconductors Ltd.
[OEM]
                      Acme Package Co.
[Description]
                      8-Pin ceramic SMT package
[Number Of Pins]
[Pin Numbers]
3
4
6
[Model Data]
 The resistance matrix for this package has no coupling
[Resistance Matrix]
                      Banded_matrix
[Bandwidth]
[Row]
10.0
       2
[Row]
15.0
[Row]
      3
15.0
[Row] 4
10.0
[Row]
10.0
[Row] 6
15.0
       7
[Row]
15.0
[Row]
10.0
 The inductance matrix has loads of coupling
[Inductance Matrix]
                     Full_matrix
```

```
[Row] 1
3.04859e-07
                4.73185e-08
                                 1.3428e-08
                                                 6.12191e-09
                                 2.73201e-08
                                                1.33807e-08
1.74022e-07
                7.35469e-08
[Row] 2
3.04859e-07
                4.73185e-08
                                 1.3428e-08
                                                 7.35469e-08
                7.35469e-08
                                 2.73201e-08
1.74022e-07
[Row] 3
3.04859e-07
                                 2.73201e-08
                4.73185e-08
                                                7.35469e-08
                7.35469e-08
1.74022e-07
[Row] 4
3.04859e-07
                1.33807e-08
                                 2.73201e-08
                                                 7.35469e-08
1.74022e-07
[Row] 5
4.70049e-07
                                                 2.95088e-08
                1.43791e-07
                                 5.75805e-08
[Row] 6
4.70049e-07
                1.43791e-07
                                 5.75805e-08
[Row]
4.70049e-07
                1.43791e-07
[Row] 8
4.70049e-07
 The capacitance matrix has sparse coupling
[Capacitance Matrix]
                       Sparse_matrix
[Row]
       2.48227e-10
1
2
       -1.56651e-11
5
       -9.54158e-11
6
       -7.15684e-12
[Row]
       2.51798e-10
2
3
       -1.56552e-11
5
       -6.85199e-12
6
        -9.0486e-11
7
       -6.82003e-12
[Row] 3
3
       2.51798e-10
4
       -1.56651e-11
       -6.82003e-12
6
        -9.0486e-11
8
       -6.85199e-12
[Row]
       2.48227e-10
7
       -7.15684e-12
8
       -9.54158e-11
[Row]
       1.73542e-10
5
6
       -3.38247e-11
[Row]
       1.86833e-10
7
       -3.27226e-11
[Row]
       1.86833e-10
7
8
       -3.38247e-11
[Row]
8
       1.73542e-10
```

```
[End Model Data]
[End Package Model]
```

## 8 ELECTRICAL BOARD DESCRIPTION

A "board level component" is the generic term to be used to describe a printed circuit board (PCB) or substrate which can contain components or even other boards, and which can connect to another board through a set of user visible pins. The electrical connectivity of such a board level component is referred to as an "Electrical Board Description". For example, a SIMM module is a board level component that is used to attach several DRAM components on the PCB to another board through edge connector pins. An electrical board description file (a .ebd file) is defined to describe the connections of a board level component between the board pins and its components on the board.

A fundamental assumption regarding the electrical board description is that the inductance and capacitance parameters listed in the file are derived with respect to well-defined reference plane(s) within the board. Also, this current description does not allow one to describe electrical (inductive or capacitive) coupling between paths. It is recommended that if coupling is an issue, then an electrical description be extracted from the physical parameters of the board.

What is, and is not, included in an Electrical Board Description is defined by its boundaries. For the definition of the boundaries, see the Description section under the [Path Description] Keyword.

### Usage Rules:

A .ebd file is intended to be a stand-alone file, not referenced by or or included in any .ibs or .pkg file. Electrical Board Descriptions are stored in a file whose name looks like <filename>.ebd, where <filename> must conform to the naming rules given in Section 3 of this specification. The .ebd extension is mandatory.

#### Contents:

A .ebd file is structured similar to a standard IBIS file. It must contain the following keywords, as defined in the IBIS specification: [IBIS Ver], [File Name], [File Rev], and [End]. It may also contain the following optional keywords: [Comment Char], [Date], [Source], [Notes], [Disclaimer], and [Copyright]. The actual board description is contained between the keywords [Begin Board Description] and [End Board Description], and includes the keywords listed below:

[Begin Board Description]

[Manufacturer]

[Number Of Pins]

[Pin List]

[Path Description]

[Reference Designator Map]

[End Board Description]

More than one [Begin Board Description]/[End Board Description] keyword pair is allowed in a .ebd file.

**Keyword:** [Begin Board Description]

Required: Yes

Description: Marks the beginning of an Electrical Board Description.

*Usage Rules:* The keyword is followed by the name of the board levelcomponent. If the .ebd file contains more than one [Begin Board Description] keyword, then each name must be unique. The length of the component name must not exceed 40 characters in length, and blank characters are allowed. For every [Begin Board Description] keyword there must be a matching [End Board Description] keyword.

Example:

[Begin Board Description] 16Meg X 8 SIMM Module

*Keyword:* [Manufacturer]

Required: Yes

Description: Declares the manufacturer of the components(s) that use this .ebd file.

*Usage Rules:* Following the keyword is the manufacturer's name. It must not exceed 40 characters, and can include blank characters. Each manufacturer must use a consistent name in all .ebd files.

Example:

[Manufacturer] Quality SIMM Corp.

Keyword: [Number Of Pins]

Required: Yes

Description: Tells the parser the number of pins to expect. Pins are any externally accessible electrical connection to the component.

*Usage Rules:* The field must be a positive decimal integer. Note: The simulator must not limit the Number Of Pins to any value less than 1,000. The [Number Of Pins] keyword must be positioned before the [Pin List] keyword.

Example:

[Number Of Pins] 128

Keyword: [Pin List]
Required: Yes

Description: Tells the parser the pin names of the user accessible pins. It also informs the parser which pins are connected to power and ground.

Sub-Params: signal\_name

Usage Rules: Following the [Pin List] keyword are two columns. The first column lists the pin name while the second lists the data book name of the signal connected to that pin. There must be as many pin\_name/signal\_name rows as there are pins given by the preceding [Number Of Pins] keyword. Pin names must be the alphanumeric external pin names of the part. The pin names cannot exceed eight characters in length. Any pin associated with a signal name that begins with 'GND' or 'POWER' will be interpreted as connecting to the boards ground or power plane. In

addition, NC is a legal signal name and indicates that the Pin is a 'no connect'. As per the IBIS standard 'GND,' 'POWER,' and 'NC' are case insensitive.

#### Example:

```
A SIMM Board Example:
[Pin List] signal_name
Α1
             GND
A2
             data1
Α3
             data2
Α4
             POWER 5
                       This pin connects to 5 V
Α5
                       a no connect pin
A22
             POWER3.3 | This pin connects to 3.3 V
В1
             casa
 .
letc.
```

Keyword: [Path Description]

Required: Yes

Description: This keyword allows the user to describe the connection between the user accessible pins of a board level component and other pins or pins of the ICs mounted on that board. Each pin to node connection is divided into one or more cascaded "sections," where each section is described in terms of its L/R/C per unit length. The Fork and Endfork subparameters allow the path to branch to multiple nodes, or another pin. A path description is required for each pin whose signal name is not 'GND,' 'POWER,' or 'NC.'

# Board Description and IC Boundaries:

In any system, each board level component interfaces with another board level component at some boundary. Every electrical board description must contain the components necessary to represent the behavior of the board level component being described within its boundaries. The boundary definition depends upon the board level component being described.

For CARD EDGE CONNECTIONS such as a SIMM or a PC Daughter Card plugged into a SIMM Socket or Edge Connector, the boundary should be at the end of the board card edge pads as they emerge from the connector.

For any THROUGH-HOLE MOUNTED COMPONENT, the boundary will be at the surface of the board on which the component is mounted.

SURFACE MOUNTED COMPONENT models end at the outboard end of their recommended surface mount pads.

If the board level component contains an UNMATED CONNECTOR, the unmated connector will be described in a separate file, with its boundaries being as described above for the through-hole or surface mounted component.

Sub-Params: Len, L, R, C, Fork, Endfork, Pin, Node

Usage Rules: Each individual connection path (user pin to node(s)) description begins with the [Path Description] keyword and a path name, followed by the subparameters used to describe the

path topology and the electrical characteristics of each section of the path. The path name must not exceed 40 characters, blanks are not allowed, and each occurrence of the [Path Description] keyword must be followed by a unique path name. Every signal pin (pins other than POWER, GND or NC) must appear in one and only one path description per [Begin Board Description]/[End Board Description] pair. Pin names do not have to appear in the same order as listed in the [Pin List] table. The individual subparameters are broken up into those that describe the electrical properties of a section, and those that describe the topology of a path.

## Section Description Subparameters:

The Len, L, R, and C subparameters specify the length, the series inductance, resistance, and the capacitance to ground of each section in a path description.

- Len The physical length of a section. Lengths are given in terms of arbitrary 'units'. Any non-zero length requires that the parameters that follow must be interpreted as distributed elements by the simulator.
- L The series inductance of a section, in terms of henries/unit length. For example, if the total inductance of a section is 3.0 nH and the length of the section is 2 'units', the inductance would be listed as L = 1.5nH (i.e. 3.0/2).
- C The capacitance to ground of a section, in terms of farads/unit length.
- R The series DC (ohmic) resistance of a section, in terms of ohms/unit length.

#### Topology Description Subparameters:

The Fork and Endfork subparameters denote branches from the main pin-to-node or pin-to-pin connection path. The Node subparameter is used to reference the pin of a component or board as defined in a .ibs or .ebd file. The Pin subparameter is used to indicate the point at which a path connects to a user visible pin.

- Fork This subparameter indicates that the sections following (up to the Endfork subparameter) are part of a branch off of the main connection path. This subparameter has no arguments.
- Endfork This subparameter indicates the end point of a branch. For every Fork subparameter there must be a corresponding Endfork subparameter. As with the Fork subparameter, the Endfork subparameter has no arguments. The Fork and Endfork parameters must appear on separate lines.
- Node reference\_designator.pin

This subparameter is used when the connection path connects to a pin of another, externally defined component. The arguments of the Node subparameter indicate the pin and reference designator of the external component. The pin and reference designator portions of the argument are separated by a period ('.'). The reference designator is mapped to an external component description (another .ebd file or .ibs file) by the [Reference Designator Map] Keyword. Note that a Node MUST reference a model of a passive or active component. A Node is not an arbitrary connection point between two elements or paths.

Pin This subparameter is used to mark the point at which a path description connects to a user accessible pin. Every path description must contain at least one occurrence of

the Pin subparameter. It may also contain the reserved word NC. The value of the Pin subparameter must be one of the pin names listed in the [Pin List] section.

Note: The reserved word NC can also be used in path descriptions in a similar manner as the subparameters in order to terminate paths. This usage is optional.

Using The Subparameters to Describe Paths:

A section description begins with the Len subparameter and ends with the slash (/) character. The value of the Len, L, R, and C subparameters and the subparameter itself are separated by an equals sign (=); white space around the equals sign is optional. The Fork, Endfork, Node, and Pin subparameters are placed between section descriptions (i.e., between the concluding slash of one section and the 'Len' parameters that starts another). The arguments of the Pin and Node subparameter are separated by white space.

Specifying a Len or L/R/C value of zero is allowed. If Len = 0 is specified, then the L/R/C values are the total for that section. If a non-zero length is specified, then the total L/R/C for a section is calculated by multiplying the value of the Len subparameter by the value of the L, R, or C subparameter. However, as noted below, if a non-zero length is specified, that section MUST be interpreted as distributed elements.

Legal Subparameter Combinations for Section Descriptions:

- A) Len, and one or more of the L, R and C subparameters. If the Len subparameter is given as zero, then the L/R/C subparameters represent lumped elements. If the Len subparameter is non-zero, then the L/R/C subparameters represent distributed elements and both L and C must be specified, R is optional. The segment Len ..../ must not be split; the whole segment must be on one line.
- B) The first subparameter following the [Path Description] keyword must be 'Pin', followed by one or more section descriptions. The path description can terminate in a Node, another pin or the reserved word, NC. However, NC may be optionally omitted.

Dealing With Series Elements:

A discrete series R or L component can be included in a path description by defining a section with Len=0 and the proper R or L value. A discrete series component can also be included in a path description by writingnote statements that reference the same component. This can be done as two back to back node statements for a series component within a single ][Path Description]. It is also allowed to insert a series component between two branches of a single [Path Description], or even between two separate [Path Description]s (see the examples below).

When a series component is modeled with node statemens and reference designator.pin arguments, the references pin models can be Series or Series\_switch. The following models are supported: [R Series], [L Series], [C Series], [RI Series], [Lc Series], [Rc Series], [Series Current], and [Series MOSFET].

Examples:

An Example Path For a SIMM Module (see Figure 33):

```
|

[Path Description] CAS_2

Pin J25

Len = 0.5 L=8.35n C=3.34p R=0.01 /

Node u21.15

Len = 0.5 L=8.35n C=3.34p R=0.01 /
```

Node u22.15 Len = 0.5 L=8.35n C=3.34p R=0.01 / Node u23.15

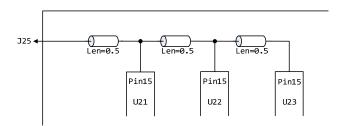


Figure 33 - SIMM Package Path Example

A Description Using The Fork and Endfork Subparameters (see Figure 34):

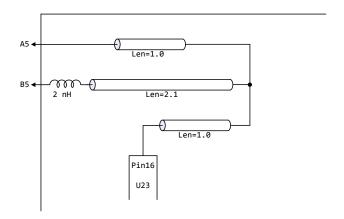


Figure 34 - Fork and Endfork in [Path Description]

A Description Including a Discrete Series Element (see Figure 35):

```
| [Path Description] sig1
Pin B27
Len = 0 L=1.6n /
Len = 1.5 L=6.0n C=2.0p /
Node R2.1
Node R2.2
Len = 0.25 L=6.0n C=2.0p /
Node U25.6
```

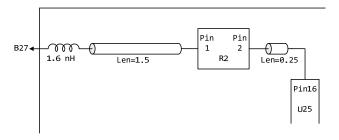


Figure 35 – Discrete Series Element in [Path Description]

A path including series passive components (C17, R21) between branches forming a differential termination (see Figure 36):

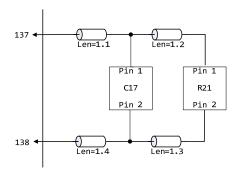


Figure 36 – Series Passive Components as Differential Termination

Two paths connected by series resistors (R8, R9) used as differential termination between components

```
[Path Description] DP+
Pin 20
Len=1 L=1n C=0.4p /
Fork
 Len=1.1 L=1n C=0.4p /
 Fork
    Node P8.D7
 Endfork
 Len=1.2 L=1n C=0.4p /
 Node R8.1
                              | Pin 1 of Series R8
Endfork
Len=1.3 L=1n C=0.4p
Fork
 Len=1.4 L=1n C=0.4p /
 Node P8.D5
Endfork
Len=1.5 L=1n C=0.4p
Node R9.1
                              | Pin 1 of Series R9
| ... Other Path(s)
[Path Description] DP-
```

```
Pin 22
Len=1 L=1n C=0.4p /
Fork
 Len=1.1 L=1n C=0.4p /
 Fork
  Node Q8.D7
 Endfork
 Len=1.2 L=1n C=0.4p /
                          | Pin 2 of Series R8
 Node R8.2
Endfork
Len=1.3 L=1n C=0.4p /
Fork
Len=1.4 L=1n C=0.4p /
 Node Q8.D5
Endfork
Len=1.5 L=1n C=0.4p /
                          | Pin 2 of Series R9
Node R9.2
                         Len=1.1
                                              Len1.2
               Len=1
           +--0____0----+
             Len=1.3
                           |Pin |
                                      |Pin |
            --0____0----
             Len=1.4
                           |P8.D5
                                      P8.D7
           +--0____0---+
             Len=1.5
                                                     |Pin 1|
                     |Pin 1|
                      R9
                                                     | R8
                      R9
                                                     R8
                      Pin 2
                                                     Pin 2
           +--0____0---+
              Len=1.5
                           |Pin |
                                      Pin
             0____0--
              Len=1.4
                           Q8.D5
                                      Q8.D7
                                      +--+--+
             -0____0---+
              Len=1.3
   22 <-----0____0---+----0__
Len=1 Len=
                         Len=1.1
                                              Len=1.2
```

Keyword: [Reference Designator Map]

Required: Yes, if any of the path descriptions use the Node subparameter

Description: Maps a reference designator to a component or electrical board description contained in an .ibs or .ebd file.

Usage Rules: The [Reference Designator Map] keyword must be followed by a list of all of the reference designators called out by the Node subparameters used in the various path descriptions. Each reference designator is followed by the name of the .ibs or .ebd file containing the electrical description of the component or board, then the name of the component itself as given by the .ibs or .ebd file's [Component] or [Begin Board Description] keyword respectively. The reference designator, file name and component name terms are separated by white space. By default the .ibs or .ebd files are assumed to exist in the same directory as the calling .ebd file. It is legal for a reference designator to point to a component that is contained in the calling .ebd file.

The reference designator is limited to ten characters.

#### Example:

```
[Reference Designator Map]
  External Part References:
 Ref Des File name
                      Component name
u23
          pp100.ibs
                      Pentium(R)__Pro_Processor
u24
          simm.ebd
                      16Meg X 36 SIMM Module
u25
          ls244.ibs
                      National 74LS244a
          r10K.ibs
u26
                      My_10K_Pullup
```

**Keyword:** [End Board Description]

Required: Yes

Description: Marks the end of an Electrical Interconnect Description.

*Usage Rules:* This keyword must come at the end of each complete electrical interconnect model description.

Optionally, a comment may be added after the [End Electrical Description] keyword to clarify which board model has ended.

Example:

```
[End Board Description] | End: 16Meg X 8 SIMM Module
```

Keyword: [End]
Required: Yes

Description: Defines the end of the .ibs, .pkg, or .ebd file.

Example:
[End]

## 9 NOTES ON DATA DERIVATION METHOD

This section explains how data values are derived. It describes certain assumed parameter and table extraction conditions if they are not explicitly specified. It also describes the allocation of data into the 'typ,' 'min,' and 'max' columns under variations of voltage, temperature, and process.

The required 'typ' column for all data represents typical operating conditions. For most [Model] keyword data, the 'min' column describes slow, weak performance, and the 'max' column describes the fast, strong performance. It is permissible to use slow, weak components or models to derive the data for the 'min' column, and to use fast, strong components or models to derive the data in the 'max' columns under the corresponding voltage and temperature derating conditions for these columns. It is also permissible to use typical components or models derated by voltage and temperature and optionally apply proprietary "X%" and "Y%" factors described later for further derating. This methodology has the nice feature that the data can be derived either from semiconductor vendor proprietary models, or typical component measurement over temperature/voltage.

The voltage and temperature keywords and optionally the process models control the conditions that define the 'typ,' 'min,' and 'max' column entries for all I-V table keywords [Pulldown], [Pullup], [GND Clamp], and [POWER Clamp]; all [Ramp] subparameters  $dV/dt_r$  and  $dV/dt_f$ ; and all waveform table keywords and subparameters [Rising Waveform], [Falling Waveform], V\_fixture, V\_fixture\_min, and V\_fixture\_max.

The voltage keywords that control the voltage conditions are [Voltage Range], [Pulldown Reference], [Pullup Reference], [GND Clamp Reference], and [POWER Clamp Reference]. The entries in the 'min' columns contain the smallest magnitude voltages, and the entries in the 'max' columns contain the largest magnitude voltages.

The optional [Temperature Range] keyword will contain the temperature which causes or amplifies the slow, weak conditions in the 'min' column and the temperature which causes or amplifies the fast, strong conditions in the 'max' column. Therefore, the 'min' column for [Temperature Range] will contain the lowest value for bipolar models (TTL and ECL) and the highest value for CMOS models. Default values described later are assumed if temperature is not specified.

The 'min' and 'max' columns for all remaining keywords and subparameters will contain the smallest and largest magnitude values. This applies to the [Model] subparameter C\_comp as well, even if the correlation to the voltage, temperature, and process variations are known, because information about such correlation is not available in all cases.

C\_comp is considered an independent variable. This is because C\_comp includes bonding pad capacitance, which does not necessarily track fabrication process variations. The conservative approach to using IBIS data will associate large C\_comp values with slow, weak models, and the small C comp values with fast, strong models.

The default temperatures under which all I-V tables are extracted are provided below. The same defaults also are stated for the [Ramp] subparameters, but they also apply for the waveform keywords.

The stated voltage ranges for I-V tables cover the most common, single supply cases. When multiple supplies are specified, the voltages shall extend similarly to values that handle practical extremes in reflected wave simulations.

For the [Ramp] subparameters, the default test load and voltages are provided. However, the test load can be entered directly by the R\_load subparameter. The allowable test loads and voltages for the waveform keywords are stated by required and optional subparameters; no defaults are needed. Even with waveform keywords, the [Ramp] keyword continues to be required so that the IBIS model remains functional in situations which do not support waveform processing.

The following discussion lists test details and default conditions.

## 1) I-V Tables:

I-V tables for CMOS models:

typ = typical voltage, typical temp deg C, typical process

min = minimum voltage, max temp deg C, typical process, minus "X%"

max = maximum voltage, min temp deg C, typical process, plus "X%"

I-V tables for bipolar models:

typ = typical voltage, typical temp deg C, typical process

min = minimum voltage, min temp deg C, typical process, minus "X%"

max = maximum voltage, max temp deg C, typical process, plus "X%"

Nominal, min, and max temperature are specified by the semiconductor vendor. The default range is 50 deg C nom, 0 deg C min, and 100 deg C max temperatures.

X% should be statistically determined by the semiconductor vendor based on numerous fab lots, test chips, process controls, etc. The value of X need not be published in the IBIS file, and may decrease over time as data on the I/O buffers and silicon process increases.

Temperatures are junction temperatures.

# 2) Voltage Ranges:

Points for each table must span the voltages listed in Table 16.

**Table 16 Voltage Ranges** 

5 5		
Table	Low Voltage	High Voltage
[Pulldown]	GND – POWER	POWER + POWER
[Pullup]	GND – POWER	POWER + POWER
[GND Clamp]	GND – POWER	GND + POWER
[POWER Clamp]	POWER	POWER + POWER
[Series Current]	GND – POWER	GND + POWER
[Series MOSFET]	GND	GND + POWER

As described in the [Pulldown Reference] keyword section, the I-V tables of the [Pullup] and the [POWER Clamp] structures are 'Vcc relative,' using the equation: Vtable = Vcc - Voutput.

For example, a model with a 5 V power supply voltage should be characterized between (0 - 5) = -5 V and (5 + 5) = 10 V; and a model with a 3.3 V power supply should be characterized between (0 - 3.3) = -3.3 V and (3.3 + 3.3) = 6.6 V for the [Pulldown] table.

When tabulating output data for ECL type models, the voltage points must span the range of Vcc to Vcc - 2.2 V. This range applies to both the [Pullup] and [Pulldown] tables. Note that this range applies ONLY when characterizing an ECL output.

These voltage ranges must be spanned by the IBIS data. Data derived from lab measurements may not be able to span these ranges as such and so may need to be extrapolated to cover the full range. This data must not be left for the simulator to provide.

## 3) Ramp Rates:

The following steps assume that the default load resistance of 50 ohms is used. There may be models that will not drive a load of only 50 ohms into any useful level of dynamics. In these cases, use the semiconductor vendor's suggested (nonreactive) load and add the load subparameter to the [Ramp] specification.

The ramp rate does not include packaging but does include the effects of the C\_comp parameter; it is the intrinsic output stage rise and fall time only.

The ramp rates (listed in AC characteristics below) should be derived as follows:

- a. If starting with the silicon model, remove all packaging. If starting with a packaged model, perform the measurements as outlined below. Then use whatever techniques are appropriate to derive the actual, unloaded rise and fall times.
- b. If: The Model\_type is one of the following: Output, I/O, or 3-state (not open or ECL types); Then: Attach a 50 ohm resistor to GND to derive the rising edge ramp. Attach a 50 ohm resistor to POWER to derive the falling edge ramp.
  - If: The Model\_type is Output\_ECL, I/O\_ECL, 3-state\_ECL;
    - Then: Attach a 50 ohm resistor to the termination voltage (Vterm = VCC 2 V). Use this load to derive both the rising and falling edges.
  - If: The Model\_type is either an Open\_sink type or Open\_drain type;
    - Then: Attach either a 50 ohm resistor or the semiconductor vendor suggested termination resistance to either POWER or the suggested termination voltage. Use this load to derive both the rising and falling edges.
  - If: The Model\_type is an Open\_source type;
    - Then: Attach either a 50 ohm resistor or the semiconductor vendor suggested termination resistance to either GND or the suggested termination voltage. Use this load to derive both the rising and falling edges.
- c. Due to the resistor, output swings will not make a full transition as expected. However the pertinent data can still be collected as follows:
  - 1. Determine the 20% to 80% voltages of the 50 ohm swing.
  - 2. Measure this voltage change as "dV".
  - 3. Measure the amount of time required to make this swing "dt".
- d. Post the value as a ratio "dV/dt". The simulator extrapolates this value to span the required voltage swing range in the final model.

 Typ, Min, and Max must all be posted, and are derived at the same extremes as the I-V tables, which are:

Ramp rates for CMOS models:

```
typ = typical voltage, typical temp deg C, typical process
min = minimum voltage, max temp deg C, typical process, minus "Y%"
max = maximum voltage, min temp deg C, typical process, plus "Y%"
```

Ramp rates for bipolar models:

```
typ = typical voltage, typical temp deg C, typical process
min = minimum voltage, min temp deg C, typical process, minus "Y%"
max = maximum voltage, max temp deg C, typical process, plus "Y%"
```

where nominal, min, and max temp are specified by the semiconductor vendor. The preferred range is  $50 \deg C$  nom,  $0 \deg C$  min, and  $100 \deg C$  max temperatures. Note that the derate factor, "Y%", may be different than that used for the I-V table data. This factor is similar to the X% factor described above. As in the case of I-V tables, temperatures are junction temperatures.

f. During the I-V measurements, the driving waveform should have a rise/fall time fast enough to avoid thermal feedback. The specific choice of sweep time is left to the modeling engineer.

## 4) Transit Time Extractions:

The transit time parameter is indirectly derived to be the value that produces the same effect as that extracted by the reference measurement or reference simulation. See Figure 37.

The test circuit consists of the following:

- a) A pulse source (10 ohms, 1 ns at full duration ramp) or equivalent and transitioning between Vcc and 0 V,
- b) A 50 ohm, 1 ns long trace or transmission line,
- c) A 500 ohm termination to the ground clamp reference voltage for TTgnd extraction and to the power clamp reference voltage for TTpower extraction (to provide a convenient, minimum loading 450 ohm - 50 ohm divider for high-speed sampling equipment observation of the component denoted as the device under test), and
- d) The device under test (DUT).

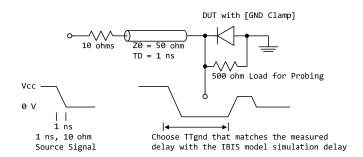


Figure 37 - Example of TTgnd Extraction Setup

The TTgnd extraction will be done only if a [GND Clamp] table exists. A high to low transition that produces a positive "glitch," perhaps several nanoseconds later, indicates a stored charge in the ground clamp circuit. The test circuit is simulated using the complete IBIS model with C\_comp and the Ct model defined under the [TTgnd] and [TTpower] keywords. An effective TTgnd value that produces a "glitch" with the same delay is extracted.

Similarly, the TTpower extraction will be done only if a [POWER Clamp] table exists. A low to high transition that produces a negative "glitch," perhaps several nanoseconds later, indicates a stored charge in the power clamp circuit. An effective TTpower value that produces a glitch with the same delay is extracted.

It is preferred to do the extractions with the package parameters removed. However, if the extraction is done from measurements, then the package model should be included in the IBIS based simulation.

## 5) Series MOSFET Table Extractions:

An extraction circuit is set up according to Figure 38. The switch is configured into the 'On' state. This assumes that the Vcc voltage will be applied to the gate by internal logic. Designate one pin of the switch as the source node, and the other pin as the drain node. The Table Currents designated as Ids are derived directly as a function of the Vs voltage at the source node as Vs is varied from 0 to Vcc. This voltage is entered as a Vgs value as a consequence of the relationship Vtable = Vgs = Vcc - Vs. Vds is held constant by having a fixed voltage Vds between the drain and source nodes. Note, Vds > 0 V. The current flowing into the drain is tabulated in the table for the corresponding Vs points.

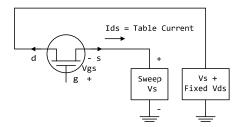


Figure 38 - Example of Series MOSFET Table Extraction

It is expected that this data will be created from semiconductor vendor proprietary silicon models, and later correlated with actual component measurement.

# 10 NOTES ON ALGORITHMIC MODELING INTERFACE AND PROGRAMMING GUIDE

This section is organized as an interface and programming guide for writing the executable code to be interfaced by the [Algorithmic Model] keyword described in 6C. Section 10 is structured as a reference document for the software engineer.

## 10.1 OVERVIEW

The algorithmic model of a Serializer-Deserializer (SERDES) transmitter or receiver consists of three functions: 'AMI\_Init', 'AMI\_GetWave' and 'AMI\_Close'. The interfaces to these functions are designed to support three different phases of the simulation process: initialization, simulation of a segment of time, and termination of the simulation.

These functions ('AMI\_Init', 'AMI\_GetWave' and 'AMI\_Close') should all be supplied in a single shared library, and their names and signatures must be as described in this section. If they are not supplied in the shared library named by the Executable sub-parameter, then they shall be ignored. This is acceptable so long as

- 1. The entire functionality of the model is supplied in the shared library.
- 2. All termination actions required by the model are included in the shared library.

The three functions can be included in the shared object library in one of the following two combinations:

- Case 1: Shared library has AMI\_Init, AMI\_GetWave and AMI\_Close.
- Case 2: Shared library has AMI\_Init and AMI\_Close.

Please note that the functions 'AMI\_Init' and 'AMI\_Close' are always required.

The interfaces to these functions are defined from three different perspectives. In addition to specifying the signature of the functions to provide a software coding perspective, anticipated application scenarios provide a functional and dynamic execution perspective, and a specification of the software infrastructure provides a software architecture perspective. Each of these perspectives is required to obtain interoperable software models.

#### 10.2 APPLICATION SCENARIOS

The next two sections provide an overview of the two simulation types supported by the IBIS-AMI specification. Statistical simulations require that the algorithm in the [Algorithmic Model] is linear and time-invariant (LTI). Time domain simulations do not have this requirement, therefore [Algorithmic Model]s used in time domain simulations may also contain non-linear and/or time-variant (non-LTI) algorithms.

System simulations will commonly involve a transmitter (Tx) and a receiver (Rx) [Algorithmic Model], each of which may perform filtering in the AMI\_Init function, the AMI\_GetWave function, or both (i.e., a "dual" algorithmic model). In the case of a "dual" algorithmic model, the filtering functionality in the AMI\_Init and AMI\_GetWave functions are each intended to be independent representations of the device's equalization. Users of a dual model can elect to use either the AMI\_Init or AMI\_GetWave filtering functionality, but not combine both simultaneously.

While the primary purpose of the AMI\_Init function is to perform the required initialization steps, it may also include LTI signal processing algorithms. Therefore, statistical simulations may be performed using the AMI\_Init function alone.

Even though time domain simulations may also be performed with the LTI AMI\_Init and/or LTI AMI\_GetWave functions, AMI\_GetWave functions containing non-LTI algorithms may only be simulated in the time domain.

## 10.2.1 STATISTICAL SIMULATIONS

- 1. From the system netlist, the EDA platform determines that a given buffer is described by an IBIS [Model].
- 2. From the IBIS [Model], the EDA platform determines that the buffer is described in part by an [Algorithmic Model].
- 3. The EDA platform loads the shared library or shared object file containing the [Algorithmic Model], and obtains the addresses of the AMI\_Init, AMI\_GetWave, and AMI\_Close functions.
- 4. The EDA platform loads the corresponding parameter file (.ami file) and assembles the arguments for the AMI\_Init function. These arguments include an impulse response matrix, a memory handle for the dynamic memory used by the [Algorithmic Model], the parameters for configuring the [Algorithmic Model], and optionally the impulse response(s) of any crosstalk interferers.
- 5. The EDA platform calls the AMI\_Init function with the arguments previously prepared. The AMI\_Init function of the transmitter and receiver [Algorithmic Model]s are called separately as described in the reference flow below.
- 6. The AMI\_Init function parses the configuration parameters, allocates dynamic memory, places the address of the start of the dynamic memory into the memory handle and modifies the impulse response by the filter response of the [Algorithmic Model].
- 7. The EDA platform completes the rest of the simulation/analysis using the impulse response calculated by the AMI\_Init function which is a complete representation of the behavior of a given [Algorithmic Model] combined with the channel.
- 8. Before exiting, the EDA platform calls the AMI\_Close function, giving it the address in the memory handle for the [Algorithmic Model].
- 9. The AMI\_Close function de-allocates the dynamic memory used by the [Algorithmic Model] and performs whatever other clean-up actions are required.
- 10. The EDA platform terminates execution.

## 10.2.2 TIME DOMAIN SIMULATIONS

- 1. From the system netlist, the EDA platform determines that a given buffer is described by an IBIS [Model].
- 2. From the IBIS [Model], the EDA platform determines that the buffer is described in part by an [Algorithmic Model].
- 3. The EDA platform loads the shared library or shared object file containing the [Algorithmic Model], and obtains the addresses of the AMI Init, AMI GetWave, and AMI Close functions.
- 4. The EDA platform loads the corresponding parameter file (.ami file) and assembles the arguments for the AMI\_Init function. These arguments include an impulse response matrix, a memory handle for the dynamic memory used by the [Algorithmic Model], the parameters for configuring the [Algorithmic Model], and optionally the impulse response(s) of any crosstalk interferers.
- 5. The EDA platform calls the AMI\_Init function with the arguments previously prepared. The AMI\_Init function of the transmitter and receiver [Algorithmic Model]s are called separately as described in the reference flow below.
- 6. The AMI\_Init function parses the configuration parameters, allocates dynamic memory, places the address of the start of the dynamic memory into the memory handle and (optionally) modifies the impulse response by the filter response of the [Algorithmic Model]. The EDA platform may make use of the impulse response returned by the AMI\_Init function in its further analysis if needed.
- 7. The EDA platform generates a time domain digital input waveform bit pattern (stimulus). A long bit pattern (and simulation) may be broken up into multiple time segments by the EDA platform. For example, if one million bits are to be simulated, there can be 1000 segments of 1000 bits each, i.e., one time segment comprises 1000 bits. The segments are not required to be equally sized and are not required to contain an integer number of bits.
- 8. For each time segment, the EDA platform calls the AMI\_GetWave function of the transmitter (if it exists), giving it the digital input waveform and the address in the memory handle for the [Algorithmic Model].
- 9. For the AMI\_GetWave function of the receiver, the EDA platform takes the output from the transmitter AMI\_GetWave function (if it exists) and combines it (for example by convolution) with the channel impulse response to produce an analog waveform and passes this result to the receiver AMI\_GetWave function for each time segment of the simulation. If the transmitter AMI\_GetWave function doesn't exist, the EDA platform takes the output of the transmitter AMI\_Init function and combines that (for example by convolution) with the digital stimulus bit pattern to produce the analog waveform for the receiver AMI\_GetWave function.

- 10. The output waveform of the receiver AMI\_GetWave function represents the voltage waveform at the decision point of the receiver. The EDA platform completes the simulation/analysis with this waveform.
- 11. Before exiting, the EDA platform calls the AMI\_Close function, giving it the address in the memory handle for the [Algorithmic Model].
- 12. The AMI\_Close function de-allocates the dynamic memory used by the [Algorithmic Model] and performs whatever other clean-up actions are required.
- 13. The EDA platform terminates execution.

#### 10.2.3 REFERENCE FLOWS

The next two sections define a reference simulation flow for statistical and time domain system analysis simulations. Other methods of calling models and processing results may be employed, but the final simulation waveforms are expected to match the waveforms produced by this reference simulation flow.

A system simulation usually involves a transmitter (Tx) and a receiver (Rx) model with a passive channel placed between them.

## 3.1 Statistical simulation reference flow

- Step 1. The simulation platform obtains the impulse response for the analog channel. This represents the combined impulse response of the transmitter's analog output, the channel and the eceiver's analog front end. The transmitter's output or receiver's -input characteristics must not include any filtering effects, for example equalization, in this impulse response, although it may include any parasitics which are included in the Tx or Rx analog model.
- Step 2. The output of Step 1 is presented to the Tx model's AMI\_Init function and the Tx AMI\_Init function is executed. The impulse response returned by the Tx AMI\_Init function is passed onto Step 3.
- Step 3. The output of Step 2 is presented to the Rx model's AMI\_Init function and the Rx AMI\_Init function is executed. The impulse response returned by the Rx AMI\_Init function is passed onto Step 4.
- Step 4. The EDA platform completes the rest of the simulation/analysis using the impulse response calculated in Step 3 by the Rx model's AMI\_Init function which is a complete representation of the behavior of a given [Algorithmic Model] combined with the channel.

# 3.2 Time domain simulation reference flow

- Step 1. The simulation platform obtains the impulse response for the analog channel. This represents the combined impulse response of the transmitter's analog output, the channel and the receiver's analog front end. The transmitter's output or receiver's input characteristics must not include any filtering effects, for example equalization, in this impulse response, although it may include any parasitics which are included in the Tx or Rx analog model.
- Step 2. The output of Step 1 is presented to the Tx model's AMI\_Init function and the Tx AMI\_Init function is executed. The Tx AMI\_Init function may modify the impulse response or choose to leave it unchanged.
- Step 3. The output of Step 2 is presented to the Rx model's AMI\_Init function and the Rx AMI\_Init function is executed. The Rx AMI\_Init function may modify the impulse response or choose to leave it unchanged.

Under certain circumstances, for example when the Rx\_AMI\_Init function includes an optimization algorithm, the impulse response presented to the Rx\_AMI\_Init function must include the Tx equalization effects for the optimization to work correctly. However, when the Tx AMI model contains an AMI\_GetWave function that performs a similar or better equalization than the Tx AMI\_Init function, there is a possibility for 'double-counting' the equalization effects in the Tx model. To allow for such models to work correctly, the EDA tool can operate in one of several ways, two of which are documented here:

- not utilize the Tx AMI\_GetWave functionality, by treating the Tx AMI model as if the Tx GetWave\_Exists was False.
- use deconvolution to obtain the impulse response of the Rx filter. Since the AMI\_Init function contains a linear and time invariant algorithm, the Rx equalization can be represented as an impulse response. Since the output of the Rx AMI\_Init function (output of Step 3) is an impulse response modified by the Rx equalization (e.g. by convolving the input of the Rx AMI\_Init function with the impulse response of the Rx filter), the impulse response of the Rx filter can be obtained by deconvolving the output of Step 3 with the input presented to Step 3.

Note: The Rx Model writer should keep in mind that it is not guaranteed that the impulse response that is presented to the Rx AMI\_init function will always include the effects of the Tx filter. Therefore the Rx AMI\_Init function may not be able to perform accurate optimization under all circumstances. For this reason, the parameters of the Rx AMI\_Init function should always default to valid values or have a mechanism to accept user defined coefficients and allow the user to turn off any automatic optimization routines to ensure successful simulations.

Step 4. The simulation platform produces a digital stimulus waveform. A digital stimulus waveform is 0.5 when the stimulus is "high", -0.5 when the stimulus is "low", and may have a value between -0.5 and 0.5 such that transitions occur when the stimulus crosses 0.

Step 5. If Tx GetWave\_Exists is True the output of Step 4 is presented to the Tx model's AMI\_GetWave function and the Tx AMI\_GetWave function is executed. The output of the Tx AMI\_GetWave functionis passed on to Step 6.

Step 6a. If Tx GetWave\_Exists is True and Rx GetWave\_Exists is True, the output of Step 5 is convolved with the output of Step 1 by the simulation platform and the result is passed on to Step 7

Step 6b. If Tx GetWave\_Exists is False and Rx GetWave\_Exists is True, the output of Step 4 is convolved with the output of Step 2 by the simulation platform and the result is passed on to Step 7

Step 6c. If Tx GetWave\_Exists is False and Rx GetWave\_Exists is False, the output of Step 4 is convolved with the output of Step 3 by the simulation platform and the result is passed on to Step 8.

Step 6d. If Tx GetWave\_Exists is True and Rx GetWave\_Exists is False, the output of Step 5 is convolved with the output of Step 1 and the Impulse Response of the Rx filter by the simulation platform and the result is passed on to Step 8. (The Impulse Response of the Rx filter may be obtained by deconvolving the output of Step 3 by the input of Step 3).

Note: For the scenario where the Tx AMI\_Init function does NOT include equalization effects (i.e. does not modify the impulse response of the channel), Step 6d is functionally equivalent to simply convolving the output of Step 5 with the output of Step 3.

Step 7. If Rx GetWave\_Exists is True the output of Step 6 is presented to the Rx model's AMI\_GetWave function and the Rx AMI\_GetWave function is executed. The output of the Rx AMI\_GetWave function is passed on to Step 8.

Step 8. The output of Step 6c, 6d or 7 becomes the simulation waveform output at the Rx decision point. Step 7 optionally may also return clock ticks, which may be post-processed by the simulation tool or presented to the user as is.

Steps 4 though 8 can be called once or can be called multiple times to process the full analog waveform. Splitting up the full analog waveform into multiple calls reduces the memory requirements when doing long simulations, and allows AMI\_GetWave to return model status every so many bits. Once all blocks of the input waveform have been processed, Tx AMI\_Close and Rx AMI\_Close are called to perform any final processing and release allocated memory.

#### 10.3 FUNCTION SIGNATURES

AMI Init

This section defines the structure and parameters used with required and optional functions.

```
Required: Yes

Declaration: long AMI_Init (double *impulse_matrix, long number_of_rows, long aggressors, double sample_interval, double bit_time, char *AMI_parameters_in, char **AMI_parameters_out, void **AMI_memory_handle, char **msg)
```

#### Arguments:

Function:

## impulse\_matrix

'impulse\_matrix' points to a memory location where the collection of channel voltage impulse responses, called the "impulse response matrix", is stored in the form of a single dimensional array of floating point numbers. The impulse responses pointed to by the 'impulse\_matrix' argument are both input and output. The EDA platform provides the impulse responses. The algorithmic model is expected to modify the impulse responses in place by applying a filtering behavior, for example, an equalization function, if modeled in the AMI\_Init function. The impulse response values are uniformly spaced in time. The sample spacing is determined by the EDA tool and passed to the algorithmic model trough the AMI\_Init function's 'sample\_interval' argument.

The first column of the impulse response matrix is the impulse response for a through channel, a channel that serves as a communication path between a transmitter/receiver pair. The rest of the columns contain the impulse responses of crosstalk channels. Crosstalk channels describe the paths between aggressor transmitters and victim receiver(s). Transmitters which are not part of a through channel between a certain transmitter/receiver pair are all considered aggressor transmitters with respect to that through channel. The receiver of the through channel in consideration is referred to as the victim receiver. The crosstalk impulse responses may be placed into the impulse response matrix in any order.

The single dimensional array of 'impulse\_matrix' is formed by concatenating the columns of an impulse response matrix, starting with the first column and ending with the last column. The matrix elements can be retrieved or identified using the following relationships:

```
impulse_matrix[idx] = impulse response matrix element (row, col)
idx = col * number_of_rows + row
row: row index ranges from 0 to number_of_rows-1
col: column index ranges from 0 to aggressors
```

Each impulse response in the impulse response matrix must have the same sample spacing and the same length.

To include any crosstalk effects in the Reference Flows described in this section of this specification, the crosstalk impulse responses must be included in the 'impulse\_matrix' and passed to the transmitter and receiver AMI\_Init functions. If present, any filtering in the transmitter and/or receiver AMI\_Init function(s) must also be applied to the crosstalk impulse responses to properly account for the crosstalk effects.

Note that the 'impulse\_matrix' will contain a different set of crosstalk impulse responses for the transmitter and receiver AMI\_Init calls, even for a transmitter/receiver pair of the same through channel. A transmitter's AMI\_Init function operates on those impulse responses which originate from that transmitter, including the through channel and crosstalk channel impulse responses. A victim receiver's AMI\_Init function, on the other hand, operates on all of those impulse responses which are received by that victim receiver, including the through channel and crosstalk channel impulse responses.

As an illustration, consider a crosstalk analysis with five channels numbered 1 through 5, where channel 3 in the center is the through channel of the transmitter/receiver pair Tx3/Rx3, and Rx3 is the victim receiver. In this case channels 1, 2 and 4, 5 are the aggressor channels with the aggressor transmitters Tx1, Tx2, Tx4 and Tx5. If the five 'impulse\_matrix'-es of the five transmitters' AMI\_Init functions contain the following data:

impulse\_matrix impulse\_matrix column 1 column 2 Tx1 IR1\_1 IR1\_3 Tx2IR2 2 IR2 3 IR3 3 IR4\_4 Tx4IR4 3 Tx5IR5\_5 IR5\_3

then the 'impulse\_matrix' passed into the victim receiver's (Rx3) AMI\_Init function will contain the following data:

where "IRi\_j" represents the impulse response from the transmitter on channel i to the receiver on channel j, Tx1Init() ... Tx5Init() represents the output of a transmitter's AMI\_Init function which modified the impulse response denoted inside the parentheses. Note that while in this example the 'impulse\_matrix' of each transmitter's AMI\_Init function contains at most one crosstalk impulse response, the victim receiver's 'impulse\_matrix' contains four crosstalk impulse responses. Also, using the above notation note that the first index number of each impulse response passed to the transmitter's AMI\_Init function matches the transmitter's channel number, and the second index

number of each impulse response passed to the receiver's AMI\_Init function matches the receiver's channel number.

It is the EDA tool's responsibility to rearrange the content of the 'impulse\_matrix' between the transmitter and receiver AMI Init calls.

The EDA tool is also responsible to limit the number of crosstalk channel impulse responses in 'impulse\_matrix' so that they shall not exceed 'Max\_Init\_Aggressors' as specified in the corresponding .ami parameter file of the algorithmic model. Consequently, the 'aggressors' parameter of the AMI\_Init function shall never contain a greater value than the value provided in 'Max\_Init\_Aggressors' of the corresponding .ami parameter file. While the allocated memory space for 'impulse\_matrix' may be larger, it is assumed that there is no meaningful data in that space beyond the last column of the impulse response matrix that is stored in it.

The AMI\_Init function must not change the size or organization of 'impulse\_matrix' that it was given in any way.

#### number\_of\_rows

The number of rows in the impulse matrix.

#### aggressors

The number of aggressors in the impulse\_matrix.

## sample\_interval

This is the sampling interval of the 'impulse\_matrix' passed into the AMI\_Init function and the 'wave' passed into the AMI\_GetWave function. The sample\_interval is determined by the EDA tool and it is usually a fraction of the bit\_time. The 'impulse\_matrix' and 'wave' returned by the algorithmic model must have the same 'sample\_interval' as the original 'impulse\_matrix' and 'wave' that was passed into the algorithmic model.

Impulse responses in 'impuse\_matrix' and waveforms in 'wave' should be treated as continuous analog waveforms by the algorithmic models. For this reason, algorithmic models must be able to produce valid results at any sample\_interval. Any internal analog to digital conversion or resampling is the responsibility of the algorithmic model. In case the algorithmic model is unable to operate at a given sample\_interval, it should abort gracefully with an exit code 0 (failure) and appropriate messaging.

Example:

```
Sample_interval = (lowest_bit_time/64)
```

#### bit\_time

The bit time or unit interval (UI) of the current data, e.g., 100 ps, 200 ps etc. The shared library may use this information along with the impulse\_matrix to initialize the filter coefficients.

#### AMI\_parameters\_in

The AMI\_parameters\_in argument is a pointer to a string. Memory for the string is allocated and de-allocated by the EDA platform. All the input from the IBIS AMI parameter file are passed to the algorithmic model using a string that has been formatted as a parameter tree.

The AMI\_parameters\_in argument must always be present in the AMI\_Init function call and it must always contain the address of a valid string. The string must always contain at least the root name of the parameter tree, even if there are no parameters to pass to the algorithmic model.

Examples of the tree parameter passing:

```
(mySampleAMI_1)

(mySampleAMI_2
    (tx
        (taps 4)
        (spacing sync)
)

(mySampleAMI_3
    (branchl
        (leaf1 value1)
        (leaf2 value2)
        (branch2
            (leaf3 value3)
            (leaf4 value4)
        )
        (leaf5 value5 value6 value7)
        )
```

The syntax for the parameter string is:

- The parameter and message strings passed through the AMI\_parameters\_in, AMI\_parameters\_out and msg arguments must not be enclosed in double quotes.
- Neither names nor individual values except for string literals may contain white space characters.
- 3. Parameter name/value pairs are always enclosed in parentheses, with the value separated from the name by white space.
- 4. A parameter value in a name/value pair can be either a single value or a list of values separated by whitespace.
- 5. Parameter name/value pairs can be grouped together into parameter groups by starting with an open parenthesis followed by the group name followed by the concatenation of one or more name/value pairs followed by a close parenthesis.
- Parameter name/values pairs and parameter groups can be freely intermixed inside a parameter group.
- 7. The top level parameter string must be a parameter group.

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- 8. White space is ignored, except as a delimiter between the parameter name and value.
- 9. Parameter values can be expressed either as a string literal, Boolean literal (True or False), decimal number, or a floating point number in the standard ANSI 'C' notation (e.g., 2.0e-9). String literal values are delimited using a double quote (") and no double quotes are allowed inside the string literals. Empty string literals are denoted by two successive double quote characters.
- 10. A parameter can be assigned an array of values by enclosing the parameter name and the array of values inside a single set of parentheses, with the parameter name and the individual values all separated by white space.

The modified BNF specification for the syntax is:

```
<tree>:
  <br/>branch>
<br/>
<br/>
dranch>:
  ( <branch name> <leaf list> )
<leaf list>:
  <br/>
<br/>
dranch>
  <leaf>
  <leaf list> <branch>
  <leaf list> <leaf>
  ( <parameter name> whitespace <value list> )
<value list>:
  <value>
  <value list> whitespace <value>
<value>:
  <string literal>
  <Boolean literal>
  <decimal number>
  <decimal number>e<exponent>
  <decimal number>E<exponent>
```

# AMI\_parameters\_out

The AMI\_parameters\_out argument is a pointer to a string pointer. Memory for the string is allocated and de-allocated by the algorithmic model. The model returns a pointer to the string as the contents of this argument. The string must be formatted as a parameter tree, as described in 3.1.2.6. The AMI\_Init function may use this string to return parameters to the EDA platform.

While the AMI\_parameters\_out argument must always be present in the AMI\_Init function call and the EDA platform must always provide a valid (non-zero) address value in it, algorithmic models are not required to return anything at that address to the EDA platform. For this reason, the EDA platform must also initialize the memory content at that address to zero (null pointer) prior to calling the AMI\_Init function, so that after the execution of the function it can determine whether or not the function returned a valid string pointer at that address. If the AMI\_Init function does not have any parameters to return to the EDA platform, it must return a pointer at the address provided

in this argument to a string which contains nothing but the root name. Note that the root name must always be included in the string.

#### AMI memory handle

Used to point to local storage for the algorithmic block being modeled and shall be passed back during the AMI GetWave calls, e.g. a code snippet may look like the following:

```
my_space = allocate_space( sizeof_space );
status = store_all_kinds_of_things( my_space );
*serdes_memory_handle = my_space;
```

The memory pointed to by AMI\_handle is allocated and de-allocated by the model.

#### msg

The msg argument is a pointer to a string pointer. Memory for the string is allocated and deallocated by the algorithmic model. The model returns a pointer to the string as the contents of this argument. The AMI\_Init function may use this string to send a descriptive, textual message to the EDA platform to be displayed in the user interface and/or to be saved in a log file.

While the msg argument must always be present in the AMI\_Init function call and the EDA platform must always provide a valid (non-zero) address value in it, algorithmic models are not required to return anything at that address to the EDA platform. For this reason, the EDA platform must also initialize the memory content at that address to zero (null pointer) prior to calling the AMI\_Init function, so that after the execution of the function it can determine whether or not the function returned a valid string pointer at that address. If the AMI\_Init function does not have a message string to return to the EDA platform, it may take the following actions:

- ignore the address provided in this argument (leaving the EDA tool provided null pointer at that address)
- return a null pointer at the address provided in this argument (redundantly rewriting the EDA tool provided null pointer at that address)

#### Return Value

1 for success

0 for failure

Algorithmic models shall return a failure code (0) if and only if the function call fails due to a program execution error. In all other cases the return code shall be "success" (1), even if the function cannot operate properly due to some functional problems. For example, if a function includes a CDR which is unable to get into a stable mode, the function shall still return a success code (1). Examples for returning a failure code (0) may include an invalid data type, a null pointer during run time, or anything that prevents the successful execution of the model's code.

The authors of Algorithmic Models are encouraged to provide feedback to the EDA tool's users through the various available messaging options about any difficulties the model encounters during execution, regardless of what the value of the function's return code is.

Function: AMI\_GetWave

Required: No

Declaration: long AMI\_GetWave (double \*wave,

long wave\_size,
double \*clock\_times,
char \*\*AMI\_parameters\_out,
void \*AMI\_memory)

### Arguments:

#### wave

'wave' points to a memory location where a uniformly sampled vector of a time domain waveform is stored. The waveform pointed to by the 'wave' argument is both input and output. The EDA platform provides the wave. The algorithmic model is expected to modify the waveform in place by applying a filtering behavior, for example, an equalization function, if modeled in the AMI\_Getwave function. The sample spacing is determined by the EDA tool and passed to the algorithmic model trough the AMI Init function's 'sample interval' argument.

Depending on the EDA platform and the analysis/simulation method chosen, the input waveform could include many components. For example, the input waveform could include:

- The waveform for the primary channel only.
- The waveform for the primary channel plus crosstalk and amplitude noise.
- The output of a time domain circuit simulator such as SPICE.

It is assumed that the electrical interface to either the driver or the receiver is differential. Therefore, the sample values are assumed to be differential voltages centered nominally around zero volts. The algorithmic model's logic threshold may be non-zero, for example to model the differential offset of a receiver; however that offset will usually be small compared to the input or output differential voltage.

The output waveform is expected to be the waveform at the decision point of the receiver (that is, the point in the receiver where the choice is made as to whether the data bit is a "1" or a "0"). It is understood that for some receiver architectures, there is no one circuit node which is the decision point for the receiver. In such a case, the output waveform is expected to be the equivalent waveform that would exist at such a node were it to exist.

## wave\_size

This is the number of samples in the waveform vector that is in the AMI\_GetWave function argument 'wave'. The length of this waveform is determined by the EDA tool. The value of 'wave\_size' may be different between GetWave calls within the same simulation. The 'wave' returned by the algorithmic model must have the same number of samples as the original 'wave' that was passed into the algorithmic model. Algorithmic models must be able to produce valid results with any wave\_size. In case the algorithmic model is unable to operate with a given wave\_size, it should abort gracefully with an exit code 0 (failure) and appropriate messaging.

# clock\_times

Vector to return clock times. The clock times are referenced to the start of the simulation (the first AMI\_GetWave call). The clock\_times vector is allocated by the EDA platform and is guaranteed to be greater than the number of clocks expected during the AMI\_GetWave call. The clock times

are exactly bit\_time/2 before the input data signal is sampled. The DLL will return non-negative clock\_times values, and place -1 after the last valid clock tick in the clock\_times vector during each AMI\_GetWave call. If there are no valid clock ticks for the duration of a AMI\_GetWave call a single entry of -1 will be returned in the clock times vector.

The clock ticks represented by clock times should be strictly monotonic, both within the clock\_times vector returned from a single call to AMI\_GetWave and between successive calls to AMI\_GetWave. That is, within a given clock\_times vector each successive valid value is greater than the value that preceded it, and the first valid value from a given call to AMI\_GetWave must be greater than the last valid value from the preceding call to AMI\_GetWave. Any non-strict-monotonic behavior of clock times (including two identical values) should be considered by EDA platform as a DLL failure.

Each valid value in the clock\_times vector shall be used to sample the output waveform by adding to it bit\_time/2, regardless whether that waveform sample occurs in the waveform segment being returned by the current call to AMI\_GetWave, or in the waveform segment to be returned by the next AMI\_GetWave call. Care should be taken in implementation of clock\_times to insure that the calculations used always maintain full double-precision floating point accuracy across multimillion bit simulations.

Although clock\_times will generally be related to the UI interval for the primary SerDes channel being simulated, there is no requirement that there be any relationship between the clock ticks generated by clock\_times and the actual waveform returned in the primary channel. It is possible for the CDR to go out of lock, resulting in clock ticks that have no definite relationship to the output wave. It is possible for the CDR to be suppressed for an undefined number of bits until the output of the 1st clock tick. In the case of a receiver without a CDR, it is possible for only -1 to ever be output during all AMI\_GetWave calls.

#### AMI parameters out

The AMI\_parameters\_out argument is a pointer to a string pointer. Memory for the string is allocated and de-allocated by the algorithmic model. The model returns a pointer to the string as the contents of this argument. The string must be formatted as a parameter tree, as described in 3.1.2.6. The AMI\_GetWave function may use this string to return parameters to the EDA platform.

While the AMI\_parameters\_out argument must always be present in the AMI\_GetWave function call and the EDA platform must always provide a valid (non-zero) address value in it, algorithmic models are not required to return anything at that address to the EDA platform. For this reason, the EDA platform must also initialize the memory content at that address to zero (null pointer) prior to calling the AMI\_GetWave function, so that after the execution of the function it can determine whether or not the function returned a valid string pointer at that address. If the AMI\_GetWave function does not have any parameters to return to the EDA platform, it must return a pointer at the address provided in this argument to a string which contains nothing but the root name. Note that the root name must always be included in the string.

#### AMI\_memory

This is the memory which was allocated during the init call.

```
Return Value
1 for success
0 for failure

Function: AMI_Close
Required: Sometimes

Declaration: long AMI_Close(void * AMI_memory)

Arguments:

AMI_memory

Same as for AMI_GetWave. See Section 3.2.2.5.

Return Value
1 for success
0 for failure
```

# 10.4 CODE SEGMENT EXAMPLES

```
extern long AMI_GetWave (wave, wave_size, clock_times, AMI_parameters_out,
AMI_memory);

my_space = AMI_memory;

clk_idx=0;
time = my_space->prev_time + my_space->sample_interval;
for(i=0; i<wave_size; i++)
    {
    wave = filterandmodify(wave, my_space);
    if (clock_times && found_clock (my_space, time))
        clock_times[clk_idx++] = getclocktime (my_space, time);
    time += my_space->sample_interval;
    }
    clock_times[clk_idx] = -1;    //terminate the clock vector
    Return 1;
```

## 10.5 RESERVED PARAMETER FORMAT

The .ami file must contain a distinct section or sub-tree named 'Reserved\_Parameters' beginning and ending with parentheses. The file may also contain another section or sub-tree named 'Model\_Specific', beginning and ending with parentheses. The sub-trees 'Reserved\_Parameters' and 'Model\_Specific' are branches of the root of the tree.

All leaves of the .ami file must begin with one of the following reserved words:

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```
Default
data_format> or Format <data_format>
```

A branch in the .ami file is an "AMI Parameter" if it contains the leaves Type, Usage, and any of the following leaves:

and does not contain another branch. Multiple leaves containing the same reserved word are not allowed within an AMI Parameter branch. A branch which contains one or more sub-branches may only contain the (Description <string>) leaf/value pair in addition to the sub-branches. Each sub-branch of a branch must have a unique name.

The parameter string passed in and out of the AMI executable model (described in sections 3.1.2.6, 3.1.2.7 and 3.2.2.4) is formatted the same way as the tree data structure in the .ami file with the following exceptions.

The EDA tool must process the content of the .ami file so that

1) the 'Reserved\_Parameters' and 'Model\_Specific' branch names and their associated open and close parentheses "()" are not included in the AMI\_parameters\_in string, and 2) the AMI Parameter branches with Usage In or Usage InOut are converted to leaf/value pairs for the AMI\_parameters\_in string, possibly incorporating user selections. In this conversion each AMI parameter branch name becomes a leaf name in the AMI\_parameters\_in string and each leaf name is followed by a white space, a value and a closing parenthesis ")".

The AMI executable model must generate a parameter string that is consistent with the content of the .ami file so that

- the 'Reserved\_Parameters' and 'Model\_Specific' branch names and their associated open and close parentheses "()" are not included in the AMI\_parameters\_out string, and
- 2) the AMI Parameter branches Usage Out or Usage InOut are returned as leaf/value pairs in the AMI\_parameters\_out\_string.

The EDA tool must pass a string to the AMI executable model through the AMI\_parameters\_in argument. This string must contain all of the leaf/value pair formatted Usage In and Usage InOut AMI parameters if there are any defined in the .ami file. No other information may be included in this string. The string must always include the root name of the parameter tree, even if there are no parameters to pass to the algorithmic model.

The AMI executable model must return a string to the EDA tool through the AMI\_parameters\_out argument. This string must contain all of the leaf/value pair formatted Usage InOut and Usage Out AMI parameters if there are any defined in the .ami file. No other information may be included in this string. The string must always include the root name of the parameter tree, even if there are no parameters to return to the EDA tool.

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For Usage In, the value in the "AMI Parameter" leaves are determined by the EDA tool based on the "AMI Parameter" branches in the .ami file. For Usage Out, the value in the "AMI Parameter" leaves are determined by the Algorithmic Model. For Usage InOut, the value in the "AMI Parameter leaves are first determined by the EDA tool based on the "AMI Parameter" branches in the .ami file and passed into the Algorithmic Model which may return a new value in the "AMI Parameter" leaves after some processing.

The 'Reserved\_Parameter' section is required while the 'Model\_Specific' section is optional. For AMI\_Version 5.1 and above, the Reserved\_Parameter sub-tree shall appear before the Model\_Specific sub-tree. Sub-trees of these sub-trees can be in any order in the parameter file. The '|' character is the comment character. Any text after the '|' character until the end of the line will be ignored by the parser.

The Model Parameter File must be organized in the following way:

```
(my_AMIname
                           Name given to the Parameter file
  (Reserved_Parameters
                           Required heading to start the
                           required Reserve_Parameters
                           section
   (Reserved parameter text)
                           End of Reserved Parameters
                           section
  (Model_Specific
                           Required heading to start the
                           optional Model_Specific section
   (Model specific parameter text)
                           End of Model_Specific section
  (Description <string>)
                           description of the model
                           (optional)
                           End my_AMIname parameter file
```

# $Init\_Returns\_Impulse, Use\_Init\_Output, GetWave\_Exists, Max\_Init\_Aggressors \ and \ Ignore\_Bits$

The Model parameter file must have a sub-tree with the heading 'Reserved\_Parameters'. This sub-tree shall contain all the reserved parameters for the model.

The following reserved parameters are used by the EDA tool and are required if the [Algorithmic Model] keyword is present. The entries following the reserved parameters points to its usage, type and default value. All reserved parameters must be in the following format:

```
(parameter_name (Usage <usage>) (Type <data_type>) (Default <values>)
(Description <string>))
```

Parameter: AMI\_Version

Required: Yes for AMI\_Version 5.1 and above, illegal before AMI\_Version 5.1

Descriptors:

Usage: Info
Type: String
Format: Value

Default: <string\_literal>(Illegal with Value)

Description: <string\_literal>

Definition: Tells EDA platform what version of the AMI modeling language is supported.

*Usage Rules:* AMI\_Version is required in the .ami parameter files of AMI models which are written in compliance with the IBIS Version 5.1 or later specification(s), but it is not allowed in the .ami parameter files of AMI models which are written in compliance with the IBIS Version 5.0 specification. When required, this parameter must be the first parameter defined in the Reserved\_Parameters branch of the .ami file.

The value of this parameter shall be '5.1' or greater for AMI models written in compliance with the IBIS Version 5.1 or later specifications. The absence of AMI\_version indicates that the AMI model was written in compliance with the IBIS Version 5.0 specification.

The version numbers of .ibs files and AMI models do not have to match. The EDA tool is expected to execute the AMI model according to the rules of the specification which corresponds to its version number.

Other Notes: For AMI\_Version 5.1, either Value or Default (but not both) are required.

Throughout this document, the shorthand, AMI\_Version < version\_number>, is used to indicate the minimum AMI\_Version level that is supported. If the AMI\_Version is not used, then the AMI model is processed at the level defined in [IBIS Ver] 5.0. In some cases, it will be noted that a rule has changed, has become more restrictive or more relaxed for a specified AMI\_Version level.

#### Examples:

Parameter: Init\_Returns\_Impulse

Required: Yes

Descriptors:

Usage: Info Type: Boolean

Format: Value (Illegal before IBIS\_AMI Version 5.1)

Default: <Boolean\_literal> (Required before AMI\_Version 5.1)
Description: <string\_literal> (Required, before AMI\_Version 5.1)

*Definition:* Tells EDA platform whether the AMI\_Init function returns a modified impulse response.

*Usage Rules:* When the Boolean\_literal value is set to 'True', the model returns the convolution of the impulse response with the impulse response of the equalization.

*Other Notes:* When reserved parameter AMI\_Version is not used, Default is required and Format Value is illegal. For AMI\_Version 5.1, either Value or Default (but not both) are required.

## Examples:

Parameter: GetWave\_Exists

Required: Yes

Descriptors:

Usage: Info Type: Boolean

Format: Value (*Illegal before IBIS\_AMI version 5.1*)

Default: <Boolean\_literal> (Required before AMI\_Version 5.1)

Description: <string\_literal> (Required, before AMI\_Version 5.1)

Definition: Tells EDA platform whether the AMI\_GetWave is implemented in this model

*Usage Rules:* Note that if Init\_Returns\_Impulse is set to 'False', then GetWave\_Exists MUST be set to 'True'.

*Other Notes:* When reserved parameter AMI\_Version is not used, Default is required and Format Value is illegal. For AMI\_Version 5.1, either Value or Default (but not both) are required.

#### Examples:

Parameter: Use\_Init\_Output

Required: No, and legal only before AMI\_Version 5.1

Descriptors:

Usage: Info
Type: Boolean
Format: (Illegal)

Default: <Boolean\_literal> (Required before AMI\_Version 5.1)
Description: <string\_literal> (Required, before AMI\_Version 5.1)

Definition: Tells EDA platform whether the AMI\_GetWave is implemented in this model

*Usage Rules:* When Use\_Init\_Output is set to 'True', the EDA tool is instructed to use the output impulse response from the AMI\_Init function when creating the input waveform presented to the AMI\_GetWave function.

If the Reserved Parameter, Use\_Init\_Output, is set to 'False', EDA tools will use the original (unfiltered) impulse response of the channel when creating the input waveform presented to the AMI\_GetWave function.

The algorithmic model is expected to modify the waveform in place.

Use\_Init\_Output is optional. The default value for this parameter is 'True'.

Type:

Format:

Default:

Description:

Integer

<numeric\_literal>

```
If Use_Init_Output is 'False', GetWave_Exists must be 'True'.
Other Notes: Format Value is illegal.
Examples:
(Use_Init_Output (Usage Info)(Type Boolean)(Default True)
     (Description "Use_Init_Output is valid only when AMI_Version is not used")
The following reserved parameters are optional. If the following parameters are not present, the
values are assumed as '0'.
Parameter:
             Max_Init_Aggressors
Required:
             No
Descriptors:
   Usage:
                    Info
   Type:
                    Integer
   Format:
                    Value (Illegal before AMI_Version 5.1)
   Default:
                    <numeric literal>
   Description:
                    <string_literal> (Required, before AMI_Version 5.1)
             Tells the EDA platform how many aggressor Impulse Responses the AMI_Init
Definition:
function is capable of processing.
Usage Rules: Its value is assumed '0' if Max_Init_Aggressors is not present.
Other Notes: When reserved parameter AMI Version is not used, Default is required and Format
Value is illegal. For AMI_Version 5.1, either Value or Default (but not both) are required.
Examples:
(Max_Init_Aggressors (Usage Info)(Type Integer)(Default 5)
       (Description "Valid for all AMI_Version levels")
(Max_Init_Aggressors (Usage Info)(Type Integer)(Value 5)
       (Description "Either Value or Default can be used, but not both
for AMI_Version 5.1")
Parameter:
             Ignore_Bits
Required:
             No
Descriptors:
   Usage:
                    Info
```

<string\_literal> (Required, before AMI\_Version 5.1)

Value (Illegal before AMI\_Version 5.1)

Definition: Tells the EDA platform how long the time variant model takes to complete initialization.

*Usage Rules:* This parameter is meant for AMI\_GetWave functions that model how equalization adapts to the input stream. The value in this field tells the EDA platform how many bits of the AMI\_GetWave output should be ignored.

Its value is assumed '0' if Ignore\_Bits is not present.

*Other Notes:* When reserved parameter AMI\_Version is not used, Default is required and Format Value is illegal. For AMI\_Version 5.1, either Value or Default (but not both) are required.

Examples:

#### Tx-only reserved parameters: Tx\_Jitter and Tx\_DCD

The following reserved parameters provide textual description to the user defined parameters.

These reserved parameters only apply to Tx models. There parameters are optional. If these parameters are not specified the values default to no jitter specified in the model ("0" jitter). If specified, they must be in the following format:

```
(parameter_name (Usage <usage>) (Type <data_type>) (Format <data_format>)
(Default <values>) (Description <string>))
```

Parameter: Tx\_Jitter Required: No

Descriptors:

Usage: Info, Out Type: Float, UI

Format: Gaussian, Dual-Dirac, DjRj, Table

Default: <numeric\_literal>(Optional for value pair or triple,

illegal forAMI\_Version 5.1)

Description: <string\_literal> (Required, before AMI\_Version 5.1)

Definition: Tells EDA platform how much jitter exists at the input to the transmitter's analog output buffer.

Usage Rules:

Other Notes: Default is not shown in the examples.

Examples:

```
(Tx_Jitter (Usage Info)(Type Float)(Gaussian 1e-9 1e-12)
      (Description "Gaussian <mean> <sigma>")
(Tx_Jitter (Usage Info)(Type Float)(Dual-Dirac 1e-9 2e-9 1e-12)
      (Description "Dual-Dirac <mean> <mean> <sigma>")
(Tx_Jitter (Usage Info)(Type Float)(1e-9 2e-9 10e-12)
      (Description "DjRj <MinDj> <MaxDj> <sigma>")
(Tx_Jitter (Usage Info)(Type Float)
      (Table
      (Labels
                "Row_No" Time" "Probability")
                    (-5 -5e-12 1e-10)
                    (-4 -4e-12
                                 3e-7)
                    (-3)
                         -3e-12
                                  1e-4)
                        -2e-12
                    (-2)
                                 1e-2)
                    (-1
                         -1e-12 0.29)
                    (0
                          0
                                  0.4)
                          1e-12 0.29)
                    (1
                    (2
                          2e-12
                                 1e-2)
                    (3
                          3e-12 1e-4)
                    (4
                          4e-12
                                  3e-7)
                    (5
                          5e-12 1e-10)
            Tx_DCD
Parameter:
Required:
            No
Descriptors:
   Usage:
                   Info, Out
   Type:
                   Float, UI
   Format:
                   Value, Range, Corner
                   <numeric_literal> (Illegal with Value for AMI_Version 5.1)
   Default:
                   <string_literal> (Required, before AMI_Version 5.1)
   Description:
            Tx_DCD (Transmit Duty Cycle Distortion) tells the EDA platform the maximum
percentage deviation of the duration of a transmitted pulse from the nominal pulse width.
Usage Rules:
Other Notes:
Examples:
(Tx_DCD (Usage Info)(Type Float)(Range 2 0 5)
      (Description "Range <typ> <min> <max>")
```

## Rx-only reserved parameters: Rx\_Clock\_PDF and Rx\_Receiver\_Sensitivity

These reserved parameters only apply to Rx model. These parameters are optional. If the parameters are not specified, the values default to '0'. If specified, they must be in the following format:

```
(parameter_name (Usage <usage>) (Type <data_type>) (Format <data_format>)
(Default <values>) (Description <string>))
            Rx_Clock_PDF
Parameter:
Required:
             No
Descriptors:
                   Info, Out
   Usage:
                   Float, UI
   Type:
   Format:
                   Gaussian, Dual-Dirac, DjRj, Table
   Default:
                   <numeric_literal> (Optional for value pair or triple,
                   illegal for AMI_Version 5.1)
                   <string_literal> (Required, before AMI_Version 5.1)
   Description:
             Tells EDA platform the probability density function of the recovered clock.
Definition:
Usage Rules:
Other Notes: (Default is not shown in the examples.)
Examples:
(Rx_Clock_PDF (Usage Info)(Type Float)(Gaussian 1e-9 1e-12)
      (Description "Gaussian <mean> <sigma>")
(Rx_Clock_PDF (Usage Info)(Type Float)(Dual-Dirac 1e-9 2e-9 1e-12)
      (Description "Dual-Dirac <mean> <mean> <sigma>")
(Rx_Clock_PDF (Usage Info)(Type Float)(DjRj 1e-9 2e-9 10e-12)
      (Description "DjRj <MinDj> <MaxDj> <sigma>")
(Rx_Clock_PDF (Usage Info)(Type Float)
      (Format Table
                "Row_No" Time" "Probability")
      (Labels
                    (-5 -5e-12 1e-10)
                    (-4 - 4e - 12 3e - 7)
                    (-3)
                         -3e-12 1e-4)
                    (-2)
                         -2e-12 1e-2)
                    (-1)
                         -1e-12 0.29)
                    (0
                          Ω
                                  0.4)
                          1e-12 0.29)
                    (1
                          2e-12
                    (2
                                  1e-2)
                    (3
                          3e-12 1e-4)
                    (4
                          4e-12
                                  3e-7)
                    (5
                          5e-12 1e-10)
```

```
IBIS 5.1 draft v110
```

Rx\_Receiver\_Sensitivity Parameter:

Required:

Descriptors:

Usage: Info, Out Float, UI Type:

Format: Value, Range, Corner

Default: <numeric\_literal> (Illegal with Value for AMI\_Version 5.1)

Description: <string\_literal> (Required, before AMI\_Version 5.1)

Description: Tells the EDA platform the voltage needed at the receiver data decision point to ensure proper sampling of the equalized signal.

Usage Rules: Other Notes:

Examples:

In the example below, 100 mV (above +100 mV or below -100 mV is needed to ensure the signal is - - - Formatted: Normal sampled correctly).

```
(Rx_Receiver_Sensitivity (Usage Info)(Type Float)(Value 0.1)
      (Description "Single Value choice, Default is optional")
(Rx_Receiver_Sensitivity (Usage Info)(Type Float)(Default 0.1)
      (Description "Default replaces Format Value for AMI_Version 5.1")
(Rx_Receiver_Sensitivity (Usage Info)(Type Float)(Range 1.0 -0.1 1.0)
      (Default 0.05)
      (Description "Range <typ> <min> <max>")
(Rx_Receiver_Sensitivity (Usage Info)(Type Float)(Corner 0.0 0.1 -0.1)
      (Default 0.05)
      (Description "Corner <typ> <min> <max>")
```

The tables below summarize the valid combinations of Reserved Parameters, defaults, Data Types and Data Formats.

Table 1 - General Rules and Allowed Usage for Reserved Parameters

l		Genera	l Rules		4		
	Reserved Parameter	Required	Default	Info	In	Out	InOut
	AMI Version <sup>1</sup>	<u>Yes</u>		<u>X</u>			4

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<u>Init_Returns_Impulse</u>	<u>Yes</u>	==	<u>X</u>		4
GetWave Exists	<u>Yes</u>	==	<u>X</u>		4
Use Init Output <sup>2</sup>	<u>No</u>	<u>True</u>	<u>X</u>		4
Ignore Bits	<u>No</u>	<u>0</u>	<u>X</u>		4
Max_Init_Aggressors	<u>No</u>	<u>0</u>	<u>X</u>		4
Tx_Jitter	<u>No</u>		<u>X</u>	<u>X</u>	4
Tx_DCD	<u>No</u>	<u>0</u>	<u>X</u>	<u>X</u>	4
Rx Receiver Sensitivity	<u>No</u>	<u>0</u>	<u>X</u>	<u>X</u>	4
Rx Clock PDF	<u>No</u>	Clock	<u>X</u>	<u>X</u>	4
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- 1) Required for IBIS Version 5.1 and above as the first reserved parameter, and illegal for IBIS Version 5.0
- 2) Illegal for Version 5.1 and above

Table 2 - Allowed Data Types for Reserved Parameters

Reserved Parameter									
Reserved Peremeter	Data Type								
Reserved Parameter	Float	UI	Integer	<u>Stri</u> Booleang	Boolean				
AMI_Version <sup>1</sup>				<u>X</u>					
Init Returns Impulse					<u>X</u>				
GetWave Exists					<u>X</u>				
Use Init Output <sup>2</sup>					<u>X</u>				
Ignore Bits			<u>X</u>						
Max_Init_Aggressors			<u>X</u>						
Tx_Jitter	<u>X</u>	<u>X</u>							
Tx DCD	<u>X</u>	<u>X</u>							
Rx Receiver Sensitivity	<u>X</u>								
Rx Clock PDF	<u>X</u>	<u>X</u>							

- 1) Required for IBIS Version 5.1 and above as the first reserved parameter, and illegal for IBIS Version 5.0
- 2) Illegal for Version 5.1 and above

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Table 3 - Allowed Data Formats for Reserved Parameters

Data Format										
Reserved Parameter	Value	Range	Corner	List	Increment	<b>Steps</b>	Gaussian		<u>DjRj</u>	<u>Table</u>
								<u>Dirac</u>		1
AMI_Version <sup>1</sup>	<u>X</u>									//
<u>Init_Returns_Impulse</u>	<u>X</u>									-1/1
GetWave Exists	<u>X</u>									-1/1
Use Init Output <sup>2</sup>	<u>X</u>									
Ignore Bits	<u>X</u>									-1//
Max_Init_Aggressors	<u>X</u>									
Tx_Jitter	<b>A</b>						<u>X</u>	_ <u>X</u>	_ <u>X</u>	<u>.+-</u> ¥
Tx DCD	<u>X</u>	<u>X</u> _	<u>X</u>							4111
Rx Receiver Sensitivity	<u>X</u>	<u>X</u>	<u>X</u>							<u> </u>
Rx Clock PDF	<b>A</b>						<u>X</u>	<u>X</u>	<u>X</u> .	*/ <u>                                    </u>

- 1) Required for IBIS Version 5.1 and above as the first reserved parameter, and illegal for IBIS Version 5.0
- 2) Illegal for Version 5.1 and above

**Table 4 - Allowed Data Types for Format Values** 

Formet	Data Type								
Format	<u>Float</u>	<u>UI</u>	<u>Integer</u>	String	<b>Boolean</b>	<u>Tap</u>			
<u>Value</u>	<u>X</u>	<u>X</u>	<u>X</u>	<u>X</u>		<u>X</u> •			
Range	<u>X</u>	<u>X</u>	<u>X</u>		<u>X</u>	<u>X</u>			
Corner	<u>X</u>	<u>X</u>	<u>X</u>	<u>X</u>	<u>X</u>	<u>X</u>			
<u>List</u>	<u>X</u>	<u>X</u>	<u>X</u>	<u>X</u>	<u>X</u>	<u>X</u>			
Increment	<u>X</u>	<u>X</u>	<u>X</u>			<u>X</u> •			
<u>Steps</u>	<u>X</u>	<u>X</u>	<u>X</u>			<u>X</u> •			
<u>Gaussian</u>	<u>X</u>	<u>X</u>				4			
<u>Dual-Dirac</u>	<u>X</u>	<u>X</u>				4			
<u>DjRj</u>	<u>X</u>	<u>X</u>				4			
<u>Table</u>	<u>X</u>	<u>X</u>	<u>X</u>	<u>X</u>	<u>X</u>	4			

## 10.5.1 MODEL SPECIFIC PARAMETERS:

The Following section describes the user defined parameters. The algorithmic model expects these parameters and their values to function appropriately. The model maker can specify any number of user defined parameters for their model. The user defined parameter section subtree must begin with the reserved parameter 'Model\_Specific'.

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A tapped delay line can be described by creating a separate parameter for each tap weight and grouping all the tap weights for a given tapped delay line in a single parameter group which is given the name of the tapped delay line. If in addition the individual tap weights are each given a name which is their tap number (i.e., "-1" is the name of the first precursor tap, "0" is the name of the main tap, "1" is the name of the first postcursor tap, etc.) and the tap weights are declared to be of type Tap, then the EDA platform can assume that the individual parameters are tap weights in a tapped delay line, and use that assumption to perform tasks such as optimization. The model developer is responsible for choosing whether or not to follow this convention.

The type Tap implies that the parameter takes on floating point values. Note that if the type Tap is used and the parameter name is not a number, this is an error condition for which EDA platform behavior is not specified.

```
Example of Parameter File
                                                                                                     Formatted: Font: Italic
                                                 Name given to the Parameter file
(mySampleAMI
                                                                                                     Formatted: Normal
  (Description "Sample AMI File")
  (Reserved_Parameters
                                              Required heading
     (Ignore_Bits (Usage Info) (Type Integer) (Default 21)
       (Description "Ignore 21 Bits"))
     (Max_Init_Aggressors (Usage Info) (Type Integer)(Default 25))
    (Init_Returns_Impulse (Usage Info) (Type Boolean)(Default True))
(GetWave_Exists (Usage Info) (Type Boolean) (Default True))
                                                End Reserved_Parameters
  (Model_Specific
                                              | Required heading
     (txtaps
       (-2 (Usage InOut)(Type Tap) (Range 0.1 -0.1 0.2)(Default 0.1)
            (Description "Second Precursor Tap"))
       (-1 (Usage InOut)(Type Tap) (Range 0.2 -0.4 0.4)(Default 0.2)
           (Description "First Precursor Tap"))
(Usage InOut)(Type Tap) (Range 1 -1 2)(Default 1)
            (Description "Main Tap"))
           (Usage InOut)(Type Tap) (Range 0.2 -0.4 0.4)(Default2 0.2)
           (Description "First Post cursor Tap"))
(Usage InOut)(Type Tap) (Range 0.1 -0.1 0.2)(Default 0.1)
           (Description "Second Post cursor Tap"))
                                              End txtaps
     (tx_freq_offset (Range 1 0 150) (Type UI) (Default 0))
                                              | End Model_Specific
                                                End SampleAMI
                                                                                                     Formatted: English (United States)
```

## 11 EMI PARAMETERS

There are two sections here: one for a [Component] and one for a [Model].

This section describes the structure of the EMI parameters under a top-level [Component] keyword. It is used to describe the EMI parameters associated with a [Component]. The parameters must be surrounded by the [Begin EMI Component] and [End EMI Component] keywords.

The following keywords are defined:

[Begin EMI Component]

[End EMI Component]

[Pin EMI]

[Pin Domain EMI]

The following subparameters are defined:

Domain

Cpd

C\_Heatsink\_gnd

C\_Heatsink\_float

Keyword: [Begin EMI Component]

Required: No

Description: Marks the beginning of the Component EMI parameters.

Sub-Params: Domain, Cpd, C\_Heatsink\_gnd, C\_Heatsink\_float

Domain indicates whether the component is digital, analog, or part digital part analog. Analog circuits are more susceptible to low-level noise. Analog circuits operate at very low signal levels (mV or uV) and can contain high gain amplifiers. In contrast, digital circuits operate at relatively large signal levels (compared to analog circuits).

The syntax for Domain is:

Domain\_value

Where Domain\_value is an enumerated argument, and is one of:

Digital, Analog, Digital\_analog

This subparameter is optional. If not entered, the default is Digital.

Cpd is the power dissipation capacitance parameter. Cpd (Power Dissipation Capacitance) is the internal parasitic capacitance (e.g., gate-to-source and gate-to-drain capacitance) plus the equivalent capacitance associated with the through currents when both transistors (n-channel and p-channel) are momentarily conducting.

Cpd is typically for CMOS devices, and helps provide a more accurate estimation of the power bus current, and therefore the noise voltage on the power bus. If the high frequency noise on the power bus (due to switching of digital circuits) is known, then the radiation can be calculated.

Sometimes Iccd (Dynamic power supply current) is found in databooks. It is normally given for FACT families. Iccd is specified in units of mA/MHz.

Cpd can be calculated from Iccd by the equation

```
Cpd(nF) = Iccd(mA/MHz) / Vcc(V).
```

The syntax for Cpd is:

Cpd = capacitance\_value

The units of capacitance\_value are Farads.

This subparameter is optional. If not entered, the default is 0.0F.

C\_Heatsink\_Float and C\_Heatsink\_Gnd define the heatsink capacitance and connection conditions. C\_Heatsink\_Float indicates that the heatsink is floating, and C\_Heatsink\_Gnd indicates that the heatsink is grounded.

Internal currents inside a (high speed) IC can be closely coupled onto a heatsink. As the heatsink is physically much larger than the IC silicon chip and bond wires, it is a more efficient radiator. Knowing the capacitance of the heatsink the radiated electric field can be estimated.

Only one of these subparameters can be defined. It is not legal to define both. It is legal to omit both. In this case it means that a heatsink is not present.

The subparameter takes one argument: the heatsink capacitance

The syntax for Heatsink\_cap is:

C\_Heatsink\_float = capacitance\_value

C\_Heatsink\_gnd = capacitance\_value

The units for capacitance\_value are Farads.

This subparameter is optional. If not entered, the default is that the component does not have a heatsink.

Keyword: [End EMI Component]

Required: No

Description: Marks the end of the Component EMI parameters.

Example:

[Begin EMI Component]
Domain Digital
Cpd = 6.4pF
C\_Heatsink\_gnd = 3.4pF
[End EMI Component]

Keyword: [Pin EMI]
Required: No

Description: Specifies the EMI parameters for a Pin.

Sub-Params: domain\_name, clock\_div

Usage Rules: Each line must contain three columns. The first column must contain the pin name. This pin name must match a pin name in the [Pin] keyword. (The pin name is the first column in the [Pin] record.)

The second column is the domain name. This specifies the clock domain for that pin. This is used by [Pin Domain EMI]. The field should be set to NA if unused.

The default for domain\_name is that the percentage of power used is 100%.

The third column is the clock division. This is the ratio of the frequency at this pin to the reference pin. The reference pin is always set to '1.0'. The ratio is a floating point number. The choice of the reference pin does not matter as this information is pin to pin ratios. It is suggested that the pin with the maximum frequency is chosen as the reference.

The field should be set to NA if unused.

The default for clock\_div is 1.0

Column length limits are:

pin\_name 5 characters max domain\_name 20 characters max clock\_div 5 characters max

It is not a requirement to specify every pin. An undefined pin will default to 100% power usage for Domain\_name, and 1.0 for clock\_div.

*Keyword:* [Pin Domain EMI]

Required: No

Description: Specifies the percentage of power used in each clock domain.

Sub-Params: percentage

*Usage Rules:* Each line must contain two columns. The first column must contain the domain\_name. This name must match a domain name in the [Pin EMI] keyword. (The domain name is the second column in that record.)

The percentage represents a user definable percentage of the power used by that domain. It is an integer in the range 0 < percentage = < 100

Column length limits are:

```
domain_name 20 characters max percentage 5 characters max
```

## Example:

```
[Begin EMI Component]
Domain
                 Digital
               = 6.4pF
Cpd
[Pin EMI]
            domain_name
                            clock_div
            MEM
                            0.5
 4
 5
            MEM
                            0.5
            NA
                            0.5
                                            | domain_name defaults to 100%
```

```
8
            RIOG
                            NA
                                           | clock_div defaults to 1.0
14
            CPU
                            1.0
15
                            0.5
            RIOG
[Pin Domain EMI]
                    percentage
                    40
CPU
MEM
                    30
RIOG
[End EMI Component]
```

This section describes the structure of the EMI parameters under a top-level [Model] keyword. It is used to describe the EMI parameters associated with a [Model]. The parameters must be surrounded by the [Begin EMI Model] and [End EMI Model] keywords.

The following set of keywords are defined:

```
[Begin EMI Model]
[End EMI Model]
```

The following set of subparameters are defined:

Model\_emi\_type
Model\_Domain

Keyword: [Begin EMI Model]

Required: No

Description: Marks the beginning of the Model EMI parameters.

Sub-Params: Model\_emi\_type, Domain

Model\_emi\_type indicates whether the model (for this pin) is a ferrite or not.

The syntax for Model\_emi\_type is:

Where Model\_emi\_type\_value is an enumerated argument, and is one of:

Ferrite, Not\_a\_ferrite

If not entered (the default), the model is Not\_a\_ferrite.

Model\_Domain indicates whether the model is digital or analog. This is only used if the [Component EMI] Domain is set to Digital\_analog. If the [Component EMI] Domain is set to anything else, Model\_Domain is ignored.

The syntax for Domain is:

Model\_Domain Domain\_value

Where Domain\_value is one of:

Digital, Analog

If not entered, the default is to use the [Component EMI] Domain setting and its default.

Keyword: [End EMI Model]

Required:

Description: Marks the end of the Model EMI parameters.

Example:

[Begin EMI Model] Model\_emi\_type Ferrite
[End EMI Model]